SiT95148 Cascade ClkSoC

High-Performance 11-output MEMS Jitter Cleaner, Clock Synchronizer



Description

The Cascade™ ClkSoC™ SiT95148 is a single-chip MEMS clock jitter cleaner optimized for the highest level of clock tree integration, consolidating multiple clock ICs and oscillators into a single device. Its low noise quad-PLL architecture and programmable output drivers can deliver up to 11 differential or 22 LVCMOS low jitter clock outputs. This ClkSoC supports 4 additional clock inputs with Frac-N dividers, enabling virtually any input to output frequency translation configurations from 8 kHz to 2.1 GHz.

The SiT95148 integrates SiTime's MEMS third-generation ApexMEMS® resonator to completely eliminate the need for external discrete crystal references required by traditional clock generators. This integrated MEMS approach simplifies system design and improves system reliability by eliminating the Clock Generator's dependency on quartz and associated quartz, along with all quartz related issues:

- No crystal capacitive matching issues that impact clock synthesis accuracy
- Always-reliable startup even at cold temperature and other harsh environmental conditions
- Simpler PCB routing without noise coupling onto a crystal interface which can result in jitter degradation
- No activity dips that are inherent to quartz
- 10 times more vibration resistant

The SiT95148 comes with the companion Cascade GUI software to simplify clock tree design. The device can be shipped with a user-specified, factory pre-programmed default startup configuration. The device configuration can be re-programmed by the user in two-time-programmable non-volatile memory (NVM) during system manufacturing or in-circuit via I2C/SPI for additional BOM flexibility. Details of register mapping can be found in the Cascade ClkSoC SiT9514x Register Map – Users Manual.

Applications

- Clock tree consolidation replacing Crystal Oscillators (XOs) and buffers
- Low jitter clock frequency translation and generation
- 10G/100G/400G Ethernet clocking
- IEEE 1588 Precision Time Protocol (PTP)
- Synchronous Ethernet Clock Synchronization, ITU-T G.8262.1
- JESD204B support
- Optical Transport Network (OTN) clocking for framers, mappers and processors
- FPGA, processor and memory clocking
- Server, storage, datacenter clocking
- Test and measurement instrumentation
- **Broadcast Video**

Features

- Quad Fractional-N PLLs with integrated VCO and loop filter, 93 fs typical RMS phase jitter for SerDes applications
- Wide output frequency support
 - Differential outputs from 8 kHz to 2.1 GHz
 - LVCMOS outputs from 8 kHz to 250 MHz
 - Supports 1 Hz to 2.1 GHz output frequency on one output
- Wide input frequency support
 - Differential input from 8 kHz to 2.1 GHz
 - LVCMOS input from 8 kHz to 250 MHz
- Individually configurable output formats and **VDD** Supply
 - LVPECL, CML, HCSL, LVDS or LVCMOS
 - 1.8 V, 2.5 V or 3.3 V
- Flexible input to output frequency translation with jitter attenuation, 4 inputs, 11 outputs
- Programmable jitter attenuation bandwidth for each PLL: 1 mHz to 4 kHz
- Synchronized, holdover or free run operation modes
- Hitless clock inputs with auto or manual switching
 - Sub 50 ps phase build out mode transients
 - Phase Propagation with programmable slopes
 - Frequency ramp for plesiochronous clocks
 - Robust and fast cycle slip and frequency step detection for input frequency steps (clean frequency tracking for large frequency steps)
- Locks to gapped clock inputs to support OTN
- Programmable Output Delay Control
- Programmable Frequency Ramp Slopes for Switching Plesiochronous Clocks
- DCO mode via I2C or SPI with 0.005 ppb resolution
- Indicators: Lock Loss, Clock Loss, Frequency Drift
- Repeatable Input to Output delays for each power up of chip
 - Zero Delay Buffer mode also possible on any one PLL
 - Output wake up sync with an independent clock also possible
- Industry standard 64-pin 9 x 9 mm package















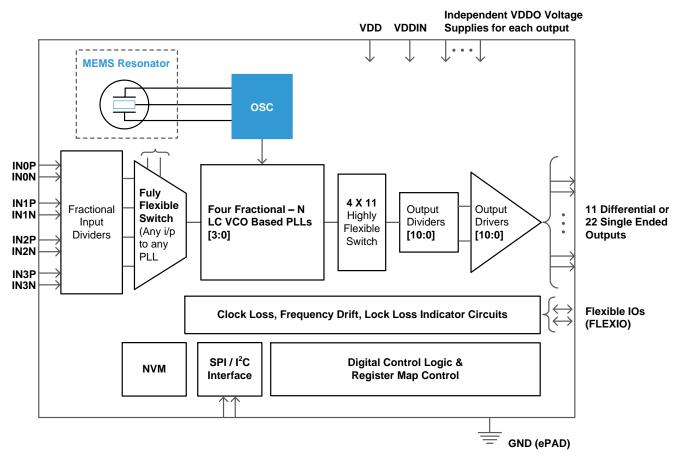


Figure 1. SiT95148 Block Diagram



Table of Contents

Description	1
Applications	1
Features	
Ordering Information	
Electrical Characteristics	
"4-16A" Phase Jitter Methodology for SerDes Applications	21
Functional Description	23
Frequency Configuration	25
Master and Slaves: Architecture Description and Programming Procedures	28
Input Slave Description	
Clock Monitor Slave Description	32
Fault Monitoring System	
Clock Loss Monitors	
Frequency Drift Monitors	
Lock Loss Monitors	
Output Slave Description	
PLL Bandwidth	
Fast Lock	
Operation Modes	
Device Start-Up and Initialization	
Free run mode	
Synchronized mode	
Holdover mode	
DCO Mode operation	
PLL MEMS Oscillator Reference	
Inputs	
Automatic Input Selection	
Manual Input Selection	
Hitless Input Switching	
Ramped Input Switching	
Input Clocks	
Clock Monitoring	
Fault Monitoring System	
Clock Loss Monitors	
Lock Loss Monitors	
Outputs	
Differential Output Termination Information	41
LVPECL	41
LVDS	43
HCSL	45
CML	45
Output Delay Control	47
Zero Delay Mode	47
Low Wander Mode	48
SiT95148 as device clock and synchronous system reference	49
Programmable Interface (PIF) Top Level View	
Serial Programming Interface Description	
I ² C protocol	
SPI Protocol	
SPI Timing Details	
SPI Single byte write	
SPI Single byte read	
Alarm Registers' Information	
Status and Notify	
Examples for Live Status Read Back	
Dynamic registers to read the various alarm registers in the RealTime page	
Examples of Sticky Bit Clearing	
Device Initialization for a Non-Programmed Device	04
Monitoring the Status for Master and Slave Pages	
IVIOLIILU IIIU LIIE JIAIUS IUI IVIASIEI AIIU JIAVE FAUES	/ 3

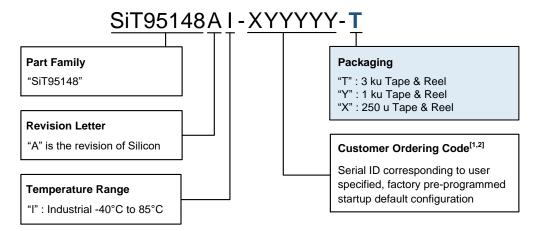
SiT95148 Cascade ClkSoC High-Performance 11-output MEMS Jitter Cleaner, Clock Synchronizer



Programming the Primary E-Fuse	77
Configuration Bits to Force Power-up of Digital Slave Subsystems	
E-Fuse Lock Configuration Bits	
E-Fuse Write Configuration Bits	79
Configuration Bit to Remove Manual Wake Up for Primary E-Fuse	
Pseudo Code: Programming the Primary E-Fuse	
Programming the Secondary E-Fuse	
Configuration Bit to Escape to PROGRAM_CMD State in GENERIC_SYS	83
Configuration Bit to Change the E-Fuse pointer	
Configuration Bit to Enable Manual Wake Up for Secondary E-Fuse	
Pseudo Code: Programming the Secondary E-Fuse	
Register Map Details.	



Ordering Information



- 1. X = "A" and "B" customer device, "C" to "Z" reserved.
 - A: Denotes blank devices;
 - B: Denotes Pre-configured devices, contact SiTime for the specifics.
- 2. Y = 0..9, A...Z for custom serial ID.



Electrical Characteristics

All Min and Max limits in the Electrical Characteristics tables are specified over temperature and rated operating voltage with standard output terminations shown in the termination diagrams. Typical values are at 25°C and nominal supply voltage.

See Table 1 below for absolute maximum ratings. Also see Table 3 for operating temperature.

Table 1. Absolute Maximum Ratings[3,4]

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Core supply voltage, Analog Input	V_{DDIN}	-0.5	1	+3.63	V	
Core supply voltage, PLL	V_{DD}	-0.5	1	+3.63		
Output bank supply voltage	V_{DDOX}	-0.5	1	+3.63	V	
Input voltage, All Inputs	V_{IN}	-0.5	1	+3.63	V	Relative to GND
I ² C Bus input voltage	V _{INI2C}	-0.5	1	+3.63	V	SCLK, SDAT pins
SPI Bus input voltage	V _{INSPI}	-0.5	1	+3.63	V	
Storage Temperature	Ts	-55	1	+150	°C	Non-functional, Non-Condensing
Programming Temperature	T _{PROG}	+25	1	+85	°C	
Maximum Junction Temperature in Operation	T _{JCT}	-	-	+125	°C	
Programming Voltage (for Programming the OTP Fuse Memory).	V_{PROG}	2.375	2.5	2.625	٧	
ESD (human body model)	ESD _{HBM}	_	-	2000	V	JESD22A-114
Latch-up	LU	-	-	100	mA	JEDEC JESD78D

- 3. Exceeding maximum ratings may shorten the useful life of the device.
- 4. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or at any other conditions beyond those indicated under the DC Electrical Characteristics is not implied. Exposure to Absolute-Maximum-Rated conditions for extended periods may affect device reliability or cause permanent device damage.

Table 2. Environmental Compliance

Parameter	Test Conditions	Value	Unit		
Mechanical Shock Resistance	MIL-STD-883F, Method 2002	10,000	g		
Mechanical Vibration Resistance	MIL-STD-883F, Method 2007	70	g		
Soldering Temperature (follow standard Pb free soldering guidelines)(1)	MIL-STD-883F, Method 2003	260	°C		
Moisture Sensitivity Level	MSL3 @ 260°C				
Electrostatic Discharge (HBM)	HBM, JESD22-A114	2,000	V		
Charge-Device Model ESD Protection	JESD220C101 750 V				
Latch-up Tolerance	JESD78	Compliant			

Table 3. Operating Temperature and Thermal Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Ambient temperature	TA	-40	-	+85	°C	
Junction temperature	TJ	ı	-	+125	°C	
		ı	25.50	-	°C/W	Still Air
Thermal Resistance Junction to Ambient	θ_{JA}	ı	20.80	-	°C/W	Air Flow 1 m/s
Ambient		ı	19.60	-	°C/W	Air Flow 2 m/s
Thermal Resistance Junction to Case	θ_{JC}	-	8.70	-	°C/W	
Thermal Resistance Junction to Board	θЈВ	-	7.07	-	°C/W	
Thermal Resistance Junction to Top Center	Ψ_{JA}	1	0.20	-	°C/W	



Table 4. DC Electrical Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition				
VDDIN = 3.3 V, VDD = 1.8 V										
Cumply voltage Apples Innut	V _{DDIN} [5,12]	2.375	2.5	2.625	٧	2.5 V range: ±5%				
Supply voltage, Analog Input	V DDIN ^[2]	2.97	3,3	3.63	٧	3.3 V range: ±10%				
		1.71	1.80	1.89	V	1.8 V range: ±5%				
Supply voltage, PLL	$V_{DD}^{[5,12]}$	2.375	2.5	2.625	٧	2.5 V range: ±5 %				
		2.97	3,3	3.63	V	3.3 V range: ±10%				
		1.71	1.80	1.89	٧	1.8 V range: ±5%				
Supply Voltage, Output Drivers	V_{DDOX}	2.375	2.50	2.625	٧	2.5 V range: ±5%				
		2.97	3.3	3.63	٧	3.3 V range: ±10%				
Supply Voltage Ramp Rate	TRAMP	0.100		50	ms	Time from 10% to 90% of VDD. See Figure 2.				
Supply Voltage Kamp Kate	TRAMP	0.100		30	1115	Power ramps must be monotonic.				
Total Power Dissipation (2.5V LVDS Outputs @ 156.25M)	Pd	_	1130	-	mW	4 PLLs, 11 Outputs				
Supply Current, VDDIN	I _{DDIN} ^[6]	-	20	25	mA	All Four Inputs assumed to be enabled				
		_	320	384	mA	All Four PLLs and 8 Outputs enabled				
Supply Current, VDD	I _{DD}	_	345	414	mA	All Four PLLs and 11 Outputs enabled				
		-	170	204	mA	Two PLLs and 4 Outputs enabled				
		_	40	48	mA	LVPECL, output pair terminated 50 Ω to VTT (VDDO – 2 V)				
Power supply current, VDDOX	I _{DDO} ^[7,8,9,10,11]	-	28	33.6	mA	LVPECL2, output pair terminated 50 Ω to VTT (VDDO – 2 V) or 0 V without common mode current				
Power supply current, VDDOX	I _{DDO} ^[7,8,9,10,11]	-	20	24	mA	CML, output pair terminated 50 Ω to VDDO				
Power supply current, VDDOX	I _{DDO} ^[7,8,9,10,11]	-	27	32.4	mA	HCSL, output pair with HCSL termination				
Power supply current, VDDOX	I _{DDO} ^[7,8,9,10,11]	-	16	19.2	mA	LVDS, output pair terminated with an AC or DC Coupled diff 100 Ω				
Power supply current, VDDOX	I _{DDO} [7,8,9,10,11]	_	20	24	mA	LVDS Boost, output pair terminated with an AC or DC Coupled diff 100 Ω				
Power supply current, VDDOX	I _{DDO} ^[7,8,9,10,11]	-	15	18	mA	LVCMOS, 250 MHz, 2.5 V output, 5 pF load				
Logio inputo	· · ·	0.7*VDD	ı	_	٧	High Level Logic (Logic State = '1')				
Logic inputs	V_{LOG}	-	ı	0.3*VDD	٧	Low Level Logic (Logic State = '0')				

Table 5. Supported Signaling Types and Voltages

Signaling Type	LVPECL	LVPECL2	LVDS	LVDS2 (Boosted)	HCSL	CML	LVCMOS
1.8 V	NOT Supported	ок	ок	NOT Supported	ок	ок	ок
2.5 V	ок	ок	ок	ок	ок	ок	ок
3.3 V	ок	ок	ок	ок	ок	ок	ок

- 5. To use 1.8 V for VDD, series resistor (4.7K) must be used at RSTB, FlexIO (input) and I²C/SPI (input) if the input volatge level is 2.5V/3.3V
- 6. This current can be linearly scaled if smaller than 4 inputs are enabled.
- 7. LVPECL mode provides 6 mA of common mode current on each output. LVPECL2 mode does not provide this common mode current.
- 8. A 50 Ω Termination resistor with a DC bias of VDDO 2 V for LVPECL standards is supported for VDDO = {2.5 V, 3.3 V}.
- 9. IDDOx Output driver supply current specified for one output driver in the table. This includes current in each of the output module that includes output dividers, drivers and clock distributions.
- 10. The LVDS Boost Mode and the LVDS Mode can be used for AC Coupled output terminations. LVDS Boost provides an LVPECL like swing with an AC Coupled 100 Ohm Differential termination.
- 11. Refer to the appropriate later section in the data sheet for various terminations that are supported.
- 12. For efuse programming in SiT95148 parts, VDD along with VDDIN can be set to 2.5 V with no reliability concerns. Refer to Programming the Primary E-Fuse for VDD/VDDIN voltage information for efuse programming.



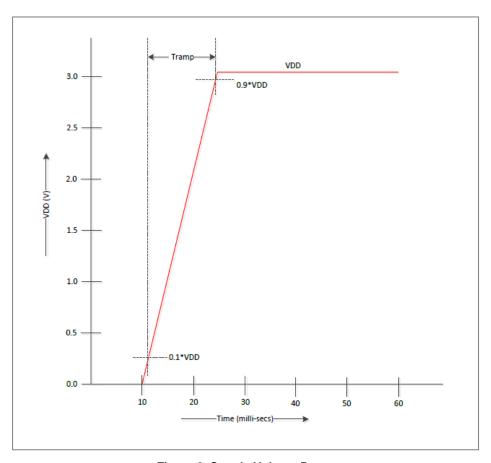


Figure 2. Supply Voltage Ramp



Table 6. Input Clock Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Differential Input Frequency	F _{IN,DIFF}	0.008	1	2100	MHz	Differential clock input
Single Ended Input Frequency	F _{IN,SE}	0.008	ı	250	MHz	All Single ended clock inputs including LVCMOS
Voltage Swing (Differential		100	ı	Ī	mV	f _{IN} < 400 MHz
Amplitude Peak or Single Ended Peak to Peak for the differential	V _{IN,DIFF}	225	ı	ı	mV	400 MHz < f _{IN} < 750 MHz
signal) ^[13]		350	ı	ı	mV	750 MHz < f _{IN} < 2100 MHz
Single Ended AC Coupled Inputs (Single Ended Peak to Peak Input) ^[14]	$V_{IN,SE}$	500	ı	3600	mV	AC Coupled f _{IN} < 250 MHz
Slew Rate ^[15,16]	SR	400	ı	ı	V/us	
Duty Cycle	DC _{IN,DIFF}	40	ı	60	%	
Input Capacitance	Cin	-	0.3	ı	pF	
Innut Posistanos	0	-	15	ı	kΩ	AC Coupled SE
Input Resistance	R _{IN}	-	10	ı	kΩ	Differential
	Puls	ed CMOS I	nput Buffer	— DC-cou	pled (INO, I	N1, IN2, IN3)
Input Frequency	FIN_PULSED_CMOS	0.008	ı	250	MHz	Single ended clock input
Input Voltage ^[16]	V _{IH}	8.0	ı	ı	٧	
input voitage	V _{IL}	-0.2	1	0.4	V	
Slew Rate ^[15,16]	SR	400	-	1	V/us	
Duty Cycle	DC	40	-	60	%	
Minimum Pulse Width	PW	1.6	-	-	ns	Pulse Input
Input Resistance	R _{IN}	-	30	-	kΩ	

Notes:

- 13. AC Coupled input assumed with series capacitance for differential inputs
- 14. Single Ended AC Coupled Input Swing requirement (Single Ended Peak to Peak Input) is for optimal noise performance.
- 15. Resistor termination for differential input followed by series capacitors for each of true and complement differential input connecting to the device pins.
- 16. LVCMOS single ended is direct coupled on the true input. Connect complement input to ground with a 100 nF capacitor.

Table 7. Serial and Control Input

	_					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
lanut Valtaga	VIL	-	-	0.3 x V _{DDIO} ^[17]	V	
Input Voltage	V _{IH}	0.7 x V _{DDIO} ^[17]	-	-	V	
Input Capacitance	Cin	-	1	-	pF	
Input Resistance	R _{IN}	-	25	-	kΩ	
Minimum Pulse Width	PW	100	-	-	ns	FLEXIO13, FLEXIO8
Update Rate	Fur	-	-	1	μs	FLEXIO13, FLEXIO8

Note:

17. VDDIO is the voltage used for all the status outputs and the serial interface. The default voltage for VDDIO can be chosen as either VDDIN or VDD with a hard coded eFuse based selection.



Table 8. Output Clock Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Differential Output Frequency (PLLA, B, C)		8k	-	2100M	Hz	LVPECL, CML, LVDS outputs
Differential Output Frequency (PLLD)	F _{OUT,DIFF} ^[18]	1	-	2100M	Hz	LVPECL, CML, LVDS outputs
Differential Output Frequency	Fout, DIFFH ^[18]	1	-	700M	Hz	HCSL outputs
Single Ended Output Frequency	F _{OUN,SE} ^[18]	1	-	250M	Hz	LVCMOS outputs
PLL loop bandwidth	F _{BW}	0.001	-	4000	Hz	Programmable
Jitter Peaking	J _{PEAK}	-	-	0.1	dB	Meets SONET Jitter Peaking requirements in closed loop
Time delay before the Historical average for output Frequency is considered	H _{DELAY} ^[19,20]	0.035	0.5	35	s	Programmable in register map
Length of time for which the Average of the frequency is considered	H _{AVG} ^[19,20]	0.07	1	70	s	Programmable in register map
Power Supply to I ² C or SPI interface ready	T _{START}	ı	-	10	ms	No I ² C transaction valid till 10 ms after all power supplies are ramped to 90% of final value.
With Speed-Up mode enabled	T _{LOCK} ^[21]	ı	300	-	ms	Speed-up mode is programmable. This is a Typical number. Actual wake up time depends on fast lock and normal BW settings.
DCO Mode Frequency Step Resolution	F _{RES,DCO} ^[22]	-	0.005	-	ppb	Frequency Increment or Decrement resolution. This is controlled through the register map.
Resolution for output delay	T _{RES} ^[23]	-	35	-	ps	Programmable per output clock with this resolution for a total delay of 7.5 ns
Maximum Phase Hit	T _{MAX} ^[24]	-50	±25	50	ps	Default Hitless Switching Mode (no phase propagation)
Uncertainty in Input to Output Delay	ΔT_{DELAY}	-175	-	175	ps	Maximum variation in the static delay from input to output clock between repeated power ups of the chip
Pull Range	ωР	-	500	-	ppm	
POR to Serial Interface Ready	T_{RDY}	1	_	15	ms	
Input to Output Delay in ZDB mode (matched pathways on external feedback, IN0 input, IN3 feedback)	T _{ZDELAY} ^[25]	-	100	-	ps	
Temperature Variation of delay in ZDB mode	T _{ZDELAY,T} [25]	-	-	1	ps/C	
Phase Delay Among Outputs from Different PLLs	T _{OUTDELAY_PS}	ı	-	±250	ps	In phase sync mode.
One free run PLL clock on fuse locked part	T _{START,Special}	-	-	11	ms	Using a special mode for fuse locked parts to generate one free run output from one PLL
		ı	-96	-	dBc	F _{OUT} = 156.25 MHz, F _{SPUR} = 100 kHz, BW= 100 Hz PSNR on VDD Supply, VDD=3.3V
	PSNR _{VDD}	-	-90	-	dBc	Fout = 156.25 MHz, Fspur = 100 kHz, BW= 100 Hz PSNR on VDD Supply, VDD=2.5 V
Power supply noise rejection (PSNR) ^[26,27]		-	-75	-	dBc	Fout = 156.25 MHz, Fspur = 100 kHz, BW= 100 Hz PSNR on VDD Supply, VDD=1.8 V
	PSNR _{VDDIN}	I	-70	_	dBc	Fout = 156.25 MHz, FSPUR = 100 kHz, BW= 100 Hz PSNR on input supply
	PSNR _{VDDO}	-	-80	-	dBc	Fout = 156.25 MHz, Fspur = 100 kHz, BW= 100 Hz PSNR on output supply
Output-Output Crosstalk [28,29,30]	XTALK	1	-75	-	dBc	156.25 MHz and 155.52 MHz on adjacent outputs

- 18. 1 Hz output available only on output OUT0 (OUT0P, OUT0N).
- 19. Hitless Switching enables PLL to switch between input clocks when the current clock is lost.
 - a. Clock Loss can be defined as 2 / 4 / 8 / 16 consecutive missing pulses.
 - b. Priority list for the input clocks can be set in the register map independently for each PLL.
 - c. Output is truly hitless (no phase transient and 0 ppb relative idd in frequency) for exactly same frequency input clocks that are switched.
 - d. Hitless switching support is both revertive and non-revertive.



- e. Revertive / Non-revertive Support: Assume Clock Input 0 is lost and switch is made to Clock Input 1. Then, PLL reverts to Clock Input 0 when it becomes valid again in Revertive mode. It does not switch back to Clock Input 0 even when it becomes valid again in the non-Revertive mode.
- 20. PLL enters holdover mode when the active input clock and all spare clocks in the clock priority list for hitless switching are lost.
 - a. Clock Loss can be defined as 2 / 4 / 8 / 16 consecutive missing pulses.
 - b. Programmable Clock Loss settings ensure Gapped Clocks can be supported by choosing higher number of missing pulses as the trigger for clock being invalid.
 - c. Entering holdover mode is supported with the frequency frozen at a historical average determined from the Hdelay and Havg settings.
- 21. For low PLL Loop Bandwidths, wake up time can be very large unless the speed up feature is used. The speed up feature provides the user options to use a completely independent loop bandwidth for the wake up transitioning to the regular bandwidth after frequency and phase are locked.
 - a. Fast Lock Bandwidth needs to be less than 100 times smaller than the input clock frequency (divided input at PLL phase detector) for stable and bounded (in time) lock trajectory of the PLL.
- 22. The 0.005 ppb specification is for the smallest frequency step resolution available. Larger frequency step resolutions up to 100 ppm can be used also. The frequency resolution for the DCO mode frequency step is independently programmable for each DCO step.
- 23. All output clocks from one specific PLL are phase aligned. Relative delay adjustment is then possible on each clock individually as defined by the TRES parameter.
- 24. This test is for 2 inputs at 8 M that are switched to get a 622.08 M output.
- 25. Both input and feedback at 8 MHz with the delays exactly matched and same slew for both for the chip.
- 26. The PSNR is measured with a 50 mVpp sinusoid in series with the supply and checking the spurious level relative to the carrier on the output in terms of phase disturbance impact.
- 27. Output PSNR measured with LVDS standard which (along with the LVDS boost) are the recommended standards for AC Coupled terminations.
- 28. Measured across adjacent outputs- All adjacent outputs are covered and the typical value for the worst case output to output coupling is reported.
- 29. The adjucent output pairs are chosen at 155.52 MHz and 156.25 MHz frequencies.
- 30. This cross talk between outputs is mainly package dependent therefore terminated outputs are used for reporting these numbers ensuring that there is signal current in the bond wires.

Table 9. Output Serial and Status Pin Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Output Voltage	Vон	V _{DDIO} [31] x 0.75	-	-	V	I _{OH} = -2 mA
	Vol	-	-	0.125	V	I _{OL} = 2 mA

Note

31. VDDIO is the voltage used for all the status outputs and the serial interface. The default voltage for VDDIO can be chosen as either VDDIN or VDD with a hard coded eFuse based selection.

Table 10. Fault Monitoring Indicators

	•					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Clock Loss Indicator Thresholds	CL _x [32,35]	2	4	16	Pulses	Clock Loss Indicators can be set on any of the four inputs. Loss of 2 / 4 / 8 / 16 consecutive pulses can be used to indicate a clock loss. Programmable in the register map
Fine Frequency Drift Indicator Thresholds: Step Size		ı	±2	-	ppm	Frequency drift threshold is programmable in the range with the
Fine Frequency Drift Indicator Thresholds: Hysteresis Range	FDx ^[33,34,35]	±2	-	±500	ppm	step size resolution specified. Frequency drift hysteresis is programmable in the range with the
Fine Frequency Drift Indicator Thresholds: Range		FDx ^[30,54,30]	±2	ı	±500	ppm
Coarse Frequency Drift Indicator Thresholds		±100	-	±1600	ppm	Coarse Drift Indicators programmable from {Up to ±1600 ppm in steps of ± 100 ppm}
Lock Loss Indicator Threshold	LL	±0.2	-	±4000	ppm	Lock Loss Indicator threshold is programmable in the range specified from the following choices for setting and clearing LL: {±0.2, ±0.4} ppm, {±2, ±4} ppm, {±20, ±40} ppm, {±200, ±400} ppm, {±2000, ±4000} ppm

- 32. Clock Loss Indicators are used for:
 - a. Hitless Switching Triggers
 - b. Update in Status Registers in the register map
- 33. Coarse and Fine Frequency Drift indicators can be concurrently enabled. This enables the user to detect fast drifting frequencies since detecting fine drifts will take longer measurements.
- 34. Clock loss and Lock loss indicators are available as alerts on flexible IO pins as described in the functional description section of the data sheet.
- 35. Clock Loss can be combined with either of the frequency drift monitors (coarse and fine) to trigger the hitless switching event in the PLLs. The trigger for a hitless switching event in the PLL can therefore be either the Clock Loss event or either of Clock Loss or Frequency Drift.



Table 11. Output RMS Jitter in Free Run Mode

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
0.012-20 Phase Jitter (legacy)	RMS _{JIT}	-	127	-	fs rms	F _{OUT} = 156.25 MHz, single PLL Measured with phase noise analyzer, integrating between 12 kHz and 20 MHz offset frequency. Recommended for SONET OC-48 applications. Includes spurs.
4-16A Phase Jitter ^[36]	RMSJIT	-	93	-	fs rms	F _{OUT} = 156.25 MHz, single PLL Measured with phase noise analyzer, extending (flat) phase noise to 3rd harmonic (i.e., 625 MHz offset), folding phase noise below the Nyquist frequency (i.e., 78.125 MHz offset), filtering and integrating from 10 kHz to Nyquist. Filter comprises 4 MHz low pass and 16 MHz high pass cut off frequencies, each with 20 dB/dec roll off. Includes spurs. For more information, refer to "4-16A" Phase Jitter Methodology for SerDes Applications.
4-20 Phase Jitter	RMS _{JIT}	_	62	_	fs rms	F _{OUT} = 312.5 MHz, single PLL Measured with phase noise analyzer and applying a 4 MHz high- pass filter with 1 st order roll off, then integrating from 12 kHz to 20 MHz. Includes spurs.

^{36.} Recommended for SerDes applications to improve the accuracy of clock jitter analysis, replacing the traditional 12 kHz to 20 MHz brick wall filter when application-specific filter characteristics are not explicitly specified.



Table 12. Output RMS Jitter in Frequency Translation Modes

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
RMS Jitter for 12 kHz – 20 MHz Integration Bandwidth	RMS _{JIT} [36,37]	-	120	-	fs rms	$F_{OUT} = 622.08 \text{ MHz}, \\ F_{IN} = 10 \text{ MHz}, \\ \text{PLL BW} = 100 \text{ Hz}, \text{ Single PLL Profile}$
RMS Jitter for 12 kHz – 20 MHz Integration Bandwidth	RMS _{JIT} [36,37]	I	128	ı	fs rms	F_{OUT} = 156.25 MHz, F_{IN} = 10 MHz, PLL BW = 100 Hz, Single PLL Profile

- 37. For best noise performance in jitter attenuation mode, use lowest usable loop bandwidth for the PLL.
- 38. Does not include noise from the input clock to the PLL.

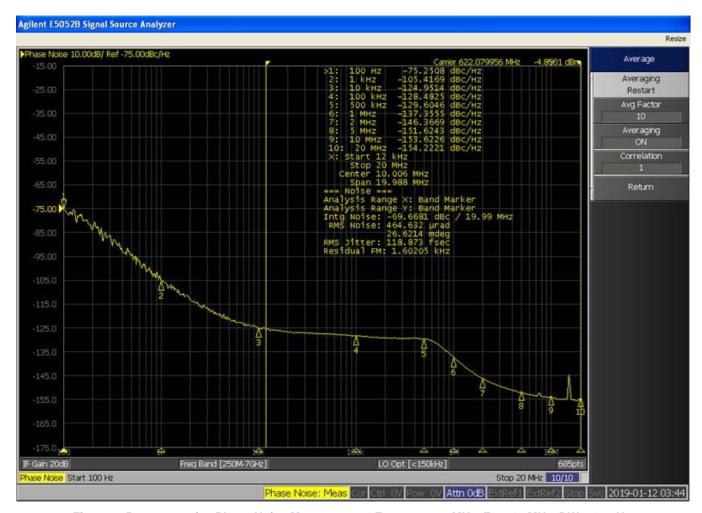


Figure 3. Representative Phase Noise Measurement: Fout = 622.08 MHz, Fin = 10 MHz, BW = 100 Hz





Figure 4. Representative Phase Noise Measurement: Fout = 156.25 MHz, F_{IN} = 10 MHz, BW = 100 Hz

Table 13. Close-in Frequency Offset Phase Noise

Parameter	Symbol	Conditions	Тур.	Unit	Condition
		Offset Frequency = 10 Hz	-91		
Low Fraguency Phase Noise	PN ^[38]	Offset Frequency = 100 Hz	-113	dBc/Hz	F _{OUT} = 122.88 MHz, F _{in} = 10 MHz, PLL BW = 100 Hz
Low Frequency Phase Noise	PINICES	Offset Frequency = 1 kHz	-130	UDC/FIZ	
		Offset Frequency = 10 kHz	-138		

Note:

39. This is the noise contribution of the chip only excluding the input and reference self contributions.



Table 14. Electrical Specifications for Output Clocks

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
			· ·			ne CMOS Output per Output Driver)
Output High Voltage	VOH	VDDO – 0.3			V	4 mA load. VDD = 3.3 V
Output High Voltage	VOH	VDDO - 0.4	_	_	V	4 mA load, VDD = 1.8 V and 2.5 V
Output High Voltage	VOH	VDDO - 0.2	_	_	V	100 uA Load
Output Low Voltage	VOL	_	_	0.3	V	4 mA load
Output Low Voltage	VOL	_	_	0.2	V	100 μA Load
	OC Electrical	Specifications -	LVDS Outputs	(VDDO = 1.8-V,	2.5-V or	3.3-V range)
Output Common-Mode Voltage	VOCM	1.125	1.2	1.375	V	VDDO = 2.5 V or 3.3 V range. Applies to LVDS and Boosted LVDS
-		0.74	0.87	0.96		VDDO = 1.8 V
Change in VOCM between complementary output states	ΔVOCM	-	-	50	mV	
Output Leakage Current	IOZ	-20	_	20	μΑ	Output Off, VOUT = 0.75 V to 1.75 V
	DC Electrica	al Specifications	- LVPECL Out	puts (VDDO = 2.	5-V or 3.	3-V range)
Output High Voltage	VOH	VDDO – 1.165	-	VDDO - 0.800	V	Rterm = 50Ω to VTT(VDDO – $2.0 V$)
Output Low Voltage	VOL	VDDO – 2.0	-	VDDO – 1.55		Rterm = 50 Ω to VTT(VDDO – 2.0 V), w/o common mode current
	DC Electrical	Specifications -	- HCSL Output	s (VDD = 1.8-V, 2	.5-V or 3	.3-V range)
Output High Voltage Max	VMAX	-	-	1150	mV	Measurement on single-ended signal
Output Low Voltage Min	VMIN	-300	-	-	mV	Measurement on single-ended signal
Differential Output High Voltage	VOHDIFF	150	-	-	mV	Measurement taken from differential waveform
Differential Output Low Voltage	VOLDIFF	-	_	-150	mV	Measurement taken from differential waveform
Absolute Crossing Point Voltage	VCROSS	250	-	550	mV	Measurement taken from single ended waveform
Variation of VCROSS over all rising clock edges	VCROSS DELTA	-	-	140	mV	Measurement taken from single ended waveform
	DC Electrical	Specifications -	- CML Outputs	(VDDO = 1.8-V, 2	2.5-V or 3	3.3-V range)
Output High Voltage	VOH	VDDO – 0.085	VDDO – 0.01	VDDO	V	Rterm = 50 Ω to VDDO
Output Low Voltage	VOL	VDDO – 0.6	VDDO – 0.4	VDDO – 0.32	V	Rterm = 50 Ω to VDDO
			Load: 10 pF <			z, 5 pF >150 MHz >200 MHz
Output Frequency	fOUT	8k	-	250M	Hz	
Output Duty cycle	tDC	45	-	55	%	Measured at 1/2 VDDO, loaded, fOUT < 100 MHz
Output Duty cycle	tDC	40	-	60	%	Measured at 1/2 VDDO, loaded, fOUT > 100 MHz
Rise/Fall time	tRFCMOS		_	2	ns	VDDO = 1.8 V, 20-80%, Highest Drive setting
Rise/Fall time	tRFCMOS	-	_	1.5	ns	VDDO = 2.5 V, 20-80%, Highest Drive setting
Rise/Fall time	tRFCMOS	_	_	1.2	ns	VDDO = 3.3 V, 20-80%, Highest Drive setting
		AC Electrical S	pecifications (LVPECL, LVDS,	CML)	
Clock Output Frequency	fOUT	8k	-	2100M	Hz	
PECL Output Rise/Fall Time	tRF	-	-	350	ps	20% to 80% of AC levels. Measured at 156.25 MHz for PECL outputs.
CML Output Rise/Fall Time	tRF	-	_	350	ps	20% to 80% of AC levels. Measured at 156.25 MHz for CML outputs
LVDS Output Rise/Fall Time	tRF	-	-	350	ps	20% to 80% of AC levels. Measured at 156.25 MHz for LVDS outputs.
Output Duty Cycle	tODC	45	50	55	%	Measured at differential 50% level, 156.25 MHz
LVDS Output differential peak	VP _{LVDS}	247	350	454	mV	Measured at 156.25 M Output
Boosted LVDS differential peak	VPB _{LVDS}	500	700	ı	mV	Measured at 156.25 M Output
LVPECL Differential peak	VP _{LVPECL}	450	750		mV	Measured at 156.25 M Output
CML Output Differential Peak	VP _{CML}	250	-	600	mV	Measured at 156.25 M Output



Table 15. I²C Bus Timing Specifications

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
SCLK clock frequency	fsclk	ı	ı	400	kHz	
Hold time START condition	thd:sta	0.6	ı	_	μs	
Low period of the SCK clock	t _{LOW}	1.3	ı	_	μs	
High period of the SCK clock	thigh	0.6	ı	_	μs	
Setup time for a repeated START condition	tsu:sta	0.6	1	_	μs	
Data hold time	t _{HD:DAT}	0	ı	_	μs	
Data setup time	tsu:dat	100	ı	_	ns	
Rise time	t _R	ı	ı	300	ns	
Fall time	t _F	ı	ı	300	ns	
Setup time for STOP condition	tsu:sto	0.6	ı	_	μs	
Bus-free time between STOP and START conditions	t _{BUF}	1.3	-	-	μs	
Default is 0x69 if SDO CSB pins are floating Otherwise address is 11010 {SDO},{CSB}	I ² C Address		0x69			

Figure 5. I²C Timing Waveform

Table 16. SPI Bus Timing Specifications[39]

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
SCLK clock frequency	f _{SCLK}	ı	_	20	MHz	
Clock pulse width HIGH	t _{CH}	20	_	_	ns	
Clock pulse width LOW	t _{CL}	20	_	_	ns	
CSB HIGH time	t _{CS}	50	_	_	ns	
CSB setup time	t _{CSS}	25	_	_	ns	
CSB hold time	t _{CSH}	25	_	_	ns	
Data in setup time	t _{SD}	10	_	_	ns	
Data in hold time	t _{HD}	10	_	_	ns	
Output valid	t _{co}	ı	_	10	ns	
Output setup time	t _{SO}	10	_	_	ns	
Output hold time	t _{HO}	10	_	_	ns	

Note:

40. When the chip is selected to be in the SPI Mode: The SDO pin is driven to 0 when the CSB is high for the chip in SPI mode.



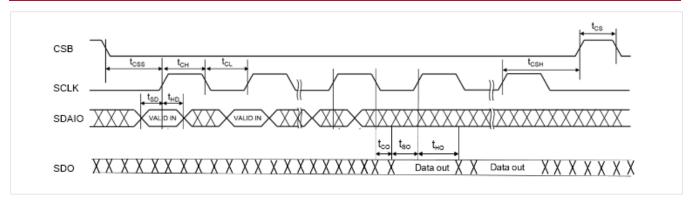


Figure 6. SPI Timing Waveform

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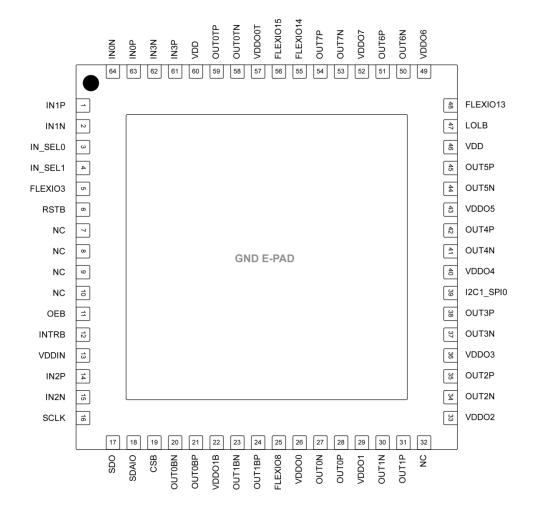


Figure 7. SiT95148 Top View

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Table 17. Detailed Pin Description^[40,42,43,44,45]

Pin Name	I/O Type	Pin#	Pull-up (kΩ)	Pull-down (kΩ)	Function	Comments
IN0P	Input	63			True input for IN0 differential pair. Input for LVCMOS IN0 input. Need series external capacitor for differential input.	
INON	Input	64			Complement input for IN0 differential pair. Ground with capacitor for LVCMOS IN0 input. Need series external capacitor for differential input.	
IN1P	Input	1			True input for IN1 differential pair. Input for LVCMOS IN1 input. Need series external capacitor for differential input.	
IN1N	Input	2			Complement input for IN1 differential pair. Ground with capacitor for LVCMOS IN1 input. Need series external capacitor for differential input.	IN0 / IN1 / IN2 / IN3 inputs can be used for output clock synchronization. An active clock and three spare clocks are
IN2P	Input	14			True input for IN2 differential pair. Input for LVCMOS IN2 input. Need series external capacitor for differential input.	chosen for each PLL. There is complete flexibility in the choice of the Active and 4 Spares for each of the 4 PLLs.
IN2N	Input	15			Complement input for IN2 differential pair. Ground with capacitor for LVCMOS IN2 input. Need series external capacitor for differential input.	
IN3P	Input	61			True input for IN3 differential pair. Input for LVCMOS IN3 input. Need series external capacitor for differential input.	
IN3N	Input	62			Complement input for IN3differential pair. Ground with capacitor for LVCMOS IN3 input. Need series external capacitor for differential input.	
GND	Power	E-PAD			Electrical and Package Ground	Exposed Ground on the bottom E-PAD.
OUT0BP	Output	21			Output 0B True Output or Output 0B LVCMOS	
OUT0BN	Output	20			Output 0B Complement Output or Output 0B LVCMOS	
OUT1BP	Output	24			Output 1B True Output or Output 1B LVCMOS	
OUT1BN	Output	23			Output 1B Complement Output or Output 1B LVCMOS	
OUT0P	Output	28			Output 0 True Output or Output 0 LVCMOS	
OUT0N	Output	27			Output 0 Complement Output or Output 0 LVCMOS	
OUT1P	Output	31			Output 1 True Output or Output 1 LVCMOS	
OUT1N	Output	30			Output 1 Complement Output or Output 1 LVCMOS	LVPECL, LVDS, HCSL, CML and LVCMOS support.
OUT2P	Output	35			Output 2 True Output or Output 2 LVCMOS	
OUT2N	Output	34			Output 2 Complement Output or Output 2 LVCMOS	
OUT3P	Output	38			Output 3 True Output or Output 3 LVCMOS	
OUT3N	Output	37			Output 3 Complement Output or Output 3 LVCMOS	
OUT4P	Output	42			Output 4 True Output or Output 4 LVCMOS	
OUT4N	Output	41			Output 4 Complement Output or Output 4 LVCMOS	
OUT5P	Output	45			Output 5 True Output or Output 5 LVCMOS	
OUT5N	Output	44			Output 5 Complement Output or Output 5 LVCMOS	



Table 16. Detailed Pin Description (continued)

			ion (cor	,		
Pin Name	I/O Type	Pin#	Pull-up (kΩ)	Pull-down (kΩ)	Function	Comments
OUT6P	Output	51			Output 6 True Output or Output 6 LVCMOS	
OUT6N	Output	50			Output 6 Complement Output or Output 6 LVCMOS	
OUT7P	Output	54			Output 7 True Output or Output 7 LVCMOS	
OUT7N	Output	53			Output 7 Complement Output or Output 7 LVCMOS	
OUT0TP	Output	59			Output 0T True Output or Output 0T LVCMOS	
OUT0TN	Output	58			Output 0T Complement Output or Output 0T LVCMOS	
VDDIN	Power	13			Power Supply Voltage pin	Decoupling capacitor close to supply pin required
VDD	Power	46, 60			Power Supply Voltage pin	Multiple Supply Pins, Decoupling capacitor close to each supply pin required
INTRB	Output	12			Active low indicator of programmable sticky notifies. Can be left floating if not used.	
RSTB	Input	6	25		Active low reset internally pulled up to VDDIO; Pull Up Resistor to VDDIO of fixed value (25 K Ω).Can be left floating.	Active low signal performs a complete reset of the part. See Note 40.
OEB	Input	11		25	Used to disable (when 1) all the output clocks. Can be left floating or pulled down to GND if not used.	See Note 40.
LOLB	Output	47			Loss of Lock Indicator	
FLEXIO3	Input / Output	5		25	Flexible Outputs can be used for programmable status monitoring. Can be left floating or pulled down to GND if not used.	
FLEXIO8	Input	25		25	Flexible Outputs can be used for programmable status monitoring. Can be left floating or pulled down to GND if not used.	See Note 40.
FLEXIO13	Input	48		25	Flexible Outputs can be used for programmable status monitoring. Can be left floating or pulled down to GND if not used.	
IN_SEL0	Input	3		25	Input Clock Selection for Manual selection of active	
IN_SEL1	Input	4		25	clock. Can be left floating or pulled down to GND if not used.	
SDAIO	Input / Output	18	25		I ² C Serial Interface Data (SDA) / SPI Input data (SDI)	
SCLK	Input	16	25		I ² C Serial Interface Clock or SPI Clock Input	
CSB/A0	Input	19	25		Chip Select for the SPI Interface. In I ² C mode this is the A0 address pin.	
SDO/A1	Output / Input	17		25	Serial Data Output (SPI Interface). In I ² C mode this is the A1 address pin.	
I2C1_SPI0	Input	39	25		Choose between SPI(0) and I ² C(1) interface being used	
VDDO1B	Power	22			Output Power Supply for Bank 0B and 1B outputs	
VDDO0	Power	26			Output Power Supply for Bank 0 outputs	
VDDO1	Power	29			Output Power Supply for Bank 1 outputs	
VDDO2	Power	33			Output Power Supply for Bank 2 outputs	
VDDO3	Power	36			Output Power Supply for Bank 3 outputs	
VDDO4	Power	40			Output Power Supply for Bank 4 outputs	
VDDO5	Power	43			Output Power Supply for Bank 5 outputs	
VDD06	Power	49			Output Power Supply for Bank 6 outputs	



Table 16. Detailed Pin Description (continued)

Pin Name	I/O Type	SiT95148 Pin #	Pull-up (kΩ)	Pull-down (kΩ)	Function	Comments
VDD07	Power	52			Output Power Supply for Bank 7 outputs	
VDDO0T	Power	57			Output Power Supply for Bank 0T outputs	
FLEXIO14	Input / Output	55		25	Flexible Outputs can be used for programmable status monitoring. Can be left floating or pulled down to GND if not used.	
FLEXIO15	Input / Output	56		25	Flexible Outputs can be used for programmable status monitoring. Can be left floating or pulled down to GND if not used.	
NC	No Connect	7, 8, 9, 10, 32			No connect. This pin is not connected to the die.	

Notes:

- 41. To use 1.8 V for VDD, series resistor (4.7K) must be used at RSTB, FlexIO (input) and I²C/SPI (input) if the input volatge level is 2.5V/3.3V
- 42. VDDIO is the voltage used for all the status GPIOs and the serial interface. The default voltage for VDDIO can be chosen as either VDDIN or VDD through the TimMaster™ GUI. This needs to be a selection in the base programmable profile itself. Configure VDDIO as VDD by setting 0x23[7] to 0 and VDDIN setting 0x23[7] to 1 on Page 0.
- 43. All digital input/output GPIOs have an on-chip 25 kΩ pull down resistor to ePAD ground and can be left unconnected if not used
- 44. The I2C1_SPI0 pad has a an on-chip 25 kΩ pull up resistor to indicate default mode of communication as I2C unless this pin is pulled down on the board to indicate the SPI mode.
- 45. In I2C mode, the serial data and clock have an on-chip 25 k Ω pull up resistor to VDDIO.
- 46. The RSTB pin has an on-chip 25 kΩ pull up resistor to VDDIO. Writing 0xFE[0] to 1 with delay addition of 10ms has the same effect as the pulling RSTB pin to GND for chip reset.

Table 18. Input Channel Selection Truth Table

IN_SEL1	IN_SEL0	Input Channel
0	0	IN0
0	1	IN1
1	0	IN2
1	1	IN3



"4-16A" Phase Jitter Methodology for SerDes Applications

Proper evaluation of reference clock (refclk) jitter is critical to optimize system performance in high-speed serial links. The traditional 12 kHz to 20 MHz analysis of filtering refclk jitter can mislead designers to select components that degrade rather than improve link performance. Therefore, this datasheet replaces the legacy 12 kHz to 20 MHz filter analysis with an established and more accurate methodology adopted by several industry standards (e.g. PCI Express, CXL, UCle) and implemented here as "4-16A" phase jitter. A brief overview follows.

Established in 1991 for SONET OC-48 line rates, the traditional 12 kHz to 20 MHz jitter filter served as a golden reference to evaluate refclk jitter for over 30 years. The filter is used is nearly all clock and timing datasheets today. However, the results it provides no longer correlate with system performance and can create suboptimum link performance. Sources of filter error include incorrect corner frequencies, unrealistic brick-wall roll offs and a lack of accounting for aliased phase noise. Errors of tens of femtoseconds are significant today and will become more

significant as data rates increase. For these reasons, we recommend customers adopt the more accurate "4-16A" phase jitter methodology for SerDes applications.

The conventional refclk jitter analysis uses a band-pass filter, as shown in Figure 8, to extract the refclk contribution to jitter observed at the receiver. Historically the refclk jitter filter was arbitrarily applied to phase noise up to an offset equal to the refclk Nyquist frequency. However, this ignores higher-offset phase noise that aliases when the refclk is sampled by a PLL's digital phase detector. Studies have shown that extending the phase noise data flat to the third harmonic (or, twice the fundamental frequency in the offset-frequency axis) accurately estimates worst-case phase jitter^[47]. Above the third harmonic, phase noise rolls off quickly and can be ignored.

Note:

 "How to evaluation reference-clock phase noise in high-speed serial links", Signal Integrity Journal.

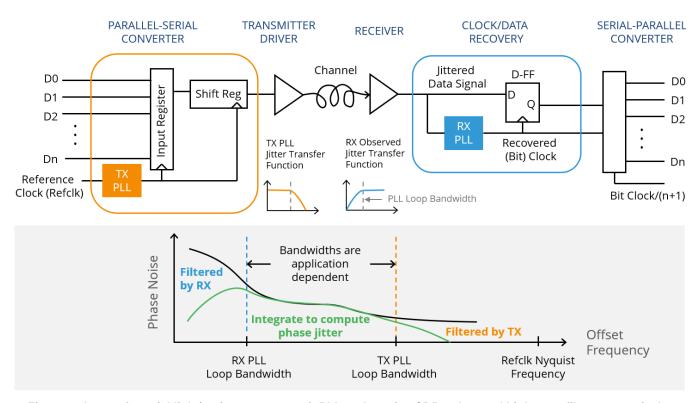


Figure 8. A generic serial link (top) uses a transmit PLL and receive CDR to low and high pass filter, respectively, refclk phase noise. This forms a band-pass system filter (bottom) for computing phase jitter.

The left Figure 9 chart illustrates this methodology of filtering aliased phase noise for a 156.25 MHz clock. Direct phase noise analyzer instruments include an anti-aliasing filter. Thus, to account for aliasing, the phase noise is extended flat to the 3rd harmonic (468.75 MHz in the signal spectrum, or 312.5 MHz in offset frequency spectrum) and the jitter filter is folded across Nyquist-zone boundaries (at

156.25/2, 156.25 and 156.25×3/2 MHz). Then the phase noise data is filtered and integrated to derive phase jitter. The right chart in Figure 9 illustrates a mathematically equivalent process that aliases the extended phase noise below an offset equal to the Nyquist frequency before filtering in the first Nyquist zone^[47].



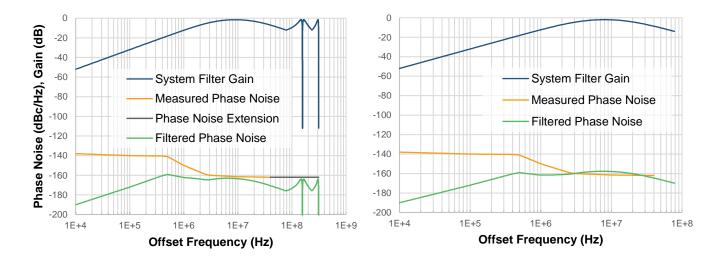


Figure 9. Illustration of two equivalent processes to filter aliased phase noise. The left chart extends (black) the measured phase noise (orange) to the 3rd harmonic, mirrors the filter (blue) across higher Nyquist zones before deriving the filtered phase noise (green). Alternatively, the right chart aliases the extended phase noise (not shown) below the Nyquist frequency before filtering (green). Integrating either green curve yields the same value of phase jitter.

A shorthand label for this methodology is "#-#A" phase jitter where the first and second numbers "#" are replaced with RX CDR and TX PLL bandwidths, respectively, with 20 dB/dec roll offs, and "A" indicates that aliasing is included. For example, "4-16A" phase jitter uses 4 MHz RX and 16 MHz TX bandwidths with aliasing. Here, 4 MHz represents the most common serial standard, Ethernet, which typically specifies a CDR bandwidth of 4 MHz for 10 Gbps and higher link rates, and 16 MHz represents a worst-case estimate for TX PLL bandwidth (the PLL becomes unstable

at higher bandwidths). This shorthand terminology makes it easy to describe variations. For example, "2-10A" phase jitter describes the same methodology but for 2 MHz RX CDR and 10 MHz TX PLL bandwidths. In practice, the exact bandwidths are application dependent, and "4-16A" is simply chosen here to represent the most common application (Ethernet).



Functional Description

SiT95148 is a jitter attenuating frequency translation device that offers four independent fractional PLLs. The output high frequency voltage-controlled oscillator (VCO) associated with each PLL is mapped to the 11 outputs in a very flexible fashion. This offers a very flexible frequency translation arrangement with independent control of each PLL in terms of jitter attenuation, bandwidth control and input clock selection with redundancy.

Figure 8 shows a high-level architecture diagram of SiT95148.

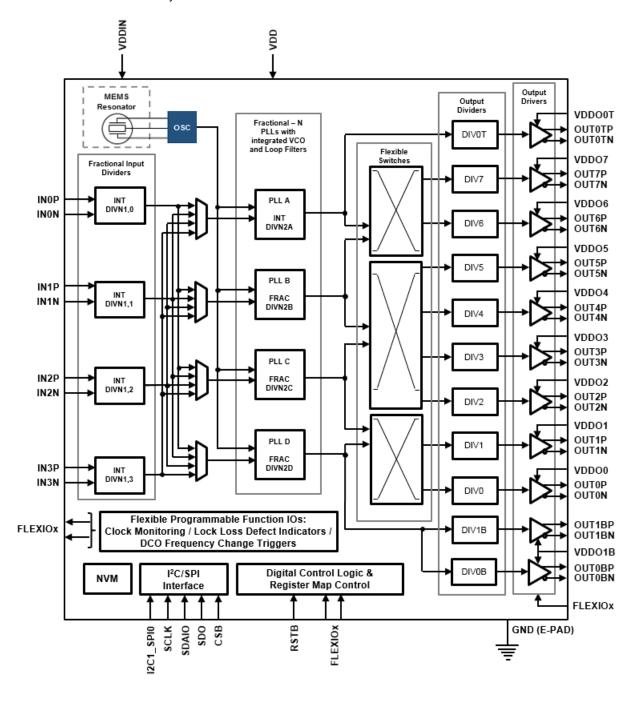


Figure 10. Overall Architecture



The digital architecture of the chip is partitioned into a master digital controller and seven slave controllers. The master controller and each of the seven controllers has an associated volatile programmable interface (PIF). The overall programmable interface PIF structure is a register map that is divided into several pages according to function. Each controller (master and slaves) has an associated unique Page number. Each Page has an independent 8 bit addressable PIF memory.

In all the pages, the last address, FF, holds the current page number and is reserved for changing the page. The current page to be communicated with can be set by writing the page number in hexadecimal form {0x00, 0x01, 0x02, 0x03, 0x0A, 0x0B, 0x0C, 0x0D} corresponding to pages {0, 1, 2, 3, A, B, C, D} in the address FF on any page. Table 18 shows a summary of the PIF contents residing on each page.

Table 19. PIF Description

Page	What?	Summary of Contents
0	Master	All Generic Information related to the chip Chip Configuration details Control for the master sequencer FSM MEMS Oscillator Reference Related Information
		Fuse Pointer for each of the remaining pages
1	ClkMon Slave	Clock Loss related function Frequency Drift related function
2	Input Slave	Input 3 / 2 / 1 / 0 related information (Input type, DIVN1 divider configuration)
3	Output Slave	Flexible Outputs 7 / 6 / 5 / 4 / 3 / 2 / 1 / 0 (ODR Standards, DIVO, Programmable delay configurations for each)
		Fixed Outputs 0T / 0B (ODR Standards, DIVO, Programmable delay configurations for each)
А	PLL A Slave	All PLL related functionality
В	PLL B Slave	All PLL related functionality
С	PLL C Slave	All PLL related functionality
D	PLL D Slave	All PLL related functionality



Frequency Configuration

The hierarchy of the clocks, nomenclature of the various frequency dividers, and the clock translation pathways available on the chip are shown in Figure 9.

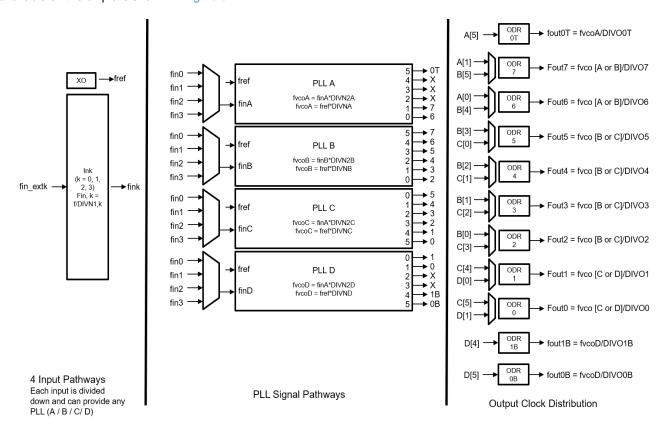


Figure 11. Overall Hierarchy of Clocks



The four input clocks with frequency fin_extk translate to PLL input clocks fink following division by the respective input dividers with fractional or integer frequency division ratios DIVN1k where the index $k \in \{0, 1, 2, 3\}$.

See Figure 10. Each of the PLLs chooses one of the four divided input clocks fink as its active input clock and sets the priority for up to three spare clocks from the remaining three input clocks if required for hitless switching to a redundant input.

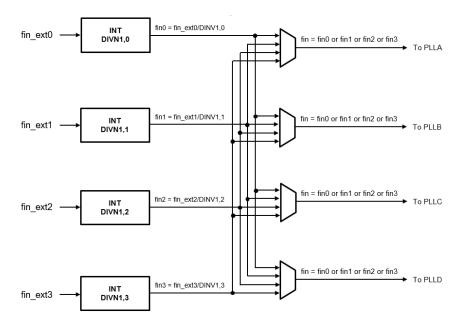


Figure 12. Input Clock Distribution

Each PLLx ($x \in \{A, B, C, D\}$) has a high frequency VCO whose frequency is determined in the free run mode by fref. In the frequency translation synchronized mode, the VCO frequency is corrected from its free run frequency.

Each of the Output Drivers (ODRj, j ϵ {0:7}) chooses an appropriate VCO frequency and divides it using their respective integer divider DIVOj to get the output frequency foutj. See Figure 11.



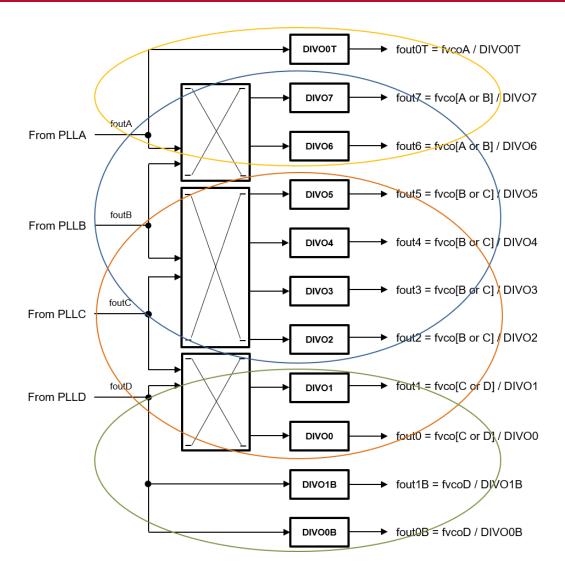


Figure 13. Output Clock Distribution

The choice of the fractional dividers as well as the placement of foutj frequencies at various outputs is defined during chip configuration.



Master and Slaves: Architecture Description and Programming Procedures

The Master controller is the first system to autonomously wake up on the application of power to the chip due to onchip power on reset circuitry. All generic system information resides in the Master controller memory and it proceeds to wake up the Slaves as required based on this information. The relative wake up sequences of the Master and the various Slaves are described in more detail later in this section after a description of the memory structures. A complete power up of the chip is also emulated with the release of an active low hard reset (RSTB) from pin while selective Master and Slave sub-system resets are enacted from software using the serial interface (I²C / SPI).

The Master memory structure is shown in Figure 12. It contains a one-time programmable non-volatile memory (NVM) that stores the settings for the chip associated with the master controller. The master controller also contains a

volatile PIF bank (NVMCopy) that has an exact copy of the NVM at every chip power up. This volatile PIF (NVMCopy) is the memory that is addressable using the serial interface (I²C / SPI) on Page 0 and can be overwritten from the I²C / SPI interface. The "Chip Settings" is the memory space that is not addressable from the I2C / SPI control and is the actual control for the chip. The NVM contains a two bit "Lock Pattern" that can be set to "10" or "01" to 'lock' the chip configuration once the final configuration is determined and wake up of the entire chip is desired in this configuration. Additionally, there is a bit in the NVM that is an active low indicator of a manual wake up. This bit set to "1" along with the 'lock' for the configuration leads to an autonomous wake up of the chip using the 'locked' configuration. Any number of different configurations can alternatively be tried at all times using only the volatile NVMCopy PIF section. This is useful for evaluations as well as allowing real time programming of the chip in various configurations with complete flexibility. The Master Controller finite state machine (FSM) described later in this section controls the device behavior in accordance with the configuration in this memory structure and as per the wake up mode.

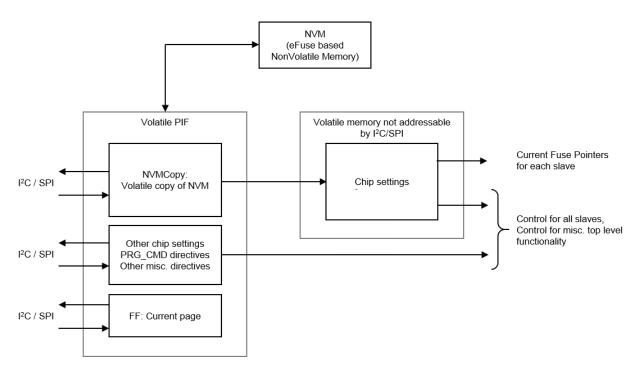


Figure 14. Master Memory Structure

The memory structure for each slave is shown in Figure 13 and is similar in construction to the master controller memory structure with some minor differences. The NVMCopy volatile PIF for the slave is addressable by the serial interface with the unique Page number associated with the slave. The "Slave Settings" is the memory space that is not addressable from the I²C / SPI control and is the actual control for the slave. Each Slave

has a two time programmable NVM by virtue of two copies of the NVM memory. This makes the slave settings two time programmable with the fuse pointer from the master controller determining which of the two NVM banks is used. The presence of two NVM banks is transparent to the slave controller since the current pointer which determines which of the two NVM banks is used is set by the master controller independently.



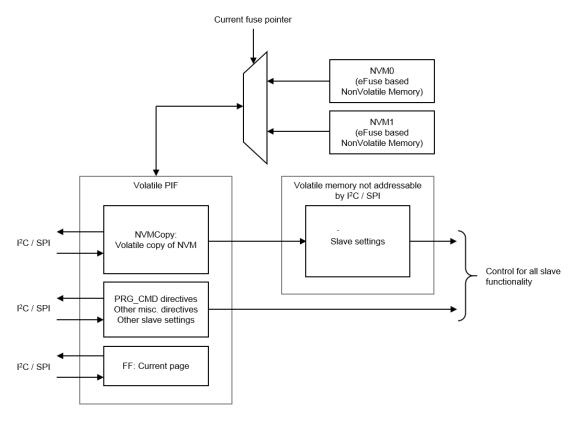


Figure 15. Slave Memory Structure

The Master Wake-Up Finite State Machine (FSM) is shown in more detail in Figure 14. At every power up of the device (or release from hard reset), the power-on-reset circuitry resets all systems and then autonomously releases only the master controller from reset. The NVM contents are copied to the NVMCopy volatile space on Page 0 which is in turn copied to the "Chip Settings". The master controller now decides if the chip configuration is locked and it is an autonomous wake up of the entire chip or if a manual wake up is desired through the PIF based on the contents in the "Chip Settings".

In case a "Lock" is detected and an autonomous wake up is desired, the Master controller proceeds to enable the MEMS oscillator and associated fref pathways followed by the Slave systems in a pre-determined sequence. This finally leads the chip to the "Active State" with all desired outputs available as a result of all slave systems released from reset by the master controller. This is according to the requested settings that are programmed in the Master and the Slave NVM banks.

For the case where the final chip settings are not frozen hence the "Lock" pattern is not exercised, the master controller FSM reaches the Program Command Wait State (PRG_CMD). The desired chip settings can be written in the NVMCopy on Page 0 using the serial interface and desired slave sub-systems can be enabled. Several

PRG_CMD state directives are available that are exercisable only in this state (refer to Figure 14). Using these directives, the desired settings written in NVMCopy can now be copied to "Chip Settings" followed by issuing the directive for the FSM to proceed to the "Active" state where each slave can now be manually written with the desired settings and in turn asked to proceed to its "Active" state.

A similar "Lock" pattern is available in the NVM bank of each slave. The currently used NVM bank for a slave (as determined by the current pointer from the master controller) can be locked for the autonomous wake up of each slave. The slave wake-up FSM is shown in Figure 15 and it similarly has a PRG_CMD state with associated directives. On Proceed to Active state directive on the slave, the slave controller wakes up the various blocks in its sub-system with the correct pre-determined sequence.

The NVM bank for the master and each slave can be programmed with a PRG_CMD directive in that state to lock a configuration / setting specific to the respective subsystem.



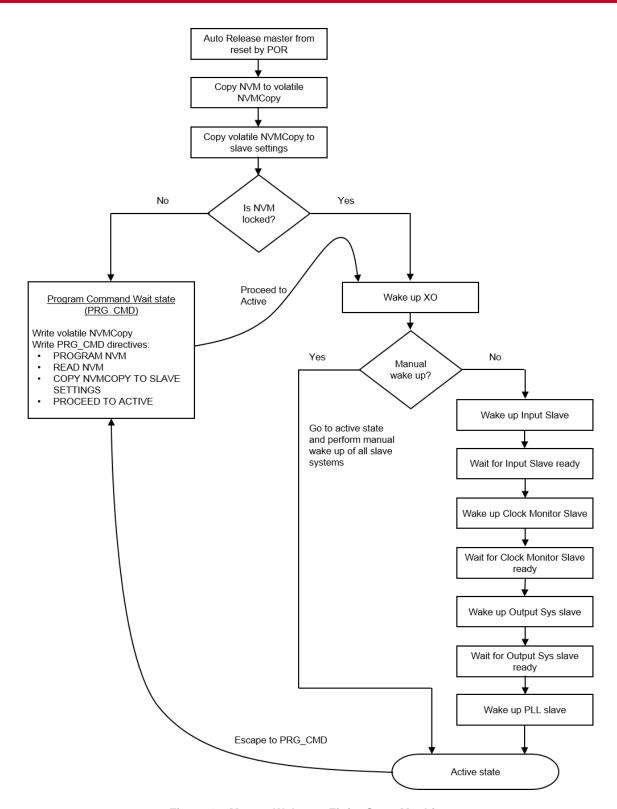


Figure 16. Master Wake-up Finite State Machine



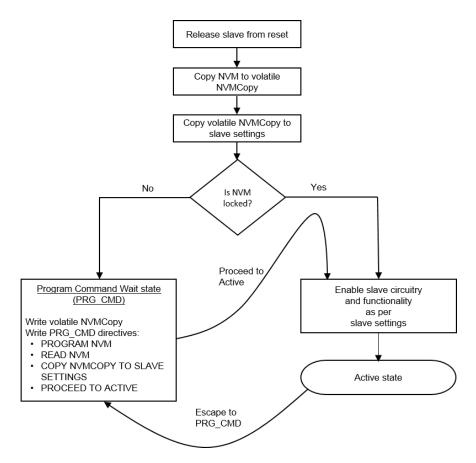


Figure 17. Slave Wake up Finite State Machine

Each FSM (Master and Slaves) allows an escape sequence to go back to PRG_CMD state from its Active State. This can be used to selectively change the settings for that particular sub-system. Such an escape to the PRG_CMD state in the master FSM can be used for example to change current NVM pointers for any of the slaves.

Note that the NVM for the master controller and current NVM for all slaves should be locked after writing desired settings for a completely autonomous wake up of the entire chip. The NVM pointer can then be changed for any slave independently if alternate settings are desired for that slave. In that case, the new NVM is unlocked and can be written with new settings and locked. For evaluations of the chip as well as cases where flexible on-the-fly programmable settings are desired, the chip can be used without engaging the NVM banks at all by using the NVMCopy space for the master and each slave in conjunction with the PRG_CMD directives. It is also possible to lock some of the slaves (to not re-write their settings for each wake up) while use programmable settings for other slaves.

This provides complete flexibility in terms of programming and using the chip in all scenarios.



Input Slave Description

Four independent clock inputs are available on the chip that can be routed to any PLL with complete flexibility. Both single ended and AC coupled differential clock inputs are possible. The input clock receiver settings (to receive a single ended or differential clock) as well as the input clock divider settings are configurable on Page 2 that is assigned to the Input Slave. It is possible to bypass the input clock divider and use the input clock directly as an input to the PLL.

Clock Monitor Slave Description

Various fault monitoring indicators are available on the chip. The Clock Loss and the Frequency Drift indicators are configurable with the Clock Monitor Slave that is accessible on Page 1. The specifications of these fault monitors are indicated in the specifications section of the data sheet.

Defect monitoring on any of the clock monitors can be accessed using multiple techniques. The current status of the defect is available as an Active High defect that can be read from the PIF. The "status" is a current indicator of the defect that is high only during the defect (for example during the time that a Clock Loss event is on-going). Additionally, a sticky indicator of the defect called "Notify" can be enabled in the PIF. In this case, the concerned "notify" bit is high the first time the respective defect occurs and stays high till cleared.

There are multiple FLEXIOs (Flexible IOs) available in the system that can be programmed to monitor individual "notify" signals or a combination of them (as an OR logic). The choice of which fault defect is monitored as an output on the FLEXIO pin is flexible and can be programmed. Additionally there are selected GPIOs that are hard coded for the information for the clock defects.

Fault Monitoring System

The SiT95148 part provides an elaborate arrangement of fault monitoring indicators. There are 4 categories of clock monitoring that are necessary for the chip namely: Clock Loss Monitor (CL), Frequency Drift Monitor (FD), Lock Loss Monitor (LL) and XO Clock Loss Monitor (CL_XO).

Clock Loss (CL) monitors loss of input clocks defined as a pre-determined number of consecutive edges missing.

Frequency Drift (FD) monitors frequency drift of a particular clock against a pre-determined Golden Reference.

Lock Loss (LL) monitors the loss of lock in any PLL by monitoring the difference in frequency between the feedback and input clocks.

XO Clock Loss (CL_XO) monitors the loss of the XO reference that is generated from an external oscillator (XO / TCXO / OCXO) .

Each of these categories monitors the health of a particular clock for a certain failure type as illustrated in the name of the clock monitoring category.

For each clock failure observed by the clock monitor block there are two types of indicators provided to the user using the register map:

- Live Failure Bit: There is a bit to indicate the live status of a particular failure. [Status]
- 2) Sticky Failure Bit: For each live failure bit there is a corresponding sticky bit that is set the first time that corresponding failure is encountered and stays set even if the failure has gone away. Only when the user clears the bit does it clear. [Notify]

The status of these can be either read from the register map or from the pins as a dynamic alarm monitoring arrangement. Additionally, sticky notify registers are available which have sticky status read back from the register map for the various defects. These can be selectively chosen to create an INTRB de-assertion on the INTRB pin as well.

An important point to note is that all of the fault monitoring indicators mentioned above that work with respect to the input clock work on the divided input clock post the DIVN1,k dividers. This implies that the fault monitoring indicators use the frequency fink that is input to the PLL (k ε {0, 1, 2, 3}) post the DIVN1,k divider translation rather than the external frequencies fin_extk (k ε {0, 1, 2, 3}).

Alarm Registers' Information section describes the read back of the alarms for the various fault monitoring arrangements using the chip register map.

Clock Loss Monitors

Each of the 4 inputs (IN0, IN1, IN2, IN3) are monitored for Clock Loss in terms of missing edges to indicate a loss of input signal. The number of edges used to indicate a clock loss (or recovery from a clock loss) is programmable in the Cascade GUI interface allowing for flexibility in choosing these thresholds. In addition there is a programmable "Wait Time" all of which are to be interpreted as follows:

Assertion of Clock Loss-

We declare a CL if "Trigger Edge" number of consecutive edges are missing. The "Trigger Edge" parameter is programmable in the chip GUI.

De-Assertion of Clock Loss-

We declare a ~CL if the clock is back and has less than "Clear Edge" consecutive edges missing. The "Clear Edge" parameter is programmable in the chip GUI.

Wait Time: After the clock is established to have returned, it is ensured that no CL error as defined by the de-assertion threshold occurs for "Val Time" seconds. This valid wait time is programmable using the chip GUI using the "Val Time" parameter which is programmable from the following options: {2m, 100m, 200m, 1} sec. The use of the this valid wait time ensures that sporadic edges in the input clock (such as ones caused by noise on floating nodes or intermittent unstable clock edges) does not de-assert clock loss and it is established over a user determined period of time that the input clock is available and stable.



Frequency Drift Monitors

Any one of the 4 input clocks or the XO clock can be used as the Golden Clock for calculating the frequency drifts of the other 4 clocks. The Golden Clock can be chosen in the GUI and is used as the "0 ppm" Reference Clock for all monitoring. Fine Frequency Drift has a step size of ±2 ppm.

Fine Frequency Drift has a range of ±2 to ±510 ppm and an independent threshold is programmable for "Set" (for setting the FD monitor) and for "Clear" (for clearing the FD monitor).

Fine Frequency Drift has an implicit hysteresis with resolution of ± 2 ppm since the same range is available for the FD assertion and de-assertion. Use of hysteresis prevents unwanted oscillation of the FD monitor output at the decision threshold and is recommended for robust operation. The value of the FD threshold hysteresis is implicit in the choice of the set and clear thresholds.

The Fine Frequency Drift monitors provide precise information for input clock frequency drift. However, since the resolution of the measurement determines time for the measurement — an alternate faster measurement mechanism for drift is needed. This is Coarse Frequency Drift which has coarser measurement but is fast. It is available for cases where the drift is very fast in the input frequency and is programmable from options as shown below.

Coarse Frequency Drift has a step size of ±100 ppm.

Coarse Frequency Drift has a range of ±100 to ±1600 ppm and an independent threshold is programmable for "Set" (for setting the FD monitor) and for "Clear" (for clearing the FD monitor).

Coarse Frequency Drift has an implicit hysteresis with resolution of ±100 ppm since the same range is available for the FD assertion and de-assertion. Use of hysteresis prevents unwanted oscillation of the FD monitor output at the decision threshold and is recommended for robust operation. The value of the FD threshold hysteresis is implicit in the choice of the set and clear thresholds.

Important Note regarding the above monitors with respect to clock switch in the PLL:

Normally the CL monitor is used for ascertaining a clock is lost for the PLL to switch to a secondary reference or proceed to Holdover. However, the Fine and/or Coarse FD monitors can also be used in addition to the CL monitor to cause a PLL switch. This implements an "OR" logic for the FD Monitors to be used in addition to the CL monitors for triggering a PLL input clock switch or entry to Holdover. This is programmable as an option in the GUI.

Lock Loss Monitors

Lock loss is programmable for each PLL with lock loss triggered if the frequency of the input reference to the PLL phase detection arrangement and the feedback clock to same PLL are different as per the programmed assertion and de-assertion thresholds.

The Set threshold for asserting the LL monitor is programmable from {±0.2, ±0.4, ±2, ±4, ±20, ±40, ±200,

 ±400 , ±2000 , ±4000 } ppm while the Clear threshold for de-asserting the LL monitor is programmable from $\{\pm0.2, \pm0.4, \pm2, \pm200\}$ ppm. A pre-determined level of hysteresis is implicit by choosing appropriately the set and clear thresholds for the LL monitor.

Additionally from the point of view of LL de-assertion, there is a delay from the point in time that lower than the specified ppm value is achieved to the point where the actual LL is de-asserted to the user such that LL never asserts during this delay period. The choice of this delay is with a timer that ensures that the delay is in line with the BW of the PLL loop. It is fully programmable from the GUI and is useful to ensure complete settling of the PLL without un-necessary toggling before LL de-assertion.

Output Slave Description

The Output Slave accessible on Page 3 is used to configure the output divider (DIVO) and output standard for each output individually. The output load and terminations for each differential output standard are shown in the Output Terminations section of the data sheet. The LVDS and LVDS Boosted modes are recommended for AC coupled termination loads with the termination at the far end. Additionally, an internal termination mode for differential outputs is available where the resistive terminations are internally provided and a differential output is available that can be AC coupled to a clock receiver. The differential clock output pins are shared for LVCMOS outputs as well. LVCMOS outputs can be either enabled on both outputs individually or on any one of the two differential outputs {OUTjP, OUTjN}. The LVCMOS outputs can be used inphase or out-of-phase on {OUTjP, OUTjN} in case both outputs are chosen. Out of phase LVCMOS toggling on the complementary outputs is recommended for best spur performance.

PLL Bandwidth

Each PLL Slave independently chooses the Bandwidth for jitter attenuation from 1 mHz to 4 kHz. This is the bandwidth that is normally used for steady state operation.

Fast Lock

An independent choice for a fast bandwidth is also available that can be used for speeding up the initial lock. After the PLL lock is achieved and the system is in the synchronized mode, the bandwidth is automatically transitioned to the steady state jitter attenuation bandwidth. This feature avoids the abnormally large wake up times that may be needed for very low PLL bandwidths. For stability considerations of the PLL, the fast lock bandwidth or regular bandwidth for the PLL should be no larger than 1/100th of the input frequency at the input of the PLL (post the DIVN1k dividers).

Operation Modes

There are three distinct modes of operation of the PLL: free run mode, synchronized mode and holdover mode. The frequency of the high frequency VCO in the PLL is determined by the specific mode of operation. The state diagram with the modes of operation is showing on the Figure 14.



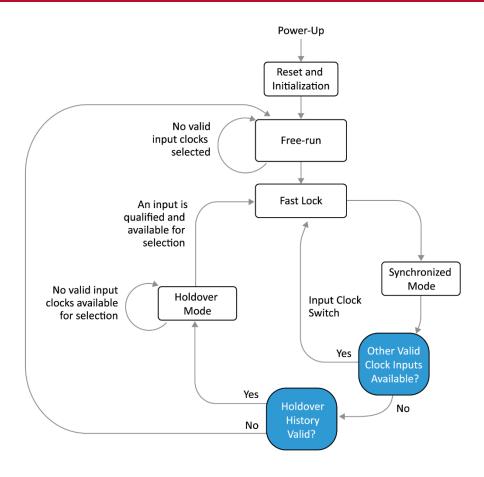


Figure 18. Operation Modes



Device Start-Up and Initialization

After powering up the device begins an initialization period where it downloads default register values and configuration data from NVM. No clocks will be generated until the initialization is done. Communicating with the device through the serial interface is possible once this initialization period is complete. A complete power up of the chip is also emulated with the release of an active low hard reset (RSTB) from pin.

Free run mode

The PLL in the free run mode can be described as a MEMS based oscillator where the output frequency is determined by the relation fVCOx = DIVNx*fref. This is the mode of operation before the loop is locked to the selected input clock or the mode of operation for the case none of the input clocks is available.

Synchronized mode

After locking to the chosen input clock, the PLL enters the synchronized mode of operation where the output is now locked to the input frequency with the relation fVCOx = DIVN2x*finx. The PLL Loop that synchronizes (locks) the output to the input clock has a programmable loop bandwidth between 1 mHz to 4 kHz and is not affected by static or dynamic drifts in the MEMS oscillator based fref frequency. In synchronized mode, the PLL is able to lock to a Gapped Input clock with some edges missing producing a smooth output clock without any gaps with the requested frequency translation from input to output. Frequency translation ratios in this case should be specified with respect to the average input frequency of the gapped clock rather than the faster instantaneous frequency.

Holdover mode

In case the input clock is lost, the PLL locks to the highest priority spare clock available. If all specified input clocks are lost the PLL remembers the correction based on historical average of the input clock as specified in Table 6 to enter the Holdover mode of operation. When the PLL is exiting the Holdover mode the frequency ramp feature can be enabled that ramps the output frequency of the PLL at a slope that is programmable to one of the following 4 settings: {0.2, 2, 20, 40000} ppm/s. The same ramp settings are used for input switching.

DCO Mode operation

The Digitally Controlled Oscillator (DCO) mode of operation is used for changing the output frequency of a PLL using software control on the serial interface or pin control. A predefined change in frequency is programmed in the PIF of the respective PLL. After programming, an increase (FLEXIO13) or decrease (FLEXIO8) command can be given on the PIF of the same PLL to make the change in output frequency effective. A low to high transition (as an edge detect) is used for the trigger of the DCO increment or decrement. Any relative change in frequency from as fine as 5 ppt to as coarse as 100 ppm is available with the DCO mode. DCO mode is available in both free run and synchronized modes of operation.

PLL MEMS Oscillator Reference

An internal MEMS oscillator circuitry is used to produce the fref clock for the system.

Inputs

Four independent clock inputs are available on the device that can be routed to any PLL with complete flexibility. Both single ended and AC coupled differential clock inputs are possible. The input clock receiver settings (to receive a single ended or differential clock) as well as the input clock divider settings are configurable on Page 2 that is assigned to the Input Slave. It is possible to bypass the input clock divider and use the input clock directly as an input to the PLL.

Automatic Input Selection

Each PLL chooses its clock priority in terms of the four input clocks. This is programmed in to the Clock Monitor slave memory. The PLL Slave then looks at Clock Loss status from the Clock Monitor slave to lock to the highest priority available clock to lock. Three spare clocks with an order of priority can be specified in case the highest priority active clock is not available.

Manual Input Selection

A forced manual selection of the active clock with no spares is possible. Less than three spares can also be specified making the clock priority arrangement completely flexible in terms of choosing the input clock for operation.

Hitless Input Switching

Phase Build Out Mode of hitless switching ensures that phase transients are not propagated to the output (the phase difference between redundant input clocks is absorbed by the PLL) and desired MTIE characteristics are seen in the output clock. This is the default mode of hitless switching for the PLL. The transition of input clock for a PLL from one clock to another is hitless in nature (with maximum phase hit limited to be less than 50 ps) for the case of the switched input clocks being same in frequency. Hitless switch is also supported for the switched clocks being fractionally related such that the same frequency can be obtained for both clocks at the input of the PLL using the input clock dividers (DIVN1k).

An alternate mode of hitless switching is the Phase Propagation mode where the phase difference between redundant input clocks is not absorbed by the PLL but is rather propagated to the output. The phase difference that is propagated to the output can either be allowed to propagate as per the PLL bandwidth or can be limited to a phase propagation slope that is programmable to one of the following 3 settings: {10, 40, 160} us/s.

Ramped Input Switching

For redundant input clocks to the PLL that are not exactly the same frequency (plesiochronous clocks), the frequency ramp feature can be enabled that ramps the output frequency of the PLL at a slope that is programmable to one of the following 4 settings: {0.2, 2, 20, 40,000} ppm/s. For redundant input clocks to the PLL that are exactly the same frequency, the frequency ramp feature should not be enabled.



Input Clocks

The recommended Input Clocks termination schemes are shown in figures below.

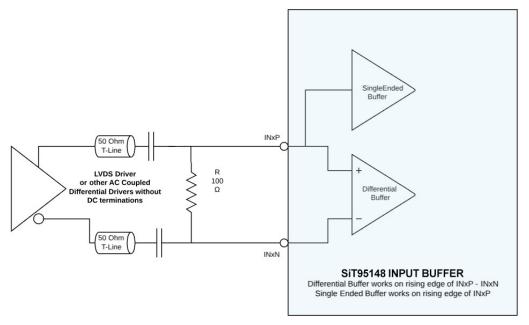


Figure 19. AC Coupled Differential LVDS Input or Other AC Coupled Driver without DC Terminations

- Uses Differential Buffer Pathway

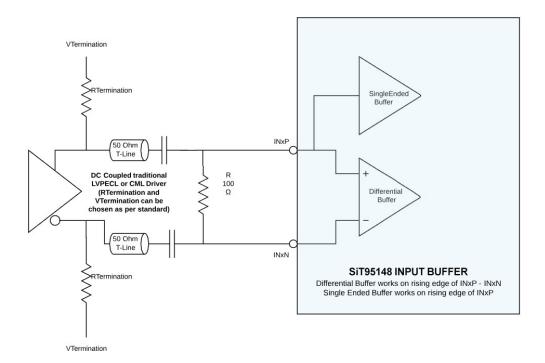


Figure 20. AC Coupled Differential LVPECL or CML (Resistor and Voltage termination is as per the standard)

- Uses Differential Buffer Pathway



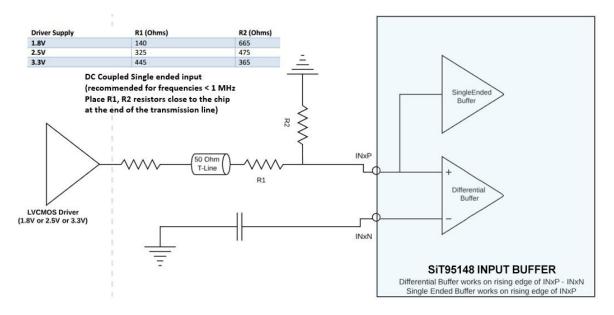


Figure 21. DC Coupled Single Ended Driver

– Uses Single Ended Buffer Pathway^[46]

Note:

48. Recommended for non-standard duty cycle applications. Please refer above table for the recommended resistor values for frequencies < 1 MHz.

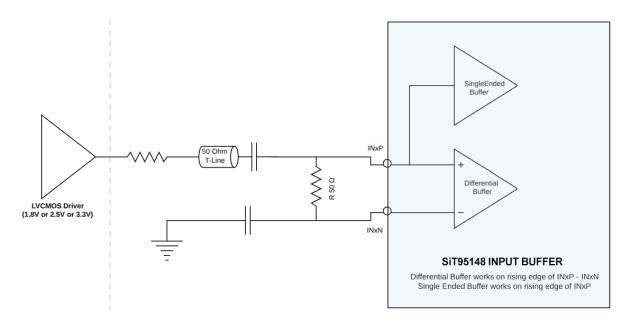


Figure 22. AC Coupled Single Ended Driver with 50 Ω Termination on receiver (chip) side

Note

49. Uses Single Ended Buffer pathway in AC coupled mode.



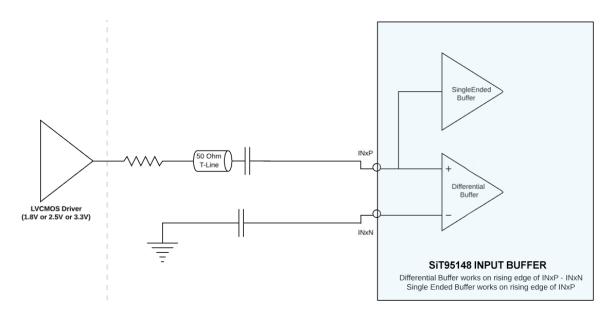


Figure 23. AC Coupled Single Ended LVCMOS input without 50 Ω Termination

Note:

50. Uses Single Ended Buffer pathway in AC coupled mode. The LVCMOS driver in this case needs to ensure source termination to match to the transmission line.



Clock Monitoring

Various fault monitoring indicators are available in the device. The Clock Loss indicator is configurable with the Clock Monitor Slave that is accessible on Page 1. The specifications of these fault monitors are indicated in Table 10.

Defect monitoring on any of the clock monitors can be accessed using multiple techniques. The current status of the defect is available as an Active High defect that can be read from the PIF. The "status" is a current indicator of the defect that is high only during the defect (for example during the time that a Clock Loss event is on-going). Additionally, a sticky indicator of the defect called "Notify" can be enabled in the PIF. In this case, the concerned "notify" bit is high the first time the respective defect occurs and stays high till cleared.

PLL Lock Loss is another fault monitor whose specifications are available in Table 10. Various programmable thresholds are available that can be used to detect lock loss in the PLL. Lock loss is indicated by the programmable drift between the frequency of the input clock for the PLL and the divided VCO clock. This defect can be tracked with status, notify and on the FLEXIOs.

There are multiple FLEXIOs (Flexible IOs) available in the system that can be programmed to monitor individual "notify" signals or a combination of them (as an OR logic). The choice of which fault defect is monitored as an output on the FLEXIO pin is flexible and can be programmed.

Fault Monitoring System

The SiT95141 part provides an elaborate arrangement of fault monitoring indicators. There are 4 categories of clock monitoring that are necessary for the chip namely: Clock Loss Monitor (CL) and Lock Loss Monitor (LL).

Clock Loss (CL) monitors loss of input clocks defined as a pre-determined number of consecutive edges missing.

Lock Loss (LL) monitors the loss of lock in any PLL by monitoring the difference in frequency between the feedback and input clocks.

Each of these categories monitors the health of a particular clock for a certain failure type as illustrated in the name of the clock monitoring category.

For each clock failure observed by the clock monitor block there are two types of indicators provided to the user using the register map:

- 1) Live Failure Bit: There is a bit to indicate the live status of a particular failure. [Status]
- 2) Sticky Failure Bit: For each live failure bit there is a corresponding sticky bit that is set the first time that corresponding failure is encountered and stays set even if the failure has gone away. Only when the user clears the bit does it clear. [Notify]

The status of these can be either read from the register map or from the pins as a dynamic alarm monitoring arrangement. Additionally, sticky notify registers are available which have sticky status read back from the register map for the various defects. These can be selectively chosen to create an INTRB de-assertion on the INTRB pin as well.

An important point to note is that all of the fault monitoring indicators mentioned above that work with respect to the input clock work on the divided input clock post the DIVN1,k dividers. This implies that the fault monitoring indicators use the frequency fink that is input to the PLL (k \in {0, 1, 2, 3}) post the DIVN1,k divider translation rather than the external frequencies fin_extk (k \in {0, 1, 2, 3}).

The Alarm Registers' Information section describes the read back of the alarms for the various fault monitoring arrangements using the chip register map.

Clock Loss Monitors

Each of the 4 inputs (IN0, IN1, IN2, IN3) are monitored for Clock Loss in terms of missing edges to indicate a loss of input signal. The number of edges used to indicate a clock loss (or recovery from a clock loss) is programmable in the Cascade GUI interface allowing for flexibility in choosing these thresholds. In addition there is a programmable "Wait Time" all of which are to be interpreted as follows:

Assertion of Clock Loss-

A CL is declared if "Trigger Edge" number of consecutive edges is missing. The "Trigger Edge" parameter is programmable in the chip GUI.

De-Assertion of Clock Loss-

A ~CL is declared if the clock is back and has less than "Clear Edge" consecutive edges missing. The "Clear Edge" parameter is programmable in the chip GUI.

Wait Time: After the clock is established to have returned, it is ensured that no CL error as defined by the de-assertion threshold occurs for "Val Time" seconds. This valid wait time is programmable using the chip GUI using the "Val Time" parameter which is programmable from the following options: {2m, 100m, 200m, 1} sec. The use of the this valid wait time ensures that sporadic edges in the input clock (such as ones caused by noise on floating nodes or intermittent unstable clock edges) does not de-assert clock loss and it is established over a user determined period of time that the input clock is available and stable.

Lock Loss Monitors

Lock loss is programmable for each PLL with lock loss triggered if the frequency of the input reference to the PLL phase detection arrangement and the feedback clock to same PLL are different as per the programmed assertion and de-assertion thresholds.

The Set threshold for asserting the LL monitor is programmable from $\{\pm0.2, \pm0.4, \pm2, \pm4, \pm20, \pm40, \pm200, \pm400, \pm2000, \pm4000\}$ ppm while the Clear threshold for de-asserting the LL monitor is programmable from $\{\pm0.2, \pm0.4, \pm2, \pm200\}$ ppm. A pre-determined level of hysteresis is implicit by choosing appropriately the set and clear thresholds for the LL monitor.

Additionally from the point of view of LL de-assertion, there



is a delay from the point in time that lower than the specified ppm value is achieved to the point where the actual LL is de-asserted to the user such that LL never asserts during this delay period. The choice of this delay is with a timer that ensures that the delay is in line with the BW of the PLL loop. It is fully programmable from the GUI and is useful to ensure complete settling of the PLL without un-necessary toggling before LL de-assertion.

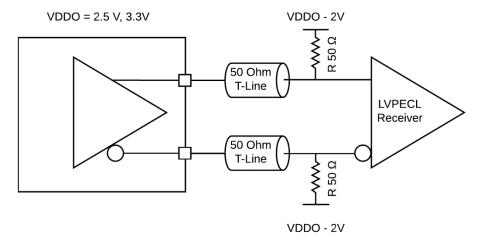
Outputs

The Output Slave accessible on Page 3 is used to configure the output divider (DIVO) and output standard for each output individually. The output load and terminations for each differential output standard are shown in the Differential Output Termination Information section. Additionally, an internal termination mode for differential outputs is available where the resistive terminations are internally provided and a differential output is available that can be AC coupled to a clock receiver. The differential clock output pins are shared for LVCMOS outputs as well. LVCMOS outputs can be either enabled on both outputs individually or on any one of the two differential outputs (OUTjP, OUTjN). The LVCMOS outputs can be used inphase or out-of-phase on (OUTjP, OUTjN) in case both outputs are chosen.



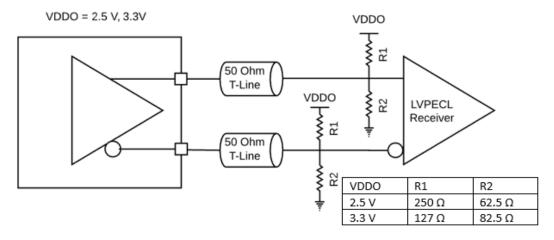
Differential Output Termination Information

LVPECL



Spec	Conditions	Min	Typical	Max
Output Differential Peak	Measured at 156.25M Output	450 mV	750 mV	

Figure 24. LVPECL with DC-coupled Termination

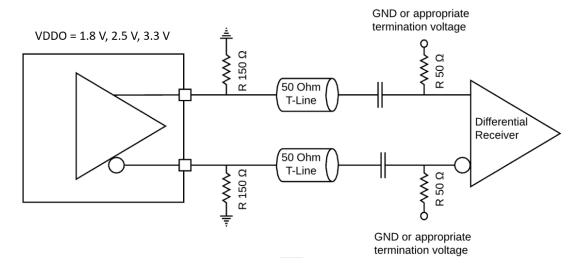


Spec	Conditions	Min	Typical	Max
Output Differential Peak	Measured at 156.25M Output	450 mV	750 mV	

Figure 25. LVPECL DC-coupled Load Termination with Thevenin Equivalent Network



LVPECL (continued)



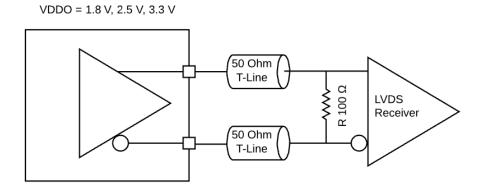
Spec	Conditions	Min	Typical	Max
Output Differential Peak	Measured at 156.25M Output	335 mV	525 mV	

Figure 26. LVPECL2 for the SiT95148 Output Driver with AC Termination at the Load



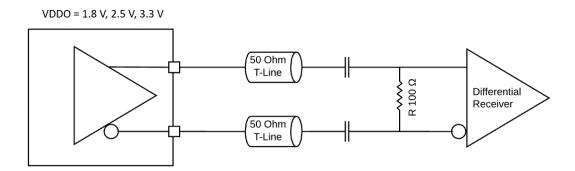
Differential Output Termination Information (continued)

LVDS



	Spec	Conditions	Min	Typical	Max
Output	Differential Peak	Measured at 156.25M Output	247 mV	350 mV	474 mV

Figure 27. LVDS DC Termination at the Load

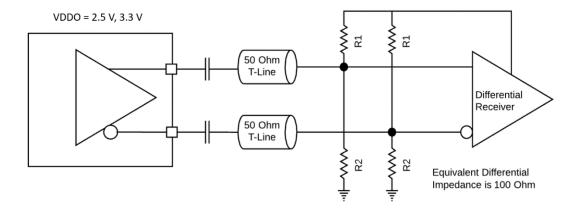


Spec	Conditions	Min	Typical	Max
Output Differential Peak	Measured at 156.25M Output	250 mV	350 mV	600 mV

Figure 28. LVDS AC Termination at the Load



LVDS (continued)



Spec	Conditions	Min	Typical	Max
Output Differential Peak	Measured at 156.25M Output	500 mV	700 mV	

Figure 29. LVDS Boost Standard for the SiT95148 Output Driver with AC Termination at the Load



Differential Output Termination Information (continued)

HCSL

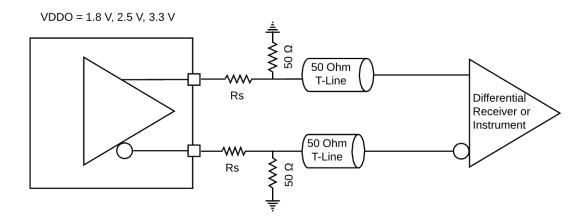
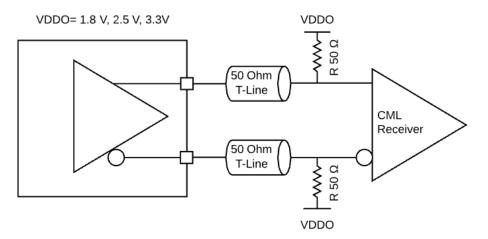


Figure 30. HCSL Interface Termination^[49]

Note:

51. R_S is sometimes used for limiting overshoot, and can be 0 Ohm.

CML



Spec	Conditions	Min	Typical	Max
Output Differential Peak	Measured at 156.25M Output	250 mV	350 mV	600 mV

Figure 31. CML Interface Termination



Differential Output Termination Information (continued) LVCMOS

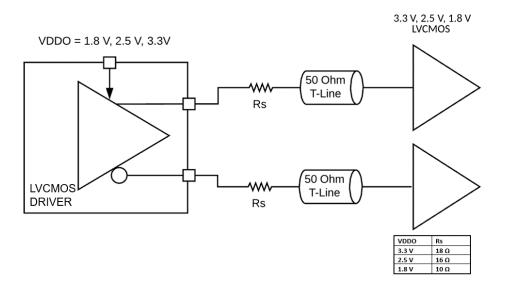


Figure 32. LVCMOS output Termination

Additionally, an internal termination mode for differential outputs is available where the resistive terminations are internally provided and a differential output is available that can be AC coupled to a clock receiver. The differential clock output pins are shared for LVCMOS outputs as well. LVCMOS outputs can be either enabled on both outputs individually or on any one of the two differential outputs {OUTjP, OUTjN}. The LVCMOS outputs can be used inphase or out-of-phase on {OUTjP, OUTjN} in case both outputs are chosen.



Output Delay Control

By default, all output clocks are phase-aligned. A delay path associated with each of Fractional Input Dividers (see Figure 31) is available for applications that need a specific output skew configuration. This is useful for PCB trace length mismatch compensation. The resolution of the phase adjustment is 35 ps definable in a range of 7.5 ns. Phase adjustments are register-configurable. All phase delay values are restored to their default values after power-up, hard reset, or a reset using the RSTB pin. Phase delay default values can be written to NVM, allowing a custom phase offset configuration at power-up or after power-on reset, or after a hardware reset using the RSTB pin.

Zero Delay Mode

Zero Delay Mode is used in applications that require minimum delay between the selected input and outputs. Zero Delay Mode is available on any of the 4 PLLs by routing the output clock back to the IN3 input as shown in Figure 31. This ensures minimum delay between the input and output. It can be used for any of the four PLLs. This provides the option to close the feedback loop of the PLL on the PCB and therefore bypasses the internal feedback dividers, thereby cancelling delays introduced by internal dividers and clock distribution pathways. The IN3 input pins are used as the external feedback and one of the outputs from the PLL that is being set up in zero delay mode should be routed to the IN3 differential inputs. It is recommended to use IN0 as the input clock when using IN3 as the external feedback clock in the zero delay mode. The terminations used for IN3 depend on the driver type chosen. The preferred option is to use an LVDS or LVDS boost output ac coupled into a differential 100 Ω termination at the IN3 input side.



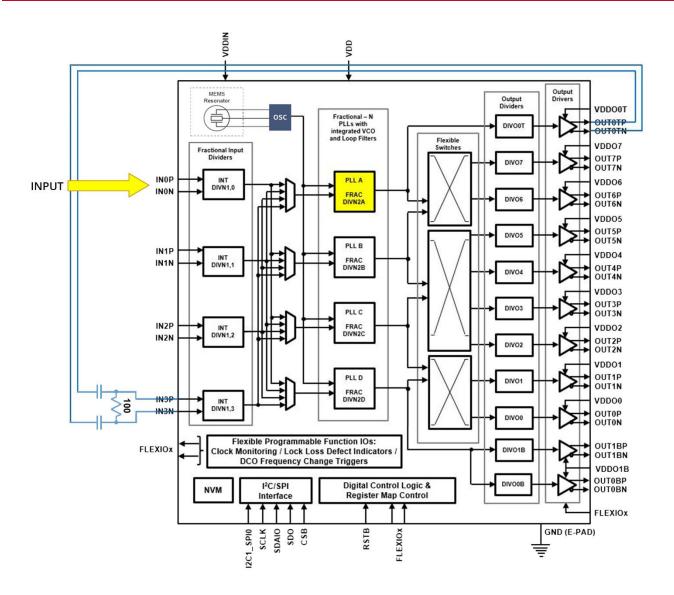


Figure 33. SiT95148 Zero Delay Mode Setup

Low Wander Mode

A Low Wander Mode (LWM) is the mode that combines the best jitter from TCXO/OCXO MEMS resonator clocks. This dual loop PLL configuration leverages the lower TCXO/OCXO close-in phase noise (PN) with the lower further out PN of the embedded MEMS resonator. The LWM implementation is shown in Figure 32, in which PLLA generates a low wander reference for the rest of the PLLs. Any or all PLLs B, C, D can operate in LWM. Wander on the input clocks to any of the 3 PLLs is attenuated with PLL bandwidth (BW) set to less than 10 Hz.



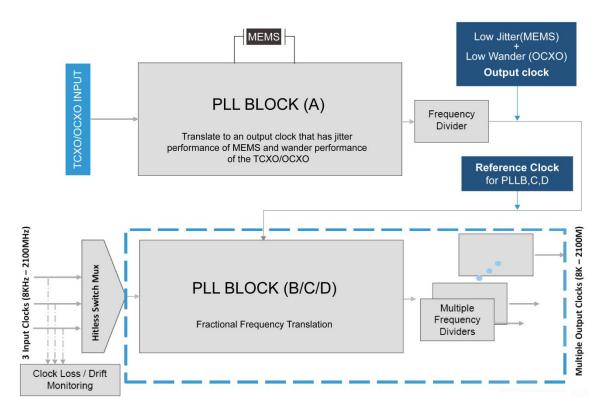


Figure 34. SiT95148 Low Wander Mode implementation diagram

SiT95148 as device clock and synchronous system reference

SiT95148 serves as the JESD204B clock source for providing timing references with fixed phase relationships. The chip distributes both a device clock (Dev_Clock) and a source synchronous system reference (SYSREF) signal to each device in the link. The converter/logic device generates its local multi-frame clock (LMFC), frame clock, and sampling clock via an internal divider fed from the

Dev_CLK. Each device in the link uses Dev_CLK to sample the SYSREF signal which is in turn used to align the LMFC to achieve synchronization between two devices. In order to maintain a deterministic phase relationship between the clock pair, SYSREF and Dev_Clock must be source-synchronous and SYSREF must meet setup and hold times relative to Dev_CLK. This will ensure that the same Dev_CLK edge, relative to SYSREF, is selected during each successive frame alignment sequence. The high-level block diagram is shown in Figure 33.

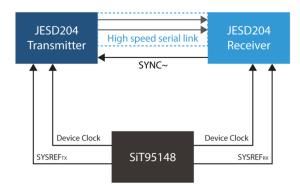


Figure 35. High level block diagram showing a JESD204B interface between an ADC (Transmitter) and an FPGA (Receiver)



Programmable Interface (PIF) Top Level View

Table 20. PIF Overview (Top Level Summary of the Programmable Interface)^[50]

Page Number	Function	Comments	Fuse repeated twice
		2Fh[7:6]: Lock Pattern for the Fuse FFh[7:0]: Current Page Number 22h[7:0]: Current Fuse Pointer 00h - 01h: Customer- Chip Information 02h - 04h: First set of Defect / Notify / Interrupt	
0h	Generic	06h - 08h: Second set of Defect / Notify / Interrupt 05h: DCO increment/decrement control 0Fh: Program Command Directives and Active Trigger Directives 10h: PLL enable control 11h - 18h: Fuse GPIO (FlexIO) Multiplexed Control 19h: VDD Padring Control and External CLKIN Switch Control 1Ah - 21h: Die ID + Wafer Co-ordinates 22h: Fuse Pointer Generic 24h: Clock Input / Output Enable Control 25h: Clock Output Enable Control 26h: OEb, Clock Output Enable Control Settings 27h - 28h: Masking of sticky bits status for Interrupt generation (INTR_b) 29h: GPIO (FLEXIO) Configuration 2Ah: Fuse Based I2C Addr 2Bh: Calibrations and Misc Settings	NO
1h	Clock Monitor	2Fh[7:6]: Customer - Lock Pattern for the Fuse FFh[7:0]: Current Page Number 00h - 01h: Chip Information 02h - 04h: First set Defect / Notify / Interrupt for Clock Monitor Sub- system. 06h - 08h: Second set of Defect / Notify / Interrupt for Clock Monitor Sub-system 0Fh: Program Command Directives and Active Trigger Directives 10h - 29h, 46h - 48h: Clock Loss Monitor Configuration 2Ah - 45h, 4Ch - 4Fh: Frequency Drift Coarse/Fine Configuration 49h - 48h: PLLs Input Clock Priority Information	YES
2h	Input	2Fh[7:6]: Customer - Lock Pattern for the Fuse FFh[7:0]: Current Page Number 00h - 01h: Chip Information 02h - 04h: Defect / Notify / Interrupt for Input Sub-system 0Fh: Program Command Directives and Active Trigger Directives 10h - 19h: CLKIN0 Fuse Configuration (IDR, DIVN0, Clock MUX) 20h - 2Fh: CLKIN1 Fuse Configuration (IDR, DIVN1, Clock MUX) 30h - 3Fh: CLKIN2 Fuse Configuration (IDR, DIVN1, Clock MUX) 40h - 4Fh: CLKIN3 Fuse Configuration (IDR, DIVN1, Clock MUX)	YES
3h	8 Flexi-Outputs/ 4 Fixed-Output Blocks	2Fh[7:6]: Customer - Lock Pattern for the Fuse FFh[7:0]: Current Page Number 00h - 01h: Chip Information 02h - 04h: Defect / Notify / Interrupt for Output Sub-system 0Fh: Program Command Directives and Active Trigger Directives 10h - 17h: Output Block 0 Fuse Configuration (ODR, DIVO, DIVO- Delay) 18h - 1Fh: Output Block 1 Fuse Configuration (ODR, DIVO, DIVO- Delay) 20h - 27h: Output Block 2 Fuse Configuration (ODR, DIVO, DIVO- Delay) 28h - 2Fh: Output Block 3 Fuse Configuration (ODR, DIVO, DIVO- Delay) 30h - 37h: Output Block 4 Fuse Configuration (ODR, DIVO, DIVO- Delay) 38h - 3Fh: Output Block 5 Fuse Configuration (ODR, DIVO, DIVO- Delay) 40h - 47h: Output Block 6 Fuse Configuration (ODR, DIVO, DIVO- Delay) 48h - 4Fh: Output Block 7 Fuse Configuration (ODR, DIVO, DIVO- Delay) 50h - 57h: Output Block 0T Fuse Configuration (ODR, DIVO, DIVO- Delay) 60h - 67h: Output Block 0B Fuse Configuration (ODR, DIVO, DIVO- Delay) 68h - 6Fh: Output Block 1B Fuse Configuration (ODR, DIVO, DIVO- Delay)	YES



Table 19. PIF Overview (Top Level Summary of the Programmable Interface)^[50] (continued)

Page Number	Function		Comments	Fuse repeated twice
		2Fh[7:6] : Cust	omer - Lock Pattern for the Fuse	
		FFh[7:0]:	Current Page Number	
		00h - 01h:	Customer- Chip Information	
		02h - 04h:	First set of Defect / Notify / Interrupt for PLLA	
Ah	PLL A	06h - 08h:	Second set of Defect / Notify / Interrupt for PLLA	YES
		05h:	Customer- PLL Generic Directives	
		0Fh:	Program Command Directives and Active Trigger Directives	
		10h - 2Fh:	PLL Fuse Configuration (All PLL specific settings for this PLL)	
		30h - 37h:	Customer-DCO Functionality	

Note:

52. All Addresses in Hexadecimal.



Serial Programming Interface Description

The device has two serial programming interface options, I²C and SPI, for reconfiguring the device settings. The protocol option can be selected through the I2C1_SPI0 pin. A 1/HIGH on the pin sets the device in I²C mode and a 0/LOW in SPI mode

I²C protocol

The device uses the SDAIO and SCLK pins for a 2-wire serial interface that operates up to 400 Kbps in Read and Write modes. It complies with the I²C bus standard. The I²C access protocol in device is byte access (random access) only for write and both random and sequential access for read.

The I²C serial interface can operate at either Standard rate (100 Kbps) or Fast rate (400 Kbps). For write operation, the device supports only single write operation. For read, the device supports both Single and Multiple read operations.

The device uses a 7-bit slave address, and the default value is 0x69 (right justified). The first 5 bits are static and programmed in the device to be 0b11010. The two least significant bits are controlled by the two address pins A1 (SDO) and A0 (CSB). When these address pins are floating, internal pull-down (for A1) and pull-up (for A0) will set the address to its default value 0x69 or 0b1101001. If the address pins are externally controlled, 3 more addresses are possible: 0x68, 0x6A, and 0x6B.

Additional slave addresses are available by using Register 0x2A at page 0 to change the static portion of the I²C address. Setting the 0x2A[7] bit to 1 enables use of non-default values for the 5 static address bits. These new values would be defined by bits 0x2A[6:2]. A1 and A0 would still control the 2 least significant bits of the address. This allows for a total of 128 supported addresses. To permanently change the I²C address, register 0x2A should be E-Fused.

If the chip is triggered into reset state (by writing a value of 0x01 to Register 0xFE), the 5 default static bits of the I²C address will be used regardless of Register 0x2A state. To exit reset state, a value of 0x00 should be written into the Register 0xFE. In this case, the I²C address will be set by the 5 default MSB bits and the 2 LSB bits controlled by A1 and A0. If these pins are floating, the default slave address 0x69 should be used as the address of the device.

Please refer to Figure 34 for the I²C addressing scheme of this device.

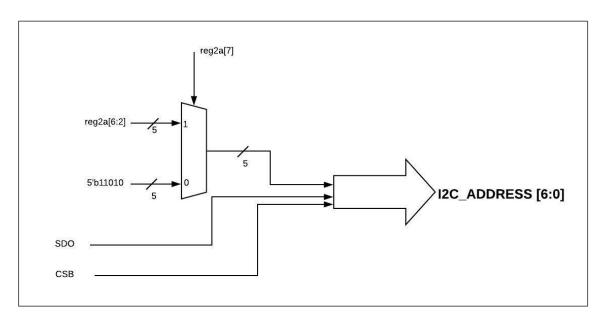


Figure 36. I²C Addressing Scheme for Cascade



Figure 35 shows the read block and Figure 36 shows the write block.

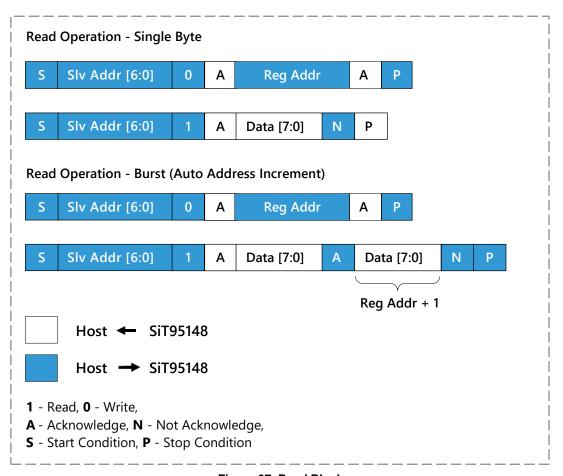


Figure 37. Read Block



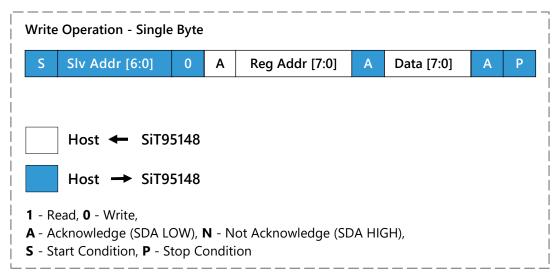


Figure 38. Write Block

■ Single Byte Write

- The master initiates the transaction by issuing a start condition, writes 7 bit slave address and then the read/write bit is written as 0 (write)
- The slave acknowledges by driving zero on the bus
- The master then writes the 8 bit register map address
- The slave acknowledges by driving zero on the bus
- The master then writes the 8 bit data to be written to the register map address specified
- The slave acknowledges by driving zero on the bus
- The master ends the transaction by issuing a stop condition

■ Single Byte Read

- The master initiates the transaction by issuing a start condition, writes 7 bit slave address and then the read/write bit is written as 0 (write)
- The slave acknowledges by driving zero on the bus
- The master then writes the 8 bit register map address
- The slave acknowledges by driving zero on the bus
- The master ends the transaction by issuing a stop condition
- The master re-initiates the transaction by issuing a start condition, writes 7 bit slave address and then the read/write bit is written as 1 (read)
- o The slave then writes the 8 bit data to be written

to the register map address specified

- The master does not acknowledge this transaction as the slave may assume a multi-byte read operation and there is a risk of slave holding the bus low
- The master ends the transaction by issuing a stop condition



Multi Byte Read

The multi-byte read mode is used to read a continuous segment of the register map. The multi-byte read is faster than performing multiple single byte reads as the device address and register map address need not be specified for every byte read from the register map

- The master initiates the transaction by issuing a start condition, writes 7 bit slave address and then the read/write bit is written as 0 (write)
- o The slave acknowledges by driving zero on the bus
- The master then writes the 8 bit register map address
- o The slave acknowledges by driving zero on the bus
- The master ends the transaction by issuing a stop condition
- The master re-initiates the transaction by issuing a start condition, writes 7 bit slave address and then the read/write bit is written as 1 (read)
- The slave then writes the 8 bit data to be written to the register map address specified
- o The master acknowledges by driving zero on the bus
- The slave automatically increments the register map address and writes the data in at that address to the bus and the master acknowledges
- When all bytes of data are read, master ends the operation by not acknowledging the last read
- The master then ends the transaction by issuing a stop condition



SPI Protocol

The SPI is a four-pin interface with Chip Select (CSB), Serial Input (SDAIO), Serial Output (SDO), and Serial Clock (SCLK) pins. The SPI bus on the device can run at speed up to 20 MHz. The SPI is a synchronous serial interface, which uses clock and data pins for serial access. When I2C1_SPI0 pin is Low, a Low on the CSB pin activates the SPI access. The SPI Timing diagram is shown in Figure 37.

- 1. The SPI can operate up to 20 MHz for regular write/read operations.
- The SPI receives serial data from the external master and provides Wr/rdn (set to 0x01h), address and data to the register map during the write operation.
- 3. The SPI receives serial data from the external master and provides Wr/rdn (set to 0x00h), address to the register map and uses the read data obtained from the register map, serializes the same and transmit to the master.
- 4. In SiT95148, the total packet size for each SPI transaction is 24 bits where the 8 bits are Wr/rdn (0x01 for write and 0x00 for read), the next 8 bits are address and the last 8 bits are data
- 5. In SiT95148 for write operation, the master assembles the Wr/rdn byte, address and data for write operation on the falling edge of the spi clock and the slave in the SIT95148 captures the same on the rising edge of the SPI clock. There is no loopback provided here.
- 6. In SiT95148 for read operation, the master assembles the Wr/rdn byte, address for read operation on the falling edge of the spi clock and the slave in the SIT95148 captures the same on the rising edge of the SPI clock and there is no loopback. The falling edge after the 16th rising SPI clock (i.e. the last address bit), is used by the slave to assemble the first read data which is captured by the master on the 17th edge of the SPI clock. Subsequent 7 more clocks are used for the 7 remaining data bits.
- 7. In SiT95148 the transmitter always sends data on the falling edge of the SPI clock to be captured in the receiver by the rising edge of the SPI clock. The transmitter can be the master for the whole operation of the write and for the control and address portions of the read. The slave is the transmitter during the data portion of the read cycle.
- 8. The register can be written to or read from one address at a time. The SPI implemented in SiT95148 does not support burst address write or read operations.



SPI Timing Details

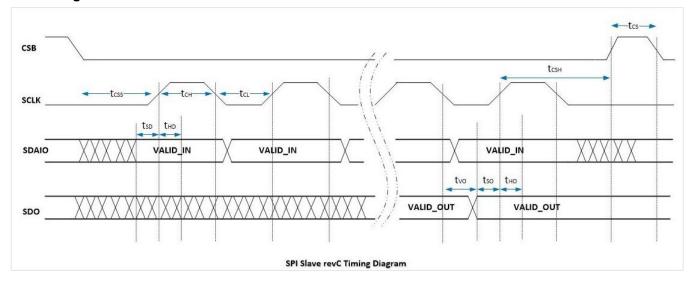


Figure 39. SPI Timing Diagram

Table 21. SPI Timing

Symbol	Description	Min.	Тур.	Max.	Units
f _{SCLK}	SCLK clock frequency	_	_	20	MHz
t _{сн}	Clock pulse width HIGH	20			ns
t _{CL}	Clock pulse width LOW	20			ns
tcs	CSB HIGH time	50			ns
tcss	CSB setup time	25			ns
tсsн	CSB hold time	25			ns
tsp	Data in setup time	10			ns
t _{HD}	Data in hold time	10			ns
tvo	Output valid			10	ns
tso	Output valid			10	ns
tно	Output valid			10	ns



SPI Single byte write

- The master initiates the transaction by issuing a start condition of pulling csn_i to active low
- The master assembles the serial data on the falling edge of the SPI clock so the SPI slave can capture the same on the rising edge of the SPI clock
- The first 7 bits are don't care with the 8th bit being set to 1 to indicate a write operation
- The next 8 bits (second byte) are used for the register map address
- The next 8 bits (third byte) are used for the register map data
- The 24th rising edge of the SPI clock is used to capture the last data bit. The SPI slave then assembles the address, data, enable and wr_rdn to the PIF slave block. The inverted version of the next falling edge of the SPI clock is used by the SPI slave to capture the address, data, enable and wr_rdn to write to the respective register
- The csn is then de-activated (by going high) by the master
- For the next write operation, CSN is held high for at least a duration of two SPI clocks following which the entire operation can start again.

SPI Single byte read

- The master initiates the transaction by issuing a start condition of pulling csn i to active low
- The master assembles the serial data on the falling edge of the SPI clock so the SPI slave can capture the same on the rising edge of the SPI clock
- The first 7 bits are don't care with the 8th bit being set to 0 to indicate a read operation
- The next 8 bits (second byte) are used for the register map address
- The next 8 bits (third byte) are used for the register map read data that is supplied by the pif slave block
- The 16th rising edge of the SPI clock is used to capture the last address bit. The SPI slave then assembles the address, enable and wr_rdn to the PIF slave block. The slave block then uses the address when enable is high to provide the read back data via a multiplexer. This operation has to be completed within half a SPI clock since the SPI slave has to assemble the first read back data bit on the falling edge of the SPI clock so the SPI slave can capture the same on the next rising edge. After 7 additional clocks, all 8 serial read back data bits are sent out from the SPI slave
- The CSN is then de-activated (by going high) by the master
- For the next read operation, CSN is held high for at least a duration of two SPI clocks following which the entire operation can start again
- When CSB goes high after an SPI transaction is complete, it is recommended that the SPI clock is shut off and stays in the low stay till the next SPI transaction starts. During this time, the SDO will hold the last transmitted bit. The duration for which the CSB is expected to be held high is equivalent of two SPI clocks. If for some reason, the SPI clocks cannot be held static at zero and need to toggle when CSB is high, then the SDO will output a low after the first rising edge of the SPI clock after the CSB has transitioned to high. The duration for which CSB is expected to be held high is equivalent of two SPI clock.

Figure 35 shows the SPI Read Operation and Figure 36 shows the SPI Write Operation.



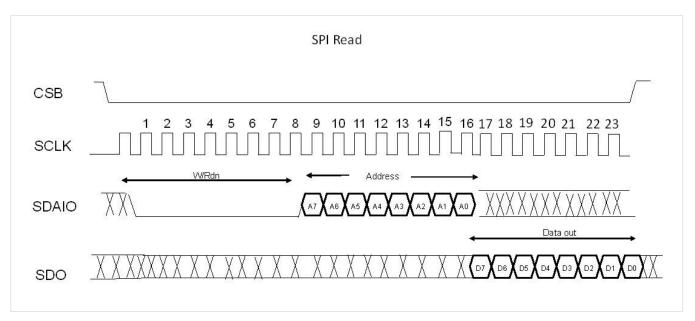


Figure 35. SPI Read Operation

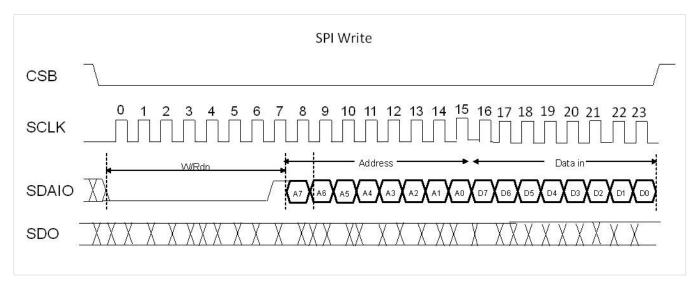


Figure 36. SPI Write Operation



Alarm Registers' Information

Status and Notify

SiT95148 provides various status and notify bits that can be accessed from the register map. Below are the details of the procedure to be followed to access the same.

The alarm registers are a set of three types of registers distributed between the various pages as described in Table 21 below and illustrated with some examples in a later section of this datasheet

- The Status registers are the current dynamic status of a defect. The live status defects are active high with a '1' indicating the defect is present.
- The Notify registers are the sticky bits for a defect. Sometimes, we may get a very short pulse for the status and it may not be possible for the external user to capture the same. Hence a notify register is provided. The notify register is set to 1 whenever there is a rising edge of the corresponding status register. This is a sticky bit and stays at 1 till the user writes a 1 to that specific bit to clear it.
- Each notify has a masking bit to enable or disable its operation. The notify sticky bit operates only if the corresponding masking bit is set to 1. If the masking register bit is set to 0, notify will not be asserted even when status toggles. The default value for the mask register is 0xff so all the notify signals are enabled. Once the user writes a 1 to clear the notify, the notify bit can again go high on the next rising edge of the status.

These registers operate on the internal 4 MHz RC clock. When there is a defect (i.e. status) of any bit in register it gets asserted and de-asserted in a live mode. User can read the corresponding register location to see the current status at any time.. The default value for the mask register is 0xFF so all the notify signals are enabled. Once the user writes a 1 to clear the notify bit, the notify bit can again go high on the next rising edge of the status. On the other hand, the default value of the notify and masking register is 0xFF – user has to write 0xff to both these registers to clear them at the beginning and use all notifies. The INTRB pin is used as a NOR operation of the selected notifies. The choice of the Notify listing that is used for the INTRB pin is selectable in the GUI when creating the profile. The sticky notifies that are selected and used for INTRB need to be cleared for restoring the INTRB to 1 for further sticky defect monitoring using this pin.

The table below details the name of the alarm, the page it is located in, the address in the page and the bit number in the address. In order to access a page of the register map, the particular page number has to be written to address 0xFF. For instance, to either write to or read from page 1, first the user needs to write to 0xFF a value of 0x01. Following this, any number of write or read operations can be done with page 1.



Table 22. Tabular Listing of Alarm Registers

S.NO	Name of Signal	Description	Page Number	Register Address	Bit Number
1	xo_clkloss_dynamic_status	Xo clock dynamic status	00	0x02	2
2	xo_clkloss_dynamic_ntfy	Xo clock dynamic Notify (write 0x04 with 0x02 to enable)	00	0x03	2
3	plla_lol_dyn_status	pll lol dynamic status	00	0x06	0
4	pllb_lol_dyn_status	pll lol dynamic status	00	0x06	1
5	pllc_lol_dyn_status	pll lol dynamic status	00	0x06	2
6	plld_lol_dyn_status	pll lol dynamic status	00	0x06	3
7	plla_ho_frz_status	pll ho freeze dynamic status	00	0x06	4
8	pllb_ho_frz_status	pll ho freeze dynamic status	00	0x06	5
9	pllc_ho_frz_status	pll ho freeze dynamic status	00	0x06	6
10	plld_ho_frz_status	pll ho freeze dynamic status	00	0x06	7
11	plla_lol_dyn_ntfy	pll lol dynamic Notify (write 0x08 with 0x01 to enable)	00	0x07	0
12	pllb_lol_dyn_ntfy	pll lol dynamic Notify (write 0x08 with 0x02 to enable)	00	0x07	1
13	pllc_lol_dyn_ntfy	pll lol dynamic Notify (write 0x08 with 0x04 to enable)	00	0x07	2
14	plld_lol_dyn_ntfy	pll lol dynamic Notify (write 0x08 with 0x08 to enable)	00	0x07	3
15	plla_ho_frz_ntfy	pll ho freeze dynamic Notify (write 0x08 with 0x10 to enable)	00	0x07	4
16	pllb_ho_frz_ntfy	pll ho freeze dynamic Notify (write 0x08 with 0x20 to enable)	00	0x07	5
17	pllc_ho_frz_ntfy	pll ho freeze dynamic Notify (write 0x08 with 0x40 to enable)	00	0x07	6
18	plld_ho_frz_ntfy	pll ho freeze dynamic Notify (write 0x08 with 0x80 to enable)	00	0x07	7
19	in0_clock_loss_dyn_status	Clock Loss Dynamic Status	01	0x02	0
20	In1_clock_loss_dyn_status	Clock Loss Dynamic Status	01	0x02	1
21	In2_clock_loss_dyn_status	Clock Loss Dynamic Status	01	0x02	2
22	In3_clock_loss_dyn_status	Clock Loss Dynamic Status	01	0x02	3
23	in0_clock_loss_fd_dyn_status	Clock Loss with Fd_dynamic Status	01	0x02	4
24	In1_clock_loss_fd_dyn_status	Clock Loss with Fd_dynamic Status	01	0x02	5
25	In2_clock_loss_fd_dyn_status	Clock Loss with Fd_dynamic Status	01	0x02	6
26 27	In3_clock_loss_fd_dyn_status in0_clock_loss_ntfy	Clock Loss with Fd_dynamic Status Clock Loss Dynamic Notify (write 0x04 with	01	0x02 0x03	7
28	In1_clock_loss_ntfy	Ox01 to enable) Clock Loss Dynamic Notify (write 0x04 with 0x02 to enable)	01	0x03	1
29	In2_clock_loss_ntfy	Clock Loss Dynamic Notify (write 0x04 with 0x04 to enable)	01	0x03	2
30	In3_clock_loss_ntfy	Clock Loss Dynamic Notify (write 0x04 with 0x08 to enable)	01	0x03	3
31	in0_clock_loss_ntfy	Clock Loss with Fd_dynamic Notify (write 0x04 with 0x10 to enable)	01	0x03	4
32	In1_clock_loss_ntfy	Clock Loss with Fd_dynamic Notify (write 0x04 with 0x20 to enable)	01	0x03	5
33	In2_clock_loss_ntfy	Clock Loss with Fd_dynamic Notify (write 0x04 with 0x40 to enable) Clock Loss with Fd_dynamic Notify (write	01	0x03	6
34	In3_clock_loss_ntfy	0x04 with 0x80 to enable)	01	0x03	7
35	in0_fd_fine_dyn_status	Frequency drift dynamic status	01	0x06	0
36	In1_fd_fine_dyn_status	Frequency drift dynamicstatus	01	0x06	1
37	In2_fd_fine_dyn_status	Frequency drift dynamicstatus	01	0x06	2



Table 21. Alarm Register Listing (continued)

S.NO	Name of Signal	Description	Page Number	Register Address	Bit Number
38	In3_fd_fine_dyn_status	Frequency drift dynamic status	01	0x06	3
39	in0_fd_coarse_dyn_status	Frequency drift dynamic status	01	0x06	4
40	In1_fd_coarse_dyn_status	Frequency drift dynamic status	01	0x06	5
41	In2_fd_coarse_dyn_status	Frequency drift dynamic status	01	0x06	6
42	In3_fd_coarse_dyn_status	Frequency drift dynamic status	01	0x06	7
43	in0_fd_fine_ntfy	Frequency drift dynamic notify (write 0x08 with 0x01 to enable)	01	0x07	0
44	In1_fd_fine_ntfy	Frequency drift dynamic notify (write 0x08 with 0x02 to enable)	01	0x07	1
45	In2_fd_fine_ntfy	Frequency drift dynamic notify (write 0x08 with 0x04 to enable)	01	0x07	2
46	In3_fd_fine_ntfy	Frequency drift dynamic notify (write 0x08 with 0x08 to enable)	01	0x07	3
47	in0_fd_coarse_ntfy	Frequency drift dynamic notify (write 0x08 with 0x10 to enable)	01	0x07	4
48	In1_fd_coarse_ntfy	Frequency drift dynamic notify (write 0x08 with 0x20 to enable)	01	0x07	5
49	In2_fd_coarse_ntfy	Frequency drift dynamic notify (write 0x08 with 0x40 to enable)	01	0x07	6
50	In3_fd_coarse_ntfy	Frequency drift dynamic notify (write 0x08 with 0x80 to enable)	01	0x07	7
51	fast_lock_dynamic_status_plla	PLL Fast lock dynamic status	0a	0x06	1
52	fast_lock_dynamic_status_pllb	PLL Fast lock dynamic status	0b	0x06	1
53	fast_lock_dynamic_status_pllc	PLL Fast lock dynamic status	0с	0x06	1
54	fast_lock_dynamic_status_plld	PLL Fast lock dynamic status	0d	0x06	1
55	fast_lock_dynamic_ntfy_plla	PLL Fast lock dynamic Notify (write 0x08 with 0x02 to enable)	0a	0x07	1
56	fast_lock_dynamic_ntfy_pllb	PLL Fast lock dynamic Notify (write 0x08 with 0x02 to enable)	0b	0x07	1
57	fast_lock_dynamic_ntfy_pllc	PLL Fast lock dynamic Notify (write 0x08 with 0x02 to enable)	0с	0x07	1
58	fast_lock_dynamic_ntfy_plld	PLL Fast lock dynamic Notify (write 0x08 with 0x02 to enable)	0d	0x07	1
59	ho_valid_dynamic_status_plla	PLL Ho Valid dynamic status	0a	0x06	2
60	ho_valid_dynamic_status_pllb	PLL Ho Valid dynamic status	0b	0x06	2
61	ho_valid_dynamic_status_pllc	PLL Ho Valid dynamic status	0c	0x06	2
62	ho_valid_dynamic_status_plld	PLL Ho Valid dynamic status	0d	0x06	2
63	ho_valid_dynamic_ntfy_plla	PLL Ho Valid dynamic Notify (write 0x08 with 0x04 to enable)	0a	0x07	2
64	ho_valid_dynamic_ntfy_pllb	PLL Ho Valid dynamic Notify (write 0x08 with 0x04 to enable)	0b	0x07	2
65	ho_valid_dynamic_ntfy_pllc	PLL Ho Valid dynamic Notify (write 0x08 with 0x04 to enable)	0с	0x07	2
66	ho_valid_dynamic_ntfy_plld	PLL Ho Valid dynamic Notify (write 0x08 with 0x04 to enable)	0d	0x07	2



Examples for Live Status Read Back

Some examples are presented based on the Table 21 above for reading the live status of the defects.

In the pseudo code presented below:

wr_cmd(address, data): refers to a "Write Command" where the corresponding data is written in to the specified register address

x = rd_cmd(address): refers to a "Read Command" where the corresponding data is read from the specified register address and stored in the variable 'x'

y >> x: denotes a bit wise right shift on the number y by x bit locations

y << x:denotes a bit wise left shift on the number y by x bit locations

& is the logical AND operation (bit wise)

Dynamic registers to read the various alarm registers in the RealTime page

1. Input Clocks CL and FD Related Real Time live status read back:

wr_cmd(0xff, 0x01) Program the CLKMON_SYS page number

Clock Loss dynamic status

clock_loss_dyn_status = rd_cmd(0x02) & 0xff

(clock_loss_dyn_status >> 0) & 0x01 IN0 Status for CL, Read bit position [0]

(clock_loss_dyn_status >> 1) & 0x01 IN1 Status for CL, Read bit position [1]

(clock_loss_dyn_status >> 2) & 0x01 IN2 Status for CL, Read bit position [2]

(clock_loss_dyn_status >> 3) & 0x01 IN3 Status for CL, Read bit position [3]

Frequency Drift dynamic status

fd_fine_dyn_status = rd_cmd(0x06) & 0x0f

fine = (fd_fine_dyn_status >> 0) & 0x01 IN0 Status for Fine FD, Read bit position [0]

fine = (fd_fine_dyn_status >> 1) & 0x01 IN1 Status for Fine FD, Read bit position [1]

fine = (fd fine dyn status >> 2) & 0x01 IN2 Status for Fine FD, Read bit position [2]

fine = (fd fine dyn status >> 3) & 0x01 IN3 Status for Fine FD, Read bit position [3]

fd_coarse_dyn_status = rd_cmd(0x06) >> 4

coarse = (fd_coarse_dyn_status >> 0) & 0x01 IN0 Status for Coarse FD, Read bit position [4]

coarse = (fd_coarse_dyn_status >> 1) & 0x01 IN1 Status for Coarse FD, Read bit position [5]

coarse = (fd_coarse_dyn_status >> 2) & 0x01 IN2 Status for Coarse FD, Read bit position [6]

coarse = (fd coarse dyn status >> 3) & 0x01 IN3 Status for Coarse FD, Read bit position [7]

2. PLL Related Real Time live status read back:

wr_cmd(0xff, 0x00) # Program the GENERIC_SYS page number, Page 0 pll_lol_ho_freeze_dyn_status = rd_cmd(0x06) & 0xff

PLL Lock Loss dynamic status

(pll_lol_ho_freeze_dyn_status >> 0) & 0x01 PLLA Status for LL, Read bit position [0]

(pll_lol_ho_freeze_dyn_status >> 1) & 0x01 PLLB Status for LL, Read bit position [1]

(pll_lol_ho_freeze_dyn_status >> 2) & 0x01 PLLC Status for LL, Read bit position [2]

(pll_lol_ho_freeze_dyn_status >> 3) & 0x01 PLLD Status for LL, Read bit position [3]

Holdover Status

(pll_lol_ho_freeze_dyn_status >> (0 + 4)) & 0x01 PLLA Status for HO, Read bit position [4]

(pll_lol_ho_freeze_dyn_status >> (1 + 4)) & 0x01 PLLA Status for HO, Read bit position [5]

(pll_lol_ho_freeze_dyn_status >> (2 + 4)) & 0x01 PLLA Status for HO, Read bit position [6]

(pll_lol_ho_freeze_dyn_status >> (3 + 4)) & 0x01 PLLA Status for HO, Read bit position [7]



Examples of Sticky Bit Clearing

As described earlier, the sticky notify bits are cleared by writing a '1' to the corresponding notify bit itself. The notify bit by itself is enabled by writing a '1' to the corresponding mask bit.

In the pseudo code presented below,

rmw_cmd(addr,bit_loc,no_of_bits,data): denotes the read/modify/write operation where no_of_bits number of bits at bit_loc location (denoted as 7:0) is replaced with the data at address location addr.

```
def clr_intb_XO_CL():
  # This function is used to clear the sticky notify for XO Clock Loss
  #Write the page number
  wr cmd(0xff, 0)
  # Information to clr ** Page 0: reg03[2]=1 **
           = 0x3
  bit_loc = 2
  no_of_bits = 1
  data
           = 1
  rmw_cmd(addr,bit_loc,no_of_bits,data)
def clr_intb_LOL_HO_Freeze():
  # This function is used to clear the sticky notify for loss of lock and holdover notify for all PLLs
  #Write the page number
  wr_cmd(0xff, 0)
  # Information to clr ** Page 0: reg07[7:0] = 0xff **
  addr
           = 0x7
  bit_loc = 7
  no_of_bits = 8
  data
           = 0xff
  rmw_cmd(addr,bit_loc,no_of_bits,data)
def clr_intb_CL():
  # This function is used to clear the sticky notify for clear clock loss notify
  # Write the page number
  wr_cmd(0xff, 1)
  # Information to clr ** Page1: reg03[3:0]=0x0f **
  addr
           = 0x3
  bit_loc = 3
  no of bits = 4
           = 0x0f
  data
  rmw_cmd(addr,bit_loc,no_of_bits,data)
def clr_intb_drift():
  # This function is used to clear the sticky notify for clear drift notify
  #Write the page number
  wr_cmd(0xff, 1)
  # Information to clr ** Page1: reg07[7:0]=0xff **
  addr
           = 0x7
  bit_loc = 7
  no_of_bits = 8
  data
           = 0xff
  rmw cmd(addr,bit loc,no of bits,data)
def clr_intrb():
  This is the main clear function
  which calls the 4 clear functions
  clr_intb_XO_CL()
  clr_intb_LOL_HO_Freeze()
  clr_intb_CL()
  clr_intb_drift()
```



Device Initialization for a Non-Programmed Device

This section describes a device initialization flow chart for an unlocked device. An unlocked device is a device on which the NVM is not programmed and where an autonomous wake up does not happen. It is assumed that the user is using a device that is not programmed for the description in this section.

The SiT95148 device register initialization flowchart for Master Control Page and the slave pages is as below. As explained in the chip functional description in the data sheet, the following is the sequence of the wake up of the various sub systems in the chip.

- First, the master control (Page 0) is initialized and programmed. The Slaves are powered up at this stage.
- Next, the Input System (Page 2) is initialized and programmed for cases where at least one input is enabled.
- Next, the Clock Monitor System (Page 1) is initialized and programmed for cases where at least one input is enabled.
- Next, the Output System (Page 3) is initialized and programmed.
- Finally, the PLLs that are expected to be used for the particular profile (PLLs A, B, C, D correspond to Pages A, B, C, D) are initialized and programmed.

The register 0xFF is written with the Page Number the user would like to access. The chip changes the current page once the user has written the register 0xFF. The page numbers corresponding to each slave and master are described in the respective table in the data sheet. At any point in time the register 0xFF can be read to find out the current page.

Please note that the flow chart in the following pages is to be used together with the sequence of register writes that are obtained from the GUI with the "Dump" button after loading a profile. This file obtained from the GUI describes the set of registers to be written in the exact order and with appropriate delays. This file obtained from the GUI is the master sequence to be followed for programming a part. The Figures on the following pages describe the flow of the same register write sequence file using flow charts.



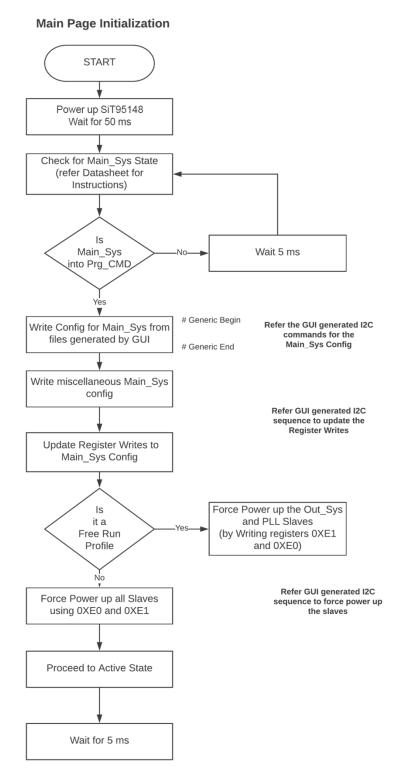


Figure 37. Step 1: Initialize the Main Page - Page 0

One can move to Page 0 by writing 0x00 to the address 0xFF. Read the current page at any time by reading the contents of the register 0xFF.



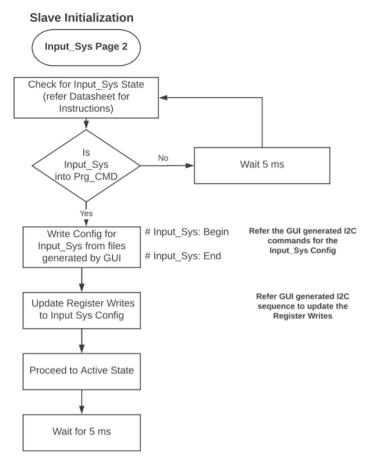


Figure 38. STEP 2: Initialize the Input System Page - Page 2

One can move to Page 2 by writing 0x02 to the address 0xFF. Read the current page at any time by reading the contents of the register 0xFF. This page is not initialized for a purely free run profile where no inputs are engaged.



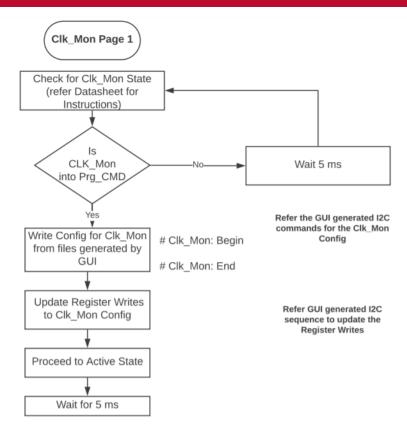


Figure 39. STEP 3: Initialize the Clock Monitor System Page - Page 1

One can move to Page 1 by writing 0x01 to the address 0xFF. Read the current page at any time by reading the contents of the register 0xFF. This page is not initialized for a purely free run profile where no inputs are engaged.



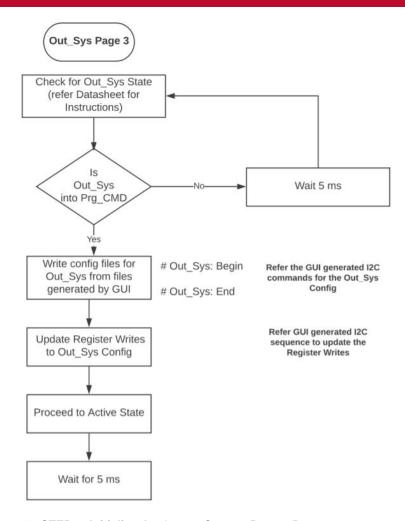


Figure 40. STEP 4: Initialize the Output System Page - Page 3

One can move to Page 3 by writing 0x03 to the address 0xFF. Read the current page at any time by reading the contents of the register 0xFF.



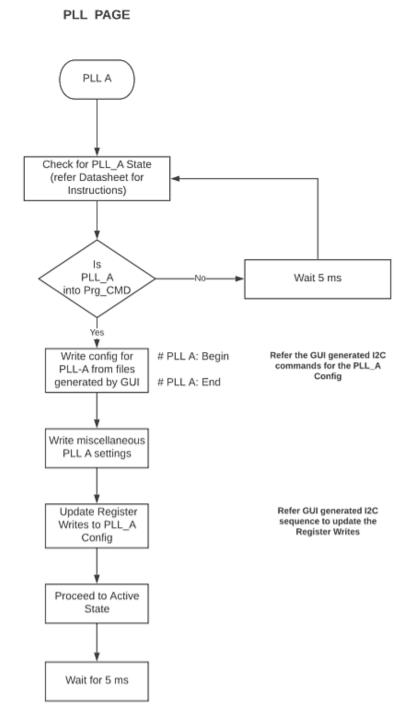


Figure 41. STEP 5: Initialize the PLL A System Page - Page A

One can move to Page A by writing 0x0A to the address 0xFF. Read the current page at any time by reading the contents of the register 0xFF. Initialize PLL A only if it is used in the profile being used.



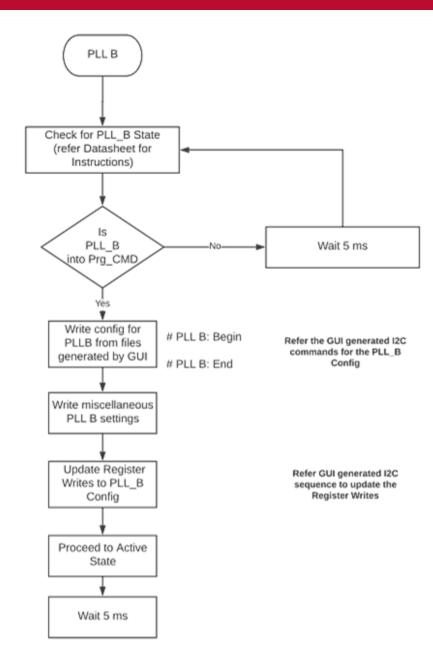


Figure 42. STEP 6: Initialize the PLL B System Page - Page B

One can move to Page B by writing 0x0B to the address 0xFF. Read the current page at any time by reading the contents of the register 0xFF. Initialize PLL B only if it is used in the profile being used.



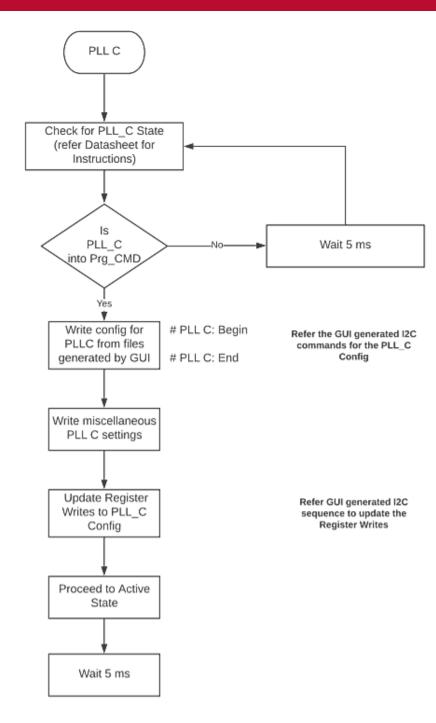


Figure 43. STEP 7: Initialize the PLL C System Page - Page C

One can move to Page C by writing 0x0C to the address 0xFF. Read the current page at any time by reading the contents of the register 0xFF. Initialize PLL C only if it is used in the profile being used.



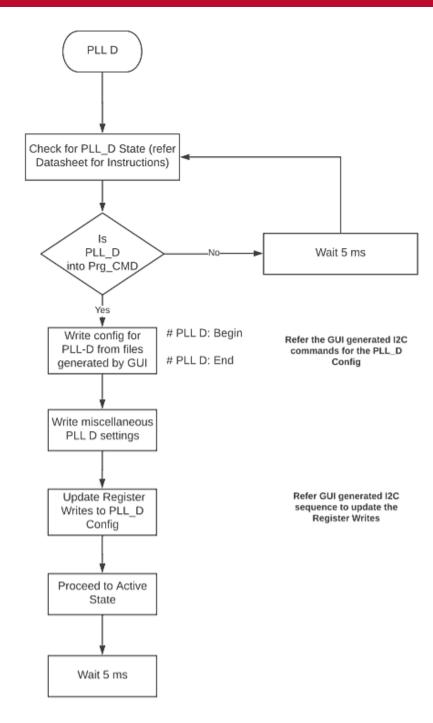


Figure 44. STEP 8: Initialize the PLL D System Page - Page D

One can move to Page D by writing 0x0D to the address 0xFF. Read the current page at any time by reading the contents of the register 0xFF. Initialize PLL D only if it is used in the profile being used.



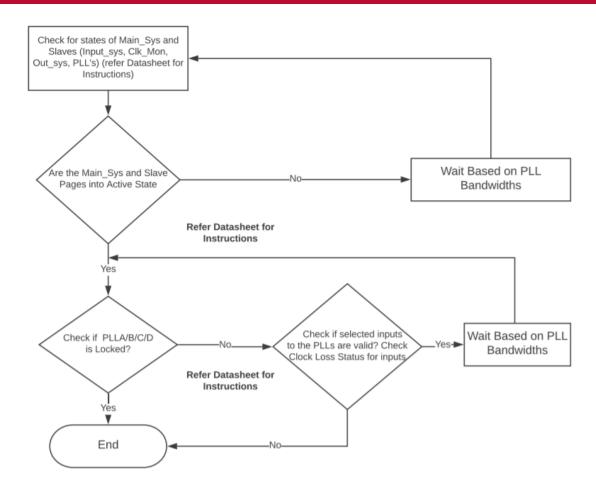


Figure 45. Active State Confirmation

Confirm from each page that was initialized that their respective state machines are in Active State. Check Lock Status of PLLs that are enabled.



Monitoring the Status for Master and Slave Pages

Once the SiT95148 is powered up, the NVM register contents are read, it is preferable to provide sufficient time delay for the read operation.

As explained in the data sheet above, we need to read that the Master Control Page 0 is in the Program Command Wait State (PRG_CMD State) before starting to write to the part. Please use the register write sequence from the GUI generated from the "Dump" button to write in to the device.

Once the entire sequence to program the profile has been written, each Page (Pages 0, 1, 2, 3, PLL Pages A, B, C, D based on which PLLs are enabled) can be checked to ensure they are in the ACTIVE state.

The sequence that needs to be followed to check the status of the Master and Slave Pages is as below.

MAIN PAGE (0)

1) Write 0xFF register to 0x00.

Write 0XD1 register on Page 0 to 0x40.

3) Read the register 0xD0.

If read data == 9 (Main Sys is in PRG_CMD state)

read data == 0 (Main Sys is in IDLE state)

read data == 36 (Main Sys is in Active state) # revC

Go to Page 0

CLK MON PAGE (1)

1) Write 0xFF register to 0x01.

2) Write 0XD1 register on Page 1 to 0x40.

3) Read ((0xD0) & 0x0F).

If read data == 5 (CLK MON is in PRG_CMD state)

read data == 0 (CLK MON is in IDLE state)

read data == 12 (CLK MON is in Active state)

Go to Page 1

INPUT_SYS PAGE (2)

1) Write 0xFF register to 0x02.

2) Write 0XD1 register on Page 2 to 0x40.

3) Read ((0xD0) & 0x1F).

If read data == 7(INPUT_SYS is in PRG_CMD state)

read data == 0 (INPUT_SYS is in IDLE state)

read data == 23 (INPUT_SYS is in Active state)

OUT_SYS PAGE (3)

1) Write 0xFF register to 0x03.

2) Write 0XD1 register on Page 3 to 0x60.

3) Read ((0xD0) & 0x1F).

If read data == 12(OUT_SYS is in PRG_CMD state)

read data == 0 (OUT_SYS is in IDLE state)

read data == 20 (OUT_SYS is in Active state)

Go to Page 2

Go to Page 3



PLL PAGE (A, B, C, D)

1) Write 0xFF register to 0x0A(PLLA). # (0x0A - PLLA, 0x0B - PLLB, 0x0C-PLLC, 0x0D-PLLD)

2) Write 0XD1 register on PLL Page to 0x20.

3) Read the register 0xD0.

If read data == 8(PLL PAGE is in PRG_CMD state)
read data == 0 (PLL PAGE is in IDLE state)
read data == 48 (PLL PAGE is in Active state) #revC

Monitoring the Loss of Lock Status for PLL

The sequence that needs to be followed to monitor the dynamic LOL status of the PLL's is as below:

Write 0xFF register to 0x0A(PLLA).
 Write 0x0A - PLLB, 0x0C-PLLC, 0x0D-PLLD)
 Write 0x04 register on PLL Page to 0x01.
 # Remove the mask for lock loss notify status

3) Read ((0x02) & 0x01). # LOL dynamic status_PLLA_B_C_D

If read data == 1 (Loss of Lock is asserted: PLL is not locked) read data == 0 (PLL is locked)

Monitoring the Hold Over Status for PLLs

The sequence that needs to be followed to monitor the Hold Over status of the PLL's is as below:

1) Write 0xFF register to 0x0A(PLLA). # (0x0A - PLLA, 0x0B – PLLB, 0x0C-PLLC, 0x0D-PLLD)
2) Read ((0x17)>>7) & 0x01). # To check if the PLL Outer Loop is Enabled/Disabled

If read data == 1 It indicates a Free Run Profile --- The PLL's will always be in Hold Over read data == 0 It is not a Free Run Profile ----- PLL may or may not be in Hold Over

3) Write 0xB3 register to 0x0D.

4) Read ((0xb9)>>3) & 0x01). # Read the 3rd bit in B9 register for Hold Over Status Information

If read data == 1 PLL is in Holdover State
read data == 0 PLL is not in Holdover State



Programming the Primary E-Fuse

This section describes primary E-Fuse program configuration for all the pages [GENERIC_SYS, INPUT_SYS, CLKMON_SYS, OUTPUT_SYS, PLLA_SYS, PLLB_SYS, PLLC_SYS, PLLD_SYS].

VDD=2.5V and VDDIN=2.5V should be used for programming the E-Fuse.

Configuration Bits to Force Power-up of Digital Slave Subsystems

The respective subsystems needs to be powered up before programming the E-Fuse

This section describes GENERIC_SYS page configuration required in register 0xe0 and 0xe1 to enable respective slave subsystems [INPUT_SYS, CLKMON_SYS, OUTPUT_SYS, PLLA_SYS, PLLB_SYS, PLLC_SYS, PLLD_SYS] as described in Table 22.

Table 23. Configuration Bits to Force Power-up of Digital Slave Subsystems

S.NO	Page Number	Register Address	Bit Number	Value & It's Description
			0	1'h1 (write to bit number 0 in register address 0xE0 with value 1'h1 to enable force overwrite INPUT_SYS)
			1	1'h1 (write to bit number 1 in register address 0xE0 with value 1'h1 to enable force overwrite CLKMON_SYS)
			2	1'h1 (write to bit number 2 in register address 0xE0 with value 1'h1 to enable force overwrite OUTPUT_SYS)
1	Page 0	0xE0	3	1'h1 (write to bit number 3 in register address 0xE0 with value 1'h1 to enable force overwrite PLLA_SYS)
			4	1'h1 (write to bit number 4 in register address 0xE0 with value 1'h1 to enable force overwrite PLLB_SYS)
			5	1'h1 (write to bit number 5 in register address 0xE0 with value 1'h1 to enable force overwrite PLLC_SYS)
			6	1'h1 (write to bit number 6 in register address 0xE0 with value 1'h1 to enable force overwrite PLLD_SYS)
			0	1'h1 (write to bit number 0 in register address 0xE1 with value 1'h1 INPUT_SYS to be Enabled)
			1	1'h1 (write to bit number 1 in register address 0xE1 with value 1'h1 CLKMON_SYS to be Enabled)
			2	1'h1 (write to bit number 2 in register address 0xE1 with value 1'h1 OUTPUT_SYS to be Enabled)
2	Page 0	0xE1	3	1'h1 (write to bit number 3 in register address 0xE1 with value 1'h1 PLLA_SYS to be Enabled)
			4	1'h1 (write to bit number 4 in register address 0xE1 with value 1'h1 PLLB_SYS to be Enabled)
			5	1'h1 (write to bit number 5 in register address 0xE1 with value 1'h1 PLLC_SYS to be Enabled)
			6	1'h1 (write to bit number 5 in register address 0xE1 with value1'h1PLLD_SYS to be Enabled)



E-Fuse Lock Configuration Bits

This section describes the location of the two bits to lock the respective slave subsystem E-Fuse by writing into the register 0x2F in all pages as described in Table 23.

Table 24. E-Fuse Lock Configuration Bits for all pages

S.NO	Page Number	Register Address	Bit Number	Value & It's Description
1	Page 0	0x2f	7:6	2'h1: E-Fuse of GENERIC_SYS is locked by writing into bit number [7:6] in register address 0x2f with value 2'h1
2	Page 1	0x2f	7:6	2'h1: E-Fuse of CLKMON_SYS is locked by writing into bit number [7:6] in register address 0x2f with value 2'h1
3	Page 2	0x2f	7:6	2'h1: E-Fuse of INPUT_SYS is locked by writing into bit number [7:6] in register address 0x2f with value 2'h1
4	Page 3	0x2f	7:6	2'h1: E-Fuse of OUTPUT_SYS is locked by writing into bit number [7:6] in register address 0x2f with value 2'h1
5	Page A	0x2f	7:6	2'h1 : E-Fuse of PLLA_SYS is locked by writing into bit number [7:6] in register address 0x2f with value 2'h1
6	Page B	0x2f	7:6	2'h1 : E-Fuse of PLLB_SYS is locked by writing into bit number [7:6] in register address 0x2f with value 2'h1
7	Page C	0x2f	7:6	2'h1: E-Fuse of PLLC_SYS is locked by writing into bit number [7:6] in register address 0x2f with value 2'h1
8	Page D	0x2f	7:6	2'h1: E-Fuse of PLLD_SYS is locked by writing into bit number [7:6] in register address 0x2f with value 2'h1



E-Fuse Write Configuration Bits

This section will describe how to program the E-Fuse by writing into the register 0x0F in all the pages as mentioned in Table 24.

Table 25. E-Fuse Write Configuration Bits for all pages

S.NO	Page Number	Register Address	Bit Number	Value & It's Description
1	Page 0	0x0f	7:3	5'h0C: writing to bit number [7:3] in register address 0x0f with value 5'h0C to do E-Fuse write in GENERIC_SYS
2	Page 1	0x0f	7:3	5'h0C: writing to bit number [7:3] in register address 0x0f with value 5'h0C to do E-Fuse write in CLKMON_SYS
3	Page 2	0x0f	7:3	5'h0C: writing to bit number [7:3] in register address 0x0f with value 5'h0C to do E-Fuse write in INPUT_SYS
4	Page 3	0x0f	7:3	5'h0C: writing to bit number [7:3] in register address 0x0f with value 5'h0C to do E-Fuse write in OUTPUT_SYS
5	Page A	0x0f	7:3	5'h0C: writing to bit number [7:3] in register address 0x0f with value 5'h0C to do E-Fuse write in PLLA_SYS
6	Page B	0x0f	7:3	5'h0C: writing to bit number [7:3] in register address 0x0f with value 5'h0C to do E-Fuse write in PLLB_SYS
7	Page C	0x0f	7:3	5'h0C: writing to bit number [7:3] in register address 0x0f with value 5'h0C to do E-Fuse write in PLLC_SYS
8	Page D	0x0f	7:3	5'h0C: writing to bit number [7:3] in register address 0x0f with value 5'h0C to do E-Fuse write in PLLD_SYS



Configuration Bit to Remove Manual Wake Up for Primary E-Fuse

Manual wake-up of slave subsystems is enabled while programming the E-Fuse. As a final step the manual wake-up mode needs to be disabled in the GENERIC_SYS page so that the chip will wake-up autonomously

This section will describe how to remove manual wakeup by writing into a register 0x2f in GENERIC_SYS as mentioned in Table 25.

Table 26. Configuration Bit to Remove Manual Wakeup for Primary E-Fuse

S.NO	Page Number	Register Address	Bit Number	Value & It's Description
1	Page 0	0x2f	4	1'h1: (writing to bit number 4 in register address 0x2f with value 'h1 to remove manual wake up)

Pseudo Code: Programming the Primary E-Fuse

VDD and VDDIN supply should be set to 2.5V while programming the E-Fuse

GENERIC_SYS

```
STEP 1: Write the GENERIC_SYS page number configuration i2c.i2cw(device_address, 0xff, 0x00)
```

STEP 2: Write the GENERIC_SYS NVM Registers configuration

STEP 3: Refer E-Fuse Write Configuration Bits section described earlier.

Write to bit number [7:3] in register address 0x0f with value 5'hC to program E-Fuse registers of GENERIC_SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```

STEP 4: Refer Configuration Bits to Force Power-up of Digital Slave Subsystems described earlier

Force Enable all slaves [INPUT_SYS, CLKMON_SYS, OUTPUT_SYS, PLLA_SYS, PLLB_SYS, PLLC_SYS,PLLD_SYS] by programming 0xE0 & 0xE1 both with value 7'h7F

```
i2c.i2cw(device_address,0xe0,0x7f)
i2c.i2cw(device_address,0xe1,0x7f)
```

INPUT SYS

```
STEP 5: Write the INPUT_SYS page number configuration 
i2c.i2cw(device address, 0xff, 0x02)
```

```
STEP 6: Refer E-Fuse Lock Configuration Bits
```

Write the INPUT_SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock E-Fuse of INPUT_SYS

STEP 7: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0f with value 5'hC to program E-Fuse Registers of INPUT SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```



CLKMON SYS

```
STEP 8: Write the CLKMON_SYS page number configuration
         i2c.i2cw(device address, 0xff, 0x01)
STEP 9: Refer E-Fuse Lock Configuration Bits
Write the CLKMON SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock E-Fuse of
CLKMON_SYS
STEP 10: Refer E-Fuse Write Configuration Bits
Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of CLKMON_SYS
         i2c.i2cw(device address, 0x0f, 0x00)
         i2c.i2cw(device address, 0x0f, 0xc0)
         i2c.i2cw(device address, 0x0f, 0x00)
OUTPUT SYS
STEP 11: Write the OUTPUT_SYS page number configuration
         i2c.i2cw(device address, 0xff, 0x03)
STEP 12: Refer E-Fuse Lock Configuration Bits
Write the OUTPUT SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock E-Fuse of
OUTPUT_SYS
STEP 13: Refer E-Fuse Write Configuration Bits
Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of OUTPUT_SYS
         i2c.i2cw(device address, 0x0f, 0x00)
         i2c.i2cw(device address, 0x0f, 0xc0)
         i2c.i2cw(device address, 0x0f, 0x00)
PLLA SYS
STEP 14: Write the PLLA_SYS page number configuration
         i2c.i2cw(device address, 0xff, 0x0a)
STEP 15: Refer E-Fuse Lock Configuration Bits
Write the PLLA SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock
E-Fuse of PLLA SYS
STEP 16: Refer E-Fuse Write Configuration Bits
Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of PLLA SYS
         i2c.i2cw(device address, 0x0f, 0x00)
         i2c.i2cw(device address, 0x0f, 0xc0)
         i2c.i2cw(device address, 0x0f, 0x00)
PLLB_SYS
STEP 17: Write the PLLB_SYS page number configuration
         i2c.i2cw(device address, 0xff, 0x0b)
STEP 18: Refer E-Fuse Lock Configuration Bits
Write the PLLB SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock
E-Fuse of PLLB_SYS
STEP 19: Refer E-Fuse Write Configuration Bits
Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of PLLB_SYS
         i2c.i2cw(device address, 0x0f, 0x00)
         i2c.i2cw(device address, 0x0f, 0xc0)
         i2c.i2cw(device address, 0x0f, 0x00)
```



PLLC_SYS

```
STEP 20: Write the PLLC_SYS page number configuration
         i2c.i2cw(device address, 0xff, 0x0c)
STEP 21: Refer E-Fuse Lock Configuration Bits
Write the PLLC_SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock
E-Fuse of PLLC_SYS
STEP 22: Refer E-Fuse Write Configuration Bits
Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of PLLC SYS
         i2c.i2cw(device address, 0x0f, 0x00)
         i2c.i2cw(device address, 0x0f, 0xc0)
         i2c.i2cw(device address, 0x0f, 0x00)
PLLD_SYS
STEP 23: Write the PLLD_SYS page number configuration
         i2c.i2cw(device address, 0xff, 0x0d)
STEP 24: Refer E-Fuse Lock Configuration Bits
Write the PLLD_SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock
E-Fuse of PLLD_SYS
STEP 25: Refer E-Fuse Write Configuration Bits
Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of PLLD_SYS
         i2c.i2cw(device address, 0x0f, 0x00)
         i2c.i2cw(device address, 0x0f, 0xc0)
         i2c.i2cw(device address, 0x0f, 0x00)
Removing Manual Wake-up and Locking GENERIC_SYS E-Fuse
STEP 26: Write the GENERIC_SYS page number configuration
         i2c.i2cw(device address, 0xff, 0x00)
STEP 27: Refer Configuration Bit to Remove Manual Wake Up for Primary E-Fuse
```

Write to bit number 4 in register address 0x2F with value 1'h1 in GENERIC_SYS to Configuration Bit to Remove Manual Wake Up

i2c.i2crmw (device_address, 0x2f, 0x4, 0x1, 0x01) //i2crmw function register 0x2f bit number 4 writing with the value 1'h1

Note: i2crmw(dev_address,register_address,bit_postion,total_bits,value)

STEP 28: Refer E-Fuse Lock Configuration Bits

Write to bit number [7:6] in register address 0x2F with value 2'h1 in in GENERIC_SYS to lock the E-Fuse $i2c.i2crmw(device_address, 0x2f, 0x7, 0x2, 0x01)$ //i2crmw function register 0x2f bit number 7:6 writing with the value 2'h1

STEP 29: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of GENERIC_SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```

STEP 30: Reset the chip or recycle Power for the chip to wake-up autonomously based on NVM configuration programmed in the primary E-Fuse.



Programming the Secondary E-Fuse

This section describes Secondary E-Fuse program configuration for all the pages [GENERIC_SYS, INPUT_SYS, CLKMON_SYS, OUTPUT_SYS, PLLA_SYS, PLLB_SYS, PLLC_SYS, PLLD_SYS].

Configuration Bit to Escape to PROGRAM_CMD State in GENERIC_SYS

With the primary E-Fuse programmed and locked the chip will autonomously wake-up and reach ACTIVE_STATE. For the E-Fuse writes the chip needs to be in PROGRAM_CMD state.

This section will describe how to do escape from ACTIVE_STATE to PROGRAM_CMD state in GENERIC_SYS by writing into the register 0x0F in GENERIC_SYS as mentioned in Table 26.

Table 27. Configuration Bit To Escape to PROGRAM_CMD State in GENERIC_SYS

S.NO	Page Number	Register Address	Bit Number	Value & It's Description
1	Page 0	0x0f	1	1'h1: writing to bit number 1 in register address 0x0f with value 1'h1 to do Escape to PROGRAM_CMD state in GENERIC_SYS

Configuration Bit to Change the E-Fuse pointer

This section will describe how to point slaves to secondary E-Fuse by writing into a register 0x22 in GENERIC_SYS as mentioned in Table 27.

Table 28. Configuration Bit to change the E-Fuse pointer

S.NO	Page Number	Register Address	Bit Number	Value & It's Description
1	Page 0	0x22	7:0	8'hFF: (writing to bit number [7:0] in register address 0x22 with value 8'hFF to point slaves[INPUT_SYS,CLKMON_SYS,OUTPUT_SY S,PLLA_SYS, PLLB_SYS,PLLC_SYS,PLLD_SYS] to secondary E-Fuse)

Configuration Bit to Enable Manual Wake Up for Secondary E-Fuse

This section will describe how to enable manual wakeup for secondary E-Fuse by writing into a register 0x10 in GENERIC_SYS as mentioned in Table 28.

Table 29. Configuration Bit to Enable Manual Wakeup for Secondary E-Fuse

S.NO	Page Number	Register Address	Bit Number	Value & It's Description
1	Page 0	0x10	7	1'h1: (writing to bit number 7 in register address 0x10 with value 1'h1 to select manual wake up)
2	Page 0	0x10	6	1'h0: (writing to bit number 6 in register address 0x10 with value 1'h0 to select manual wake up)



Pseudo Code: Programming the Secondary E-Fuse

GENERIC SYS

STEP 1: Write the GENERIC_SYS page number configuration

```
i2c.i2cw(device address, 0xff, 0x00)
```

STEP 2: Refer Configuration Bit To Escape To PROGRAM CMD State in GENERIC SYS

Write to bit number 1 in register address 0x0F with value 1'h1 to escape to PROGRAM CMD state in GENERIC SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0x02)
i2c.i2cw(device_address,0x0f,0x00)
```

STEP 3: Refer Configuration Bit to Change the E-Fuse pointer

Write to bit number [7:0] in register address 0x22 with value 8'hFF to point slaves [INPUT_SYS,CLKMON_SYS,OUTPUT_SYS,PLLA_SYS,PLLB_SYS,PLLC_SYS,PLLD_SYS] to secondary E-Fuse in GENERIC_SYS

```
i2c.i2cw(device address, 0x22, 0xff)
```

STEP 4: Refer Configuration Bit to Enable Manual Wake Up for Secondary E-Fuse

Write to bit number 7 in register address 0x10 with value 1'h1 to select for manual wakeup in GENERIC_SYS

i2c.i2crmw (device_address, 0x10, 0x7, 0x1, 0x01) //i2crmw function register 0x10 bit number 7 writing with the value 1'h1

STEP 5: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of GENERIC_SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```

STEP 6: Reset the chip or recycle power for the E-Fuse pointers to get updated

STEP 7: Refer Configuration Bits to Force Power-up of Digital Slave Subsystems

Force Enable all slaves [INPUT_SYS, CLKMON_SYS, OUTPUT_SYS, PLLA_SYS, PLLB_SYS, PLLC_SYS, PLLD_SYS] by programming 0xE0 & 0xE1 both with value 7'h7F

```
i2c.i2cw(device_address,0xe0,0x7f)
i2c.i2cw(device_address,0xe1,0x7f)
```

INPUT_SYS

STEP 8: Write the INPUT_SYS page number configuration

```
i2c.i2cw(device address, 0xff, 0x02)
```

STEP 9: Refer E-Fuse Lock Configuration Bits

Write the INPUT_SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock E-Fuse of INPUT_SYS

STEP 10: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of INPUT_SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```



CLKMON SYS

```
STEP 11: Write the CLKMON_SYS page number configuration
```

```
i2c.i2cw(device address, 0xff, 0x01)
```

STEP 12: Refer E-Fuse Lock Configuration Bits

Write the CLKMON_SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock E-Fuse of CLKMON_SYS

STEP 13: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of CLKMON_SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```

OUTPUT SYS

STEP 14: Write the OUTPUT_SYS page number configuration

```
i2c.i2cw(device address, 0xff, 0x03)
```

STEP 15: Refer E-Fuse Lock Configuration Bits

Write the OUTPUT_SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock E-Fuse of OUTPUT_SYS

STEP 16: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of OUTPUT_SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```

PLLA_SYS

STEP 17: Write the PLLA_SYS page number configuration

```
i2c.i2cw(device address, 0xff, 0x0a)
```

STEP 18: Refer E-Fuse Lock Configuration Bits

Write the PLLA_SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock E-Fuse of PLLA_SYS

STEP 19: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of PLLA_SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```

PLLB SYS

STEP 20: Write the PLLB_SYS page number configuration

```
i2c.i2cw(device address, 0xff, 0x0b)
```

STEP 21: Refer E-Fuse Lock Configuration Bits

Write the PLLB_SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock E-Fuse of PLLB_SYS

STEP 22: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of PLLB_SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```



PLLC SYS

```
STEP 23: Write the PLLC_SYS page number configuration
```

```
i2c.i2cw(device address, 0xff, 0x0c)
```

STEP 24: Refer E-Fuse Lock Configuration Bits

Write the PLLC_SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock E-Fuse of PLLC_SYS

STEP 25: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of PLLC_SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```

PLLD SYS

STEP 26: Write the PLLD_SYS page number configuration

```
i2c.i2cw(device address, 0xff, 0x0d)
```

STEP 27: Refer E-Fuse Lock Configuration Bits

Write the PLLD_SYS NVM Registers configuration and write 0x2F register for bit number [7:6] with 2'h1 to lock E-Fuse of PLLD_SYS

STEP 28: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of PLLD SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```

Programming GENERIC SYS E-Fuse to Remove Manual Wake Up in Secondary E-Fuse

STEP 29: Write the GENERIC_SYS page number configuration

```
i2c.i2cw(device address, 0xff, 0x00)
```

STEP 30: Refer Configuration Bit To Escape To PROGRAM_CMD State in GENERIC_SYS

Write to bit number 1 in register address 0x0F with value 1'h1 to escape to PROGRAM CMD state in GENERIC SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0x02)
i2c.i2cw(device_address,0x0f,0x00)
```

STEP 31: Write to bit number 6 in register address 0x10 with value 1'h1 in GENERIC_SYS to Configuration Bit to Remove Manual Wake Up in secondary E-Fuse

i2c.i2crmw (device_address, 0x10, 6, 0x1, 0x01) //i2crmw function register 0x10 bit number 6 writing with the value 1'h1

Note: i2crmw(dev_address,register_address,bit_postion,total_bits,value)

STEP 32: Refer E-Fuse Write Configuration Bits

Write to bit number [7:3] in register address 0x0F with value 5'hC to program E-Fuse Registers of GENERIC_SYS

```
i2c.i2cw(device_address,0x0f,0x00)
i2c.i2cw(device_address,0x0f,0xc0)
i2c.i2cw(device_address,0x0f,0x00)
```

STEP 33: Reset Chip or recycle power for the chip to wake-up autonomously from the second E-Fuse



Register Map Details

Table 30. PAGE 0: Generic Master System Related registers:

Registers from 10h to 4Fh are equivalent NVMCopy Registers for this Page

Register Name	Register Number	Bit Range	Access Type	Default Value	Description
VERSION_ID	01h	7:0	R	Cxh (SiT95148)	Overall Platform Revision x = 1 or 2
		7	R	00h	SPARE
		6	R	00h	SPARE
		5	R	00h	SPARE
CTATUS 4 CENERIC	004	4	R	00h	SPARE
STATUS_1_GENERIC	02h	3	R	00h	SPARE
		2	R	00h	Dynamic status for xoclk_loss,
		1	R	00h	SPARE
		0	R	00h	SPARE
		7	R/W	1h	SPARE
		6	R/W	1h	SPARE
		5	R/W	1h	SPARE
NOTIFY A OFNERIO	001	4	R/W	1h	SPARE
NOTIFY_1_GENERIC	03h	3	R/W	1h	SPARE
		2	R/W	1h	Sticky/Notify status for _xoclk_loss,
		1	R/W	1h	SPARE
		0	R/W	1h	SPARE
		7	R/W	1h	SPARE
		6	R/W	1h	SPARE
		5	R/W	1h	SPARE
		4	R/W	1h	SPARE
MASKb_1_GENERIC	04h	3	R/W	1h	SPARE
					Mask bit for NOTIFY_1_GENERIC (03h)
		2	R/W	1h	If programmed as '0': Mask sticky/Notify bit generation for 03h[2].
		1	R/W	1h	SPARE
		0	R/W	1h	SPARE
		3:2	R/W	00h	0: DCO_PLLA 1: DCO_PLLB 2: DCO_PLLC 3: DCO_PLLD
Directives_GENERIC	05h	1	R/W	00h	dco increment commonly used for all plls if 0xe7[7] is set as '1'
		0	R/W	00h	dco decrement commonly used for all plls if 0xe7[7] is set as '1'



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		7	R	00h	Dynamic status for plld_ho_freeze
		6	R	00h	Dynamic status for pllc_ho_freeze
		5	R	00h	Dynamic status for pllb_ho_freeze
STATUS_2_GENERIC	06h	4	R	00h	Dynamic status for plla_ho_freeze
STATUS_Z_GENERIC	0011	3	R	00h	Dynamic status for plld_loss_of_lock
		2	R	00h	Dynamic status for pllc_loss_of_lock
		1	R	00h	Dynamic status for pllb_loss_of_lock
		0	R	00h	Dynamic status for plla_loss_of_lock
		7	R/W	1h	Sticky/Notify status for plld_ho_freeze
		6	R/W	1h	Sticky/Notify status for pllc_ho_freeze
		5	R/W	1h	Sticky/Notify status for pllb_ho_freeze
NOTIFY_2_GENERIC	07h	4	R/W	1h	Sticky/Notify status for plla_ho_freeze
NOTIFI_2_GENERIC	0711	3	R/W	1h	Sticky/Notify status for plld_loss_of_lock
		2	R/W	1h	Sticky/Notify status for pllc_loss_of_lock
		1	R/W	1h	Sticky/Notify status for pllb_loss_of_lock
		0	R/W	1h	Sticky/Notify status for plla_loss_of_lock
		7	R/W	1h	Mask bit for NOTIFY_2_GENERIC (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[7].
		6	R/W	1h	Mask bit for NOTIFY_2_GENERIC (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[6].
		5	R/W	1h	Mask bit for NOTIFY_2_GENERIC (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[5].
MASKE 2 GENERIC	08h	4	R/W	1h	Mask bit for NOTIFY_2_GENERIC (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[4].
MASKb_2_GENERIC	0011	3	R/W	1h	Mask bit for NOTIFY_2_GENERIC (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[3].
		2	R/W	1h	Mask bit for NOTIFY_2_GENERIC (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[2].
		1	R/W	1h	Mask bit for NOTIFY_2_GENERIC (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[1].
		0	R/W	1h	Mask bit for NOTIFY_2_GENERIC (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[0].



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
PRG_Directives_GENERIC	0Fh	7:3	R/W	0h	PRG_CMD Directives: 5b1_1000: PROGRAM_EFUSE 5b0_1100: READ_EFUSE 5b0_0110: Copy NVM Copy to Settings 5b1_1011: Proceed to Active
		2	R/W	0h	SPARE
		1	R/W	0h	Escape to the PRG_CMD state from ACTIVE state
		7	R/W	0h	Selects between maual_wake_upb and manual_wake_up2b
NIVMDI I EN CENEDIC	10h	6	R/W	0h	select '0' to enable manual wake up sequence
NVMPLLEN_GENERIC	10h	5:4	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}
		3:0	R/W	0h	Bits {3,2,1,0} correspond to enable of PLL {D,C,B,A}: Active Low.
		7	R/W	0h	Select the direction of FLEXIO14. '0' – Input, '1' – Output
NVMFLEXIO8_GENERIC	18h	6:4	R/W	Oh	Mux select to bring out internal signals on FLEXIO14, if programmed as output 3'b000: 0 3'b001: Ored_all_notify (clock loss for clkin0/1/2/3 + Freq drift coarse for clkin 0/1/2/3 + Freq drift coarse for clkin 0/1/2/3 + Loss of lock for PLL A/B/C/D+HO freeze for PLL A/B/C/D) 3'b010: Ored_all_pll_ntfy (Loss of lock for PLL A/B/C/D)+HO freeze for PLL A/B/C/D) 3'b011: Ored_all_clkmon_ntfy ((clock loss for clkin0/1/2/3/ + Freq drift coarse for clkin 0/1/2/3 + Freq drift coarse for clkin 0/1/2/3) 3'b100: Dynamic_Clock_Monitoring_Status 3'b101: Internal debug 3'b110: Internal debug 3'b111: Internal debug
		3	R/W	0h	Select the direction of FLEXIO15. '0' – Input, '1' – Output



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
	Number	2:0	R/W	Oh	Mux select to bring out internal signals on FLEXIO15, if programmed as output 3'b000: 0 3'b001: Ored_all_notify (clock loss for clkin0/1/2/3/ + Freq drift coarse for clkin 0/1/2/3 + Freq drift coarse for clkin 0/1/2/3 + Loss of lock for PLL A/B/C/D+HO freeze for PLL A/B/C/D) 3'b010: Ored_all_pll_ntfy (Loss of lock for PLL A/B/C/D+HO freeze for PLL A/B/C/D) 3'b011: Ored_all_clkmon_ntfy ((clock loss for clkin0/1/2/3/ + Freq drift coarse for clkin 0/1/2/3) 3'b100: Dynamic_Clock_Monitoring_Status 3'b101: Internal debug
					3'b110 : Internal debug 3'b111 : Internal debug
		7	R/W	0h	if set '1', Enables vdd padring functionality(0x23[7]) for padring selection. Keeping at 0 enables pad rail switch, select 1 to ensure no switch and keep rail to left
NVMSPARE1_GENERIC	19h	6	R/W	0h	To map the external clock in select and allow the each pll independetly to force into holdover mode. Each pll ctrl - refer 0x2B[3:0]
FUSE_PTR_GENERIC	22h	7:0	R/W	0h	One Hot Decode for Fuse Pointer: Bits {7,6,5,4,3,2,1,0} correspond to fuse pointers for Pages 1, 2, 3, 4, A, B, C, D respectively Page 4 is reserved and not used.
XO4_GENERIC	23h	7	R/W	0h	'1' => Set VDDIO as VDDIN & '0' => Set VDDIO as VDD
		7:4	R/W	0h	One Hot Input Enable for the Clock Inputs 3:0 which are the 4 Clock inputs defined on Page 2: Active Low
BTOUT_IN_EN_GENERIC	24h	3:2	R/W	0h	One Hot Output Enable for Bottom Outputs 1:0 which are the 2 Bottom Fixed-Outputs defined on Page 3: Active Low
		1:0	R/W	0h	One Hot Output Enable for Top Outputs 1:0 which are the 2 Top Fixed-Outputs defined on Page 3: Active Low
FLEXOUTPUT_EN_GENERIC	25h	7:0	R/W	0h	One Hot Output Enable for Outputs 7:0 which are the 8 Flex-Outputs defined on Page 3: Active Low
OEB_CTRL	26h	7:6 5:4	R/W	0h 0h	Selects which PLL to run in free mode at wake up , this feature is enables by 0x23[5]: 0: PLLA 1: PLLB 2: PLLC 3: PLLD
		0.4	10,77		



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		3:2	R/W	0h	To program delay between enabling PLLA and other PLLs in fuse locked modes. 2'b00 - 4ms 2'b01 - 40 ms 2'b10 - 400 ms 2'b11 - 4s
		1	R/W	0h	if set as '1' then set PLLX_OEB as '1' if loss of lock status is asserted for respective PLL
		0	R/W	0h	if set as '1' then set PLLX_OEB as '1' if there is XO clock loss
		7	R/W	0h	If set '1', Interrupt will not be generated for DRIFT in freq for clk_in3
		6	R/W	0h	If set '1', Interrupt will not be generated for DRIFT in freq for clk_in2
		5	R/W	0h	If set '1', Interrupt will not be generated for DRIFT in freq for clk_in1
INTO MACK 4 CONFIG	075	4	R/W	0h	If set '1', Interrupt will not be generated for DRIFT in freq for clk_in0
INTR_MASK_1_CONFIG	27h	3	R/W	0h	If set '1', Interrupt will not be generated for CLOCK LOSS for clk_in3
		2	R/W	0h	If set '1', Interrupt will not be generated for CLOCK LOSS for clk_in2
		1	R/W	0h	If set '1', Interrupt will not be generated for CLOCK LOSS for clk_in1
		0	R/W	0h	If set '1', Interrupt will not be generated for CLOCK LOSS for clk_in0
		7	R/W	0h	If set '1', Interrupt will not be generated for LOSS OF LOCK for PLLA
		6	R/W	0h	If set '1', Interrupt will not be generated for LOSS OF LOCK for PLLB
		5	R/W	0h	If set '1', Interrupt will not be generated for LOSS OF LOCK for PLLC
INTO MACK A CONFIG	201-	4	R/W	0h	If set '1', Interrupt will not be generated for LOSS OF LOCK for PLLD
INTR_MASK_2_CONFIG	28h	3	R/W	0h	If set '1', Interrupt will not be generated for HOLDOVER FREEZE for PLLA
		2	R/W	0h	If set '1', Interrupt will not be generated for HOLDOVER FREEZE for PLLB
		1	R/W	0h	If set '1', Interrupt will not be generated for HOLDOVER FREEZE for PLLC
		0	R/W	0h	If set '1', Interrupt will not be generated for HOLDOVER FREEZE for PLLD
		7	R/W	0h	
		6	R/W	0h	
CHIP_FLEXIO_CONFIG	29h	5	R/W	0h	Reserved
		4	R/W	0h	
		3	R/W	0h	



Register Name	Register Number	Bit Range	Access Type	Default Value	Description		
		2:0	R/W	0h	001: SiT95148		
		7	R/W	0h	Enable the new I2C Address (if changed from the default 0x69)		
I2C_GENERIC	2Ah	6:2	R/W	0h	I2C Address static bits (when changed from 0b11010)		
		0:1	R/W	0h	Reserved		
		7:6	R/W	0h	PATTERN :{'01'/'10'} =] Efuse Locked, {'00'/'11'} =] Efuse NOT Locked		
OE_PATTERN_GENERIC	2Fh	2Fh	2Fh	5	R/W	0h	High Speed Enable for the I2C pads, HS_EN=0 ensures true I2C function (no pull up) for I2C. Don't care for SPI.
		4	R/W	0h	select '0' to enable manual wake up sequence		
		3:0	R/W	0h	Reserved		
OverwriteCLKIN1_2_GENERIC	E7h	7	R/W	0h	EN_COMMON_DCO_DECR		
RESET_REGISTER	FEh	7:0	R/W	0h	Register FE is a READ / WRITE register used to reset the chip. Writing 0x01 to this register will apply the reset to the digital and this is propagated asynchronously to the digital blocks. On writing a 0 to bit 0 of register FE, the reset is de-asserted and internal to the digital, the various clocks are used to perform the de-assertion reset synchronization for the appropriate clock domains.		
PAGE_NUMBER	FFh	7:0	R/W	0h	On all pages register FF is a READ / WRITE register used to change the page number		



Table 31. PAGE 1: Clock Monitor System Related registers:

Registers from 11h to 4Fh are equivalent NVMCopy Registers for this Page

Register Name	Register Number	Bit Range	Access Type	Default Value	Description	
		7	R	00h	Dynamic status for clk_in3_loss_OR_with_FD	
		6	R	00h	Dynamic status for clk_in2_loss_OR_with_FD	
		5	R	00h	Dynamic status for clk_in1_loss_OR_with_FD	
STATUS_CLKMON	02h	4	R	00h	Dynamic status for clk_in0_loss_OR_with_FD	
		3	R	00h	Dynamic status for clk_in3_loss	
		2	R	00h	Dynamic status for clk_in2_loss	
		1	R	00h	Dynamic status for clk_in1_loss	
		0	R	00h	Dynamic status for clk_in0_loss	
		7	R/W	1h	Sticky/Notify status for clk_in3_loss_OR_with_FD	
		6	R/W	1h	Sticky/Notify status for clk_in2_loss_OR_with_FD	
			5	R/W	1h	Sticky/Notify status for clk_in1_loss_OR_with_FD
NOTIFY_CLKMON	03h	4	R/W	1h	Sticky/Notify status for clk_in0_loss_OR_with_FD	
		3	R/W	1h	Sticky/Notify status for clk_in3_loss	
		2	R/W	1h	Sticky/Notify status for clk_in2_loss	
		1	R/W	1h	Sticky/Notify status for clk_in1_loss	
		0	R/W	1h	Sticky/Notify status for clk_in0_loss	
		7	R/W	1h	Mask bit for NOTIFY_CLKMON (03h) If programmed as '0': Mask sticky/Notify bit generation for 03h[7]	
		6	R/W	1h	Mask bit for NOTIFY_CLKMON (03h) If programmed as '0': Mask sticky/Notify bit generation for 03h[6]	
		5	R/W	1h	Mask bit for NOTIFY_CLKMON (03h) If programmed as '0': Mask sticky/Notify bit generation for 03h[5]	
MASKb_CLKMON	04h	4	R/W	1h	Mask bit for NOTIFY_CLKMON (03h) If programmed as '0': Mask sticky/Notify bit generation for 03h[4]	
		3	R/W	1h	Mask bit for NOTIFY_CLKMON (03h) If programmed as '0': Mask sticky/Notify bit generation for 03h[3]	
		2	R/W	1h	Mask bit for NOTIFY_CLKMON (03h) If programmed as '0': Mask sticky/Notify bit generation for 03h[2]	



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		1	R/W	1h	Mask bit for NOTIFY_CLKMON (03h) If programmed as '0': Mask sticky/Notify bit generation for 03h[1]
		0	R/W	1h	Mask bit for NOTIFY_CLKMON (03h) If programmed as '0': Mask sticky/Notify bit generation for 03h[0]
		7	R	00h	Dynamic status for clk3_freq_coarse_drifted
		6	R	00h	Dynamic status for clk2_freq_coarse_drifted
		5	R	00h	Dynamic status for clk1_freq_coarse_drifted
STATUS_FDCOARSE_CLKMON	06h	4	R	00h	Dynamic status for clk0_freq_coarse_drifted
		3	R	00h	Dynamic status for clk3_freq_fine_drifted
		2	R	00h	Dynamic status for clk2_freq_fine_drifted
		1	R	00h	Dynamic status for clk1_freq_fine_drifted
		0	R	00h	Dynamic status for clk0_freq_fine_drifted
		7	R/W	1h	Sticky/Notify status for clk3_freq_coarse_drifted
		6	R/W	1h	Sticky/Notify status for clk2_freq_coarse_drifted
		5	R/W	1h	Sticky/Notify status for clk1_freq_coarse_drifted
NOTICY EDCOADSE OF KNOW	07h	4	R/W	1h	Sticky/Notify status for clk0_freq_coarse_drifted
NOTIFY_FDCOARSE_CLKMON	U/n	3	R/W	1h	Sticky/Notify status for clk3_freq_fine_drifted
		2	R/W	1h	Sticky/Notify status for clk2_freq_fine_drifted
		1	R/W	1h	Sticky/Notify status for clk1_freq_fine_drifted
		0	R/W	1h	Sticky/Notify status for clk0_freq_fine_drifted
		7	R/W	1h	Mask bit for NOTIFY_FDCOARSE_CLKMON (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[7]
MASKb_FDCOARSE_CLKMON	08h	6	R/W	1h	Mask bit for NOTIFY_FDCOARSE_CLKMON (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[6]
		5	R/W	1h	Mask bit for NOTIFY_FDCOARSE_CLKMON (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[5]



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		4	R/W	1h	Mask bit for NOTIFY_FDCOARSE_CLKMON (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[4]
		3	R/W	1h	Mask bit for NOTIFY_FDCOARSE_CLKMON (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[3]
		2	R/W	1h	Mask bit for NOTIFY_FDCOARSE_CLKMON (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[2]
		1	R/W	1h	Mask bit for NOTIFY_FDCOARSE_CLKMON (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[1]
		0	R/W	1h	Mask bit for NOTIFY_FDCOARSE_CLKMON (07h) If programmed as '0': Mask sticky/Notify bit generation for 07h[0]
FD32_STATUS_COARSE_CLKMON	0Dh	7:0	R/W	0h	Reserved
FD10_STATUS_COARSE_CLKMON	0Eh	7:0	R/W	0h	Reserved
PRG Directives CLKMON	0Fh	7:3	R/W	0h	PRG_CMD Directives: 5b1_1000: PROGRAM_EFUSE 5b0_1100: READ_EFUSE 5b0_0110: Copy NVM Copy to Settings 5b1_1011: Proceed to Active
		2	R/W	0h	Spare
		1	R/W	0h	Escape to the PRG_CMD state from ACTIVE state
		7:6	R/W	0h	IN3_VAL_TIME: timer setting for deassertion of clock loss for FD3 Values {0,1,2,3} correspond to {2ms, 100ms, 200ms, 1sec}
OL DEGG OLIVINON	441	5:4	R/W	0h	IN2_VAL_TIME : timer setting for deassertion of clock loss for FD2 Values {0,1,2,3} correspond to {2ms, 100ms, 200ms, 1sec}
CL_REG2_CLKMON	11h	3:2	R/W	0h	IN1_VAL_TIME : timer setting for deassertion of clock loss for FD1 Values {0,1,2,3} correspond to {2ms, 100ms, 200ms, 1sec}
		1:0	R/W	0h	IN0_VAL_TIME : timer setting for deassertion of clock loss for FD0 Values {0,1,2,3} correspond to {2ms, 100ms, 200ms, 1sec}
CL2 SET TUD2 CLUMON	40h	7:3	R/W	0h	SPARE
CL3_SET_THR2_CLKMON	12h	2:0	R/W	0h	IN3 19-bit Threshold Value
CL3_SET_THR1_CLKMON	13h	7:0	R/W	0h	GUI calculates the correct CL register
CL3_SET_THR0_CLKMON	14h	7:0	R/W	0h	threshold trigger value for IN3



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
CL2 SET THR2 CLKMON	15h	7:3	R/W	0h	SPARE
GEZ_GET_TTIKZ_GERMON	1011	2:0	R/W	0h	IN2 19-bit Threshold Value
CL2_SET_THR1_CLKMON	16h	7:0	R/W	0h	GUI calculates the correct CL register
CL2_SET_THR0_CLKMON	17h	7:0	R/W	0h	threshold trigger value for IN2
CL1_SET_THR2_CLKMON	18h	7:3	R/W	0h	SPARE
CET_SET_THR2_CERMON	1011	2:0	R/W	0h	IN1 19-bit Threshold Value
CL1_SET_THR1_CLKMON	19h	7:0	R/W	0h	GUI calculates the correct CL register
CL1_SET_THR0_CLKMON	1Ah	7:0	R/W	0h	threshold trigger value for IN1
CL0_SET_THR2_CLKMON	1Bh	7:3	R/W	0h	SPARE
CLU_SET_THR2_CLRMON	TOIT	2:0	R/W	0h	IN0 19-bit Threshold Value
CL0_SET_THR1_CLKMON	1Ch	7:0	R/W	0h	GUI calculates the correct CL register
CL0_SET_THR0_CLKMON	1Dh	7:0	R/W	0h	threshold trigger value for IN0
CL3 CLR THR2 CLKMON	4Fb	7:3	R/W	0h	SPARE
CL3_CLR_THR2_CLRWON	1Eh	2:0	R/W	0h	IN3 19-bit Threshold Value
CL3_CLR_THR1_CLKMON	1Fh	7:0	R/W	0h	GUI calculates the correct CL register
CL3_CLR_THR0_CLKMON	20h	7:0	R/W	0h	threshold clear value for IN3
CLA CLD TUDA CLKMON	045	7:3	R/W	0h	SPARE
CL2_CLR_THR2_CLKMON	21h	2:0	R/W	0h	IN2 19-bit Threshold Value
CL2_CLR_THR1_CLKMON	22h	7:0	R/W	0h	GUI calculates the correct CL register
CL2_CLR_THR0_CLKMON	23h	7:0	R/W	0h	threshold clear value for IN2
OLA OLD TUDO OLKMON	0.41	7:3	R/W	0h	SPARE
CL1_CLR_THR2_CLKMON	24h	2:0	R/W	0h	IN1 19-bit Threshold Value
CL1_CLR_THR1_CLKMON	25h	7:0	R/W	0h	GUI calculates the correct CL register
CL1_CLR_THR0_CLKMON	26h	7:0	R/W	0h	threshold clear value for IN1
CLA CLE TURG CLUMON	075	7:3	R/W	0h	SPARE
CL0_CLR_THR2_CLKMON	27h	2:0	R/W	0h	INO 19-bit Threshold Value
CL0_CLR_THR1_CLKMON	28h	7:0	R/W	0h	GUI calculates the correct CL register
CL0_CLR_THR0_CLKMON	29h	7:0	R/W	0h	threshold clear value for IN0
					FDCOARSE Enable Bit
FD_REG1_CLKMON	2Ah	7:4	R/W	0h	Value of position {3,2,1,0} correspond to Inputs {3,2,1,0}
		3:0	R/W	0h	FDFINE Enable Bit Value of position {3,2,1,0} correspond to Inputs {3,2,1,0}
		7	R/W	0h	SPARE
FD_REG2_CLKMON	2Bh	6:3	R/W	0h	XO divider configuration for FD monitors. GUI configures these dividers



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		2:0	R/W	0h	Golden reference clock selection for frequency drift monitors. Value of 4 corresponds to the XO Reference Value of {3,2,1,0} correspond to Inputs {3,2,1,0}
	0.01	7:4	R/W	0h	FD3 divider configuration for FD monitors. GUI configures these dividers
FD_REG3_CLKMON	2Ch	3:0	R/W	0h	FD2 divider configuration for FD monitors. GUI configures these dividers
	-51	7:4	R/W	0h	FD1 divider configuration for FD monitors. GUI configures these dividers
FD_REG4_CLKMON	2Dh	3:0	R/W	0h	FD0 divider configuration for FD monitors. GUI configures these dividers
		7:4	R/W	0h	SPARE
FXOBYFIN3_LOG2_BAND	2Eh	3:0	R/W	0h	IN3 FD monitor configuration bits calculated by GUI
FXOBYFIN2_LOG2_BAND	2Fh	7:6	R/W	0h	PATTERN :{'01'/'10'} => Efuse Locked, {'00'/'11'} => Efuse NOT Locked
		5:4	R/W	0h	SPARE
FXOBYFIN2_LOG2_BAND	2Fh	3:0	R/W	0h	IN2 FD monitor configuration bits calculated by GUI
EVORVEINA FINO LOCA DAND	201-	7:4	R/W	0h	IN1 FD monitor configuration bits calculated by GUI
FXOBYFIN1_FIN0_LOG2_BAND	30h	3:0	R/W	0h	IN0 FD monitor configuration bits calculated by GUI
		7:6	R/W	0h	PLLA ACTIVE Clock Selection 0 : CLKIN0, 1 : CLKIN1, 2 : CLKIN2, 3 : CLKIN3
		5:4	R/W	0h	PLLA SPARE0 Clock Selection 0 : CLKIN0, 1 : CLKIN1, 2 : CLKIN2, 3 : CLKIN3
PLLA_ACT_SPARE_SEL	31h	3:2	R/W	0h	PLLA SPARE1 Clock Selection 0 : CLKIN0, 1 : CLKIN1, 2 : CLKIN2, 3 : CLKIN3
		1:0	R/W	0h	PLLA SPARE2 Clock Selection 0: CLKIN0, 1: CLKIN1, 2: CLKIN2, 3: CLKIN3
FD3_CLR_THRFINE_CLKMON	32h	7:0	R/W	0h	IN3 FD clear threshold is calculated as 2X of FD3_CLR_THRFINE_CLKMON
FD2_CLR_THRFINE_CLKMON	33h	7:0	R/W	0h	IN2 FD clear threshold is calculated as 2X of FD2_CLR_THRFINE_CLKMON
FD1_CLR_THRFINE_CLKMON	34h	7:0	R/W	0h	IN1 FD clear threshold is calculated as 2X of FD1_CLR_THRFINE_CLKMON
FD0_CLR_THRFINE_CLKMON	35h	7:0	R/W	0h	IN0 FD clear threshold is calculated as 2X of FD0_CLR_THRFINE_CLKMON
FD32_CLR_THRCOARSE_CLKMON	36h	7:4	R/W	0h	IN3 FD clear threshold is calculated as 100*(FD3_CLR_THRCOARSE_CLKMON +1)



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		3:0	R/W	0h	IN2 FD clear threshold is calculated as 100*(FD2_CLR_THRCOARSE_CLKMON +1)
ED40 CLB THECOARSE CLVMON	37h	7:4	R/W	0h	IN1 FD clear threshold is calculated as 100*(FD1_CLR_THRCOARSE_CLKMON +1)
FD10_CLR_THRCOARSE_CLKMON	3711	3:0	R/W	0h	IN0 FD clear threshold is calculated as 100*(FD0_CLR_THRCOARSE_CLKMON +1)
	001	7:4	R/W	0h	IN3 FD set threshold is calculated as 100*(SET FD3_SET_THRCOARSE_CLKMON+1)
FD32_SET_THRCOARSE_CLKMON	38h	3:0	R/W	0h	IN2 FD set threshold is calculated as 100*(FD2_SET_THRCOARSE_CLKMON +1)
FD10_SET_THRCOARSE_CLKMON	39h	7:4	R/W	0h	IN1 FD set threshold is calculated as 100*(SET_TH FD1_SET_THRCOARSE_CLKMON +1)
	3911	3:0	R/W	0h	IN0 FD set threshold is calculated as 100*(FD0_SET_THRCOARSE_CLKMON +1)
FD3_FGBYFM2_CLKMON	3Ah	7:0	R/W	0h	IN3 FD monitor configuration bits calculated by GUI
FD3_FGBYFM1_CLKMON	3Bh	7:0	R/W	0h	IN3 FD monitor configuration bits calculated by GUI
FD3_FGBYFM0_CLKMON	3Ch	7:0	R/W	0h	IN3 FD monitor configuration bits calculated by GUI
FD2_FGBYFM2_CLKMON	3Dh	7:0	R/W	0h	IN2 FD monitor configuration bits calculated by GUI
FD2_FGBYFM1_CLKMON	3Eh	7:0	R/W	0h	IN2 FD monitor configuration bits calculated by GUI
FD2_FGBYFM0_CLKMON	3Fh	7:0	R/W	0h	IN2 FD monitor configuration bits calculated by GUI
FD1_FGBYFM2_CLKMON	40h	7:0	R/W	0h	IN1 FD monitor configuration bits calculated by GUI
FD1_FGBYFM1_CLKMON	41h	7:0	R/W	0h	IN1 FD monitor configuration bits calculated by GUI
FD1_FGBYFM0_CLKMON	42h	7:0	R/W	0h	IN1 FD monitor configuration bits calculated by GUI
FD0_FGBYFM2_CLKMON	43h	7:0	R/W	0h	IN0 FD monitor configuration bits calculated by GUI
FD0_FGBYFM1_CLKMON	44h	7:0	R/W	0h	IN0 FD monitor configuration bits calculated by GUI
FD0_FGBYFM0_CLKMON	45h	7:0	R/W	0h	IN0 FD monitor configuration bits calculated by GUI



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		7:6	R/W	0h	0: CL3 1: CL3 + FD3 COARSE 2: CL3 + FD3 FINE 3: CL3 + FD3 COARSE + FD3 FINE
CLKX HITLESS SW SOURCE	46h	5:4	R/W	0h	0 : CL2 1 : CL2 + FD2 COARSE 2: CL2 + FD2 FINE 3 : CL2 + FD2 COARSE + FD2 FINE
CLRX_HITLESS_SW_SOURCE	4011	3:2	R/W	0h	0 : CL1 1 : CL1 + FD1 COARSE 2: CL1 + FD1 FINE 3 : CL1 + FD1 COARSE + FD1 FINE
		1:0	R/W	0h	0: CL0 1: CL0 + FD0 COARSE 2: CL0 + FD0 FINE 3: CL0 + FD0 COARSE + FD0 FINE
		7:6	R/W	0h	PLLB ACTIVE Clock Selection 0 : CLKIN0, 1 : CLKIN1, 2 : CLKIN2, 3 : CLKIN3
		5:4	R/W	0h	PLLB SPARE0 Clock Selection 0: CLKIN0, 1: CLKIN1, 2: CLKIN2, 3: CLKIN3
PLLB_ACT_SPARE_SEL	49h	3:2	R/W	0h	PLLB SPARE1 Clock Selection 0: CLKIN0, 1: CLKIN1, 2: CLKIN2, 3: CLKIN3
		1:0	R/W	0h	PLLB SPARE2 Clock Selection 0: CLKIN0, 1: CLKIN1, 2: CLKIN2, 3: CLKIN3
		7:6	R/W	0h	PLLC ACTIVE Clock Selection 0 : CLKIN0, 1 : CLKIN1, 2 : CLKIN2, 3 : CLKIN3
		5:4	R/W	0h	PLLC SPARE0 Clock Selection 0: CLKIN0, 1: CLKIN1, 2: CLKIN2, 3: CLKIN3
PLLC_ACT_SPARE_SEL	4Ah	3:2	R/W	0h	PLLC SPARE1 Clock Selection 0: CLKIN0, 1: CLKIN1, 2: CLKIN2, 3: CLKIN3
		1:0	R/W	0h	PLLC SPARE2 Clock Selection 0: CLKIN0, 1: CLKIN1, 2: CLKIN2, 3: CLKIN3
		7:6	R/W	0h	PLLD ACTIVE Clock Selection 0 : CLKIN0, 1 : CLKIN1, 2 : CLKIN2, 3 : CLKIN3
		5:4	R/W	0h	PLLD SPARE0 Clock Selection 0: CLKIN0, 1: CLKIN1, 2: CLKIN2, 3: CLKIN3
PLLD_ACT_SPARE_SEL	4Bh	3:2	R/W	0h	PLLD SPARE1 Clock Selection 0: CLKIN0, 1: CLKIN1, 2: CLKIN2, 3: CLKIN3
		1:0	R/W	0h	PLLD SPARE2 Clock Selection 0: CLKIN0, 1: CLKIN1, 2: CLKIN2, 3: CLKIN3

SiT95148 Cascade ClkSoC High-Performance 11-output MEMS Jitter Cleaner, Clock Synchronizer



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
FD3_SET_THRFINE_CLKMON	4Ch	7:0	R/W	0h	IN3 FD set threshold is calculated as 2X of FD3_SET_THRFINE_CLKMON
FD2_SET_THRFINE_CLKMON	4Dh	7:0	R/W	0h	IN2 FD set threshold is calculated as 2X of FD2_SET_THRFINE_CLKMON
FD1_SET_THRFINE_CLKMON	4Eh	7:0	R/W	0h	IN1 FD set threshold is calculated as 2X of FD1_SET_THRFINE_CLKMON
FD0_SET_THRFINE_CLKMON	4Fh	7:0	R/W	0h	IN0 FD set threshold is calculated as 2X FD0_SET_THRFINE_CLKMON _THR
PAGE_NUMBER	FFh	7:0	R/W	0h	On all pages register FF is a READ / WRITE register used to change the page number



Table 32. PAGE 2: Input System Related Registers.

Registers from 10h to 4Fh are equivalent NVMCopy Registers for this Page

Register Name	Register Number	Bit Range	Access Type	Default Value	Description
PRG_Directives_INPAGE	0Fh	7:3	R/W	0h	PRG_CMD Directives: 5b1_1000: PROGRAM_EFUSE 5b0_1100: READ_EFUSE 5b0_0110: Copy NVM Copy to Settings 5b1_1011: Proceed to Active
		2	R/W	0h	Spare
		1	R/W	0h	Escape to the PRG_CMD state from ACTIVE state
CLKIN0_DIVN1_INT1_INPAGE	10h	7:0	R/W	0h	IN0 DIVN1 Divider Integer Value
		7	R/W	0h	IN0 DIVN1 Integer Mode of Division
CLKIN0_DIVN1_INT2_INPAGE	11h	6	R/W	0h	Enable the Frequency Ramp FD Monitoring
		5:0	R/W	0h	IN0 DIVN1 Divider Integer Value
		7:6	R/W	0h	IN0 DIVN1 Divider Integer Value
CLKIN0_CFG1_INPAGE	1Ah	5	R/W	0h	IN0 Direct Bypass for DIVN1
		4	R/W	0h	INO Single Ended Enable, Default is Differential
CLKIN0_CFG2_INPAGE	1Bh	7:0	R/W	0h	
CLKIN0_CFG3_INPAGE	1Ch	7:0	R/W	0h	IN0 FD Ramp monitor configuration bits calculated by GUI
CLKIN0_CFG4_INPAGE	1Dh	7:0	R/W	0h	5.10 04.04.404 2, 00.
CLKIN0_OUTSEL_INPAGE	1Eh	7:4	R/W	0h	XO divider configuration for FD Ramp monitors. GUI configures these dividers
CERINO_OUTSEE_INI AGE	1511	3:0	R/W	0h	IN0 divider configuration for FD Ramp monitors. GUI configures these dividers
		7	R/W	0h	SPARE
CLKINO_RAMPFD_MEAS_COUNT	1Fh	6:5	R/W	0h	SPARE
GERNA_INAMITE_MEAS_GOONT		4:0	R/W	0h	Exponent that determines the ideal measurement count for Ramp: Calculated by the GUI.
CLKIN1_DIVN1_INT1_INPAGE	20h	7:0	R/W	0h	IN1 DIVN1 Divider Integer Value
		7	R/W	0h	IN1 DIVN1 Integer Mode of Division
CLKIN1_DIVN1_INT2_INPAGE	21h	6	R/W	0h	SPARE
		5:0	R/W	0h	IN1 DIVN1 Divider Integer Value
		7:6	R/W	0h	IN1 DIVN1 Divider Integer Value
CLKIN1_CFG1_INPAGE	2Ah	5	R/W	0h	IN1 Direct Bypass for DIVN1
		4	R/W	0h	IN1 Single Ended Enable, Default is Differential
CLKIN1_CFG2_INPAGE	2Bh	7:0	R/W	0h	N4 50 0
CLKIN1_CFG3_INPAGE	2Ch	7:0	R/W	0h	IN1 FD Ramp monitor configuration bits calculated by GUI
		7:0	R/W	0h	,
CLKIN1_CFG4_INPAGE	2Dh	3:0	R/W	0h	IN1 divider configuration for FD Ramp monitors. GUI configures these dividers
		7:6	R/W	0h	PATTERN :{'01'/'10'} =] Efuse Locked , {'00'/'11'} =] Efuse NOT Locked
CLKIN1_RAMPFD_MEAS_COUNT	2Fh	4:0	R/W	0h	Exponent that determines the ideal measurement count for Ramp: Calculated by the GUI.
CLKIN2_DIVN1_INT1_INPAGE	30h	7:0	R/W	0h	IN2 DIVN1 Divider Integer Value



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
CLKIN2 DIVN1 INT2 INPAGE	31h	7	R/W	0h	IN2 DIVN1 Integer Mode of Division
CERINZ_DIVINT_INTZ_INFAGE	3111	5:0	R/W	0h	IN2 DIVN1 Divider Integer Value
		7:6	R/W	0h	IN2 DIVN1 Divider Integer Value
CLKIN2_CFG1_INPAGE	3Ah	5	R/W	0h	IN2 Direct Bypass for DIVN1
		4	R/W	0h	IN2 Single Ended Enable, Default is Differential
CLKIN2_CFG2_INPAGE	3Bh	7:0	R/W	0h	
CLKIN2_CFG3_INPAGE	3Ch	7:0	R/W	0h	IN2 FD Ramp monitor configuration bits calculated by GUI
CLKIN2_CFG4_INPAGE	3Dh	7:0	R/W	0h	ŕ
		7:4	R/W	0h	Internal FD Ramp related settings
CLKIN2_OUTSEL_INPAGE	3Eh	3:0	R/W	0h	IN2 divider configuration for FD Ramp monitors. GUI configures these dividers
		4:0	R/W	0h	Exponent that determines the ideal measurement count for Ramp: Calculated by the GUI.
CLKIN3_DIVN1_INT1_INPAGE	40h	7:0	R/W	0h	IN3 DIVN1 Divider Integer Value
CLKIN3_DIVN1_INT2_INPAGE	41h	7	R/W	0h	IN3 DIVN1 Integer Mode of Division
CERINS_DIVINT_INTZ_INFAGE	4111	5:0	R/W	0h	IN3 DIVN1 Divider Integer Value
		7:6	R/W	0h	IN3 DIVN1 Divider Integer Value
CLKIN3_CFG1_INPAGE	4Ah	5	R/W	0h	IN3 Direct Bypass for DIVN1
		4	R/W	0h	IN3 CLKIN3 Single Ended Enable, Default is Differential
CLKIN3_CFG2_INPAGE	4Bh	7:0	R/W	0h	NO 50 0 11 15 15
CLKIN3_CFG3_INPAGE	4Ch	7:0	R/W	0h	IN3 FD Ramp monitor configuration bits calculated by GUI
CLKIN3_CFG4_INPAGE	4Dh	7:0	R/W	0h	ŕ
	4Eh	7:6	R/W	0h	SPARE
CLKIN3 OUTSEL INPAGE		5:4	R/W	0h	SPARE
OLIMIO_OUTGEL_HIFAGE		3:0	R/W	0h	IN3 divider configuration for FD Ramp monitors. GUI configures these dividers
CLKIN3_RAMPFD_MEAS_COUNT	4Fh	4:0	R/W	0h	Exponent that determines the ideal measurement count for Ramp: Calculated by the GUI.
PAGE_NUMBER	FFh	7:0	R/W	0h	On all pages register FF is a READ / WRITE register used to change the page number



Table 33. PAGE 3: Output System and Output Dividers Related Registers.

Registers from 18h to 67h are equivalent NVMCopy Registers for this Page

Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		7:3	R/W	Oh	PRG_CMD Directives: 5b1_1000: PROGRAM_EFUSE 5b0_1100: READ_EFUSE 5b0_0110: Copy NVM Copy to Settings 5b1_1011: Proceed to Active
PRG_Directives_OUTPAGE	0Fh	2	R/W	0h	Spare
PRO_DIRECTIVES_OUTPAGE	OFTI	1	R/W	0h	Escape to the PRG_CMD state from ACTIVE state
		2	R/W	0h	
		1	R/W	0h	
		0	R/W	0h	
DIVO1_DIV2_OUTPAGE	18h	7:4	R/W	0h	Spare
DIVOI_DIVZ_OUTFAGE	1011	3:0	R/W	0h	DIVO Divider for this output: Bits [19:16]
DIVO1_DIV1_OUTPAGE	19h	7:0	R/W	0h	DIVO Divider for this output: Bits [15:8]
DIVO1_DIV0_OUTPAGE	1Ah	7:0	R/W	0h	DIVO Divider for this output: Bits [7:0]
DIVO1_PROG1_OUTPAGE	1Bh	7:6	R/W	0h	CMOS Driver Phase Selection phase_sel<1> phase_sel<0> ODR_P ODR_N 0 0 CLKP CLKN 0 1 CLKP CLKP 1 0 CLKN CLKN 1 1 CLKN CLKN
		2:0	R/W	0h	Single Ended Driver Programming of strength: Use 0b111= 0d7
DIVO1_PROG0_OUTPAGE	1Ch	7:0	R/W	0h	Programmable Output Delay PRG_DELAY[5:0] is the coarse delay on the clock output. It determines relative delay on this clock programmable from 0 to 63 VCO clock delays based on this number PRG_DELAY[7:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 3, 2, 1, 0 times 30 ps based on this 2 bit code
		4:3	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}. VDD Definition for this particular output.
DIVO1_MISC2_OUTPAGE	1Dh	2:0	R/W	0h	DRV_TYPE: Output Driver Standard: 0b010: DC Coupled CML 0b011: DC Coupled HCSL 0b000: LVDS (Can be AC Coupled or DC Coupled) 0b100: Boosted LVDS (Use for LVPECL like swings with AC Coupled loads) 0b001: DC Coupled LVPECL (with Common mode current) 0b101: DC Coupled LVPECL2 (without Common mode current)



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
DIVO2_DIV2_OUTPAGE	20h	7:4	R/W	0h	Spare
DIVOZ_DIVZ_GOTFAGE	2011	3:0	R/W	0h	DIVO Divider for this output: Bits [19:16]
DIVO2_DIV1_OUTPAGE	21h	7:0	R/W	0h	DIVO Divider for this output: Bits [15:8]
DIVO2_DIV0_OUTPAGE	22h	7:0	R/W	0h	DIVO Divider for this output: Bits [7:0]
DIVO2_PROG1_OUTPAGE	23h	7:6	R/W	Oh	CMOS Driver Phase Selection phase_sel<1> phase_sel<0> ODR_P ODR_N 0 0 CLKP CLKN 0 1 CLKP CLKP 1 0 CLKN CLKN 1 1 CLKN CLKN
		2:0	R/W	0h	Single Ended Driver Programming of strength: Use 0b111= 0d7
					Programmable Output Delay
DIVO2_PROG0_OUTPAGE	24h	7:0	R/W	Oh	PRG_DELAY[5:0] is the coarse delay on the clock output. It determines relative delay on this clock programmable from 0 to 63 VCO clock delays based on this number PRG_DELAY[7:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 3, 2, 1, 0 times 30 ps based on this 2 bit code
		4:3	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}. VDD Definition for this particular output.
DIVO2_MISC2_OUTPAGE	25h	2:0	R/W	0h	DRV_TYPE: Output Driver Standard: 0b010: DC Coupled CML 0b011: DC Coupled HCSL 0b000: LVDS (Can be AC Coupled or DC Coupled) 0b100: Boosted LVDS (Use for LVPECL like swings with AC Coupled loads) 0b001: DC Coupled LVPECL (with Common mode current) 0b101: DC Coupled LVPECL2 (without Common mode current)
DIVO2 DIV2 OUTDACE	28h	7:4	R/W	0h	Spare
DIVO3_DIV2_OUTPAGE		3:0	R/W	0h	DIVO Divider for this output: Bits [19:16]
DIVO3_DIV1_OUTPAGE	29h	7:0	R/W	0h	DIVO Divider for this output: Bits [15:8]
DIVO3_DIV0_OUTPAGE	2Ah	7:0	R/W	0h	DIVO Divider for this output: Bits [7:0]
DIVO3_PROG1_OUTPAGE	2Bh	7:6	R/W	0h	CMOS Driver Phase Selection phase_sel<1> phase_sel<0> ODR_P ODR_N 0 0 CLKP CLKN 0 1 CLKP CLKP 1 0 CLKN CLKN 1 1 CLKN CLKN
		2:0	R/W	0h	Single Ended Driver Programming of strength: Use 0b111= 0d7



Register Name	Register Number	Bit Range	Access Type	Default Value	Description		
					Programmable Output Delay		
DIVO3_PROG0_OUTPAGE	2Ch	7:0	R/W	Oh	PRG_DELAY[5:0] is the coarse delay on the clock output. It determines relative delay on this clock programmable from 0 to 63 VCO clock delays based on this number PRG_DELAY[7:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 3, 2, 1, 0 times 30 ps based on this 2 bit code		
DIVO3_MISC2_OUTPAGE	2Dh	4:3	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}. VDD Definition for this particular output.		
DIVO3_MISC2_OUTPAGE	2Dh	2:0	R/W	0h	DRV_TYPE : Output Driver Standard: 0b010: DC Coupled CML 0b011: DC Coupled HCSL 0b000: LVDS (Can be AC Coupled or DC Coupled) 0b100: Boosted LVDS (Use for LVPECL like swings with AC Coupled loads) 0b001: DC Coupled LVPECL (with Common mode current) 0b101: DC Coupled LVPECL2 (without Common mode current)		
		7:6	R/W	0h	PATTERN :{'01'/'10'} =] Efuse Written, {'00'/'11'} =] Efuse NOT Written		
		4	R/W	Oh	PRG_DELAY[8:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 4,3, 2, 1, 0 times 30 ps based on this 3 bit code		
		3	R/W	0h	{0, 0, 0, 0} External Termination, Differential		
DIVO3_MISC0_OUTPAGE	2Fh	2	R/W	0h	Output {0, 0, 1, 0} Internal Pull Up, Differential		
		1	R/W	0h	Output {0, 0, 0, 1} Internal Pull Dn, Differential		
		0	R/W	0h	Output		
		2	R/W	0h	{0, 1, 0, 0} CMOS On OutP, Nothing on OutN		
		1	R/W	0h	{1, 0, 0, 0} Nothing on OutP, CMOS on OutN {1, 1, 0, 0} CMOS on OutP, CMOS on OutN		
		0	R/W	0h			
DIVO4_DIV2_OUTPAGE	30h	3:0	R/W	0h	DIVO Divider for this output: Bits [19:16]		
DIVO4_DIV1_OUTPAGE	31h	7:0	R/W	0h	DIVO Divider for this output: Bits [15:8]		
DIVO4_DIV0_OUTPAGE	32h	7:0	R/W	0h	DIVO Divider for this output: Bits [7:0]		
DIVO4_PROG1_OUTPAGE	33h	7:6	R/W	CMOS Driver Phase Selection phase_sel<1> phase_sel<0> ODR_F ODR_N 0 0 CLKP CLKN 0 1 CLKP CLKP			
					1 0 CLKN CLKN 1 1 CLKN CLKP		



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		2:0	R/W	0h	Single Ended Driver Programming of strength: Use 0b111= 0d7
DIVO4_PROG0_OUTPAGE	34h	34h 7:0 R	R/W	Oh	Programmable Output Delay
					PRG_DELAY[5:0] is the coarse delay on the clock output. It determines relative delay on this clock programmable from 0 to 63 VCO clock delays based on this number
					PRG_DELAY[7:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 3, 2, 1, 0 times 30 ps based on this 2 bit code
		4:3	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}. VDD Definition for this particular output.
					DRV_TYPE : Output Driver Standard:
				Oh	0b010: DC Coupled CML
			R/W		0b011: DC Coupled HCSL
DIVO4_MISC2_OUTPAGE	35h	2:0			0b000: LVDS (Can be AC Coupled or DC Coupled)
					0b100: Boosted LVDS (Use for LVPECL like swings with AC Coupled loads)
					0b001: DC Coupled LVPECL (with Common mode current)
					0b101: DC Coupled LVPECL2 (without Common mode current)
DIVO4_MISC0_OUTPAGE		4	R/W	0h	PRG_DELAY[8:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 4,3, 2, 1, 0 times 30 ps based on this 3 bit code
			R/W	0h	{0, 0, 0, 0} External Termination, Differential Output
	37h	3			{0, 0, 1, 0} Internal Pull Up, Differential Output
	3711				{0, 0, 0, 1} Internal Pull Dn, Differential Output
		2	R/W	0h	{0, 1, 0, 0} CMOS On OutP, Nothing on OutN
		1	R/W	0h	{1, 0, 0, 0} Nothing on OutP, CMOS on OutN
		0	R/W	0h	{1, 1, 0, 0} CMOS on OutP, CMOS on OutN
DIVO5_DIV2_OUTPAGE	38h	7:4	R/W	0h	Spare
DIVOS_DIVZ_OUTLAGE	3011	3:0	R/W	0h	DIVO Divider for this output: Bits [19:16]
DIVO5_DIV1_OUTPAGE	39h	7:0	R/W	0h	DIVO Divider for this output: Bits [15:8]
DIVO5_DIV0_OUTPAGE	3Ah	7:0	R/W	0h	DIVO Divider for this output: Bits [7:0]



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
DIVO5_PROG1_OUTPAGE	3Bh	7:6	R/W	0h	CMOS Driver Phase Selection phase_sel<1> phase_sel<0> ODR_P ODR_N 0 0 CLKP CLKN 0 1 CLKP CLKP 1 0 CLKN CLKN 1 1 CLKN CLKN
		2:0	R/W	0h	Single Ended Driver Programming of strength: Use 0b111= 0d7
DIVO5_PROG0_OUTPAGE	3Ch	7:0	R/W	Oh	Programmable Output Delay PRG_DELAY[5:0] is the coarse delay on the clock output. It determines relative delay on this clock programmable from 0 to 63 VCO clock delays based on this number PRG_DELAY[7:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 3, 2, 1, 0 times 30 ps based on this 2 bit code
DIVO5_MISC3_OUTPAGE	3Dh	4:3	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}. VDD Definition for this particular output.
DIVO5_MISC3_OUTPAGE	3Dh	2:0	R/W	Oh	DRV_TYPE: Output Driver Standard: 0b010: DC Coupled CML 0b011: DC Coupled HCSL 0b000: LVDS (Can be AC Coupled or DC Coupled) 0b100: Boosted LVDS (Use for LVPECL like swings with AC Coupled loads) 0b001: DC Coupled LVPECL (with Common mode current) 0b101: DC Coupled LVPECL2 (without Common mode current)
DIVO6 DIV2 OUTPAGE	40h	7:4	R/W	0h	spare
		3:0	R/W	0h	DIVO Divider for this output: Bits [19:16]
DIVO6_DIV1_OUTPAGE	41h	7:0	R/W	0h	DIVO Divider for this output: Bits [15:8]
DIVO6_DIV0_OUTPAGE	42h	7:0	R/W	0h	DIVO Divider for this output: Bits [7:0]
DIVO6_PROG1_OUTPAGE	43h	7:6	R/W	0h	CMOS Driver Phase Selection phase_sel<1> phase_sel<0> ODR_P ODR_N 0 0 CLKP CLKN 0 1 CLKP CLKP 1 0 CLKN CLKN 1 1 CLKN CLKN
		2:0	R/W	0h	Single Ended Driver Programming of strength: Use 0b111= 0d7



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
					Programmable Output Delay
DIVO6_PROG0_OUTPAGE	44h	7:0	R/W	Oh	PRG_DELAY[5:0] is the coarse delay on the clock output. It determines relative delay on this clock programmable from 0 to 63 VCO clock delays based on this number PRG_DELAY[7:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 3, 2, 1, 0 times 30 ps based on this 2 bit code
		4:3	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}. VDD Definition for this particular output.
DIVO6_MISC2_OUTPAGE	45h	2:0	R/W	0h	DRV_TYPE: Output Driver Standard: 0b010: DC Coupled CML 0b011: DC Coupled HCSL 0b000: LVDS (Can be AC Coupled or DC Coupled) 0b100: Boosted LVDS (Use for LVPECL like swings with AC Coupled loads) 0b001: DC Coupled LVPECL (with Common mode current) 0b101: DC Coupled LVPECL2 (without Common mode current)
		7:6	R/W	0h	DIVO Divider for 0B output: Bits [33:32]
		4 R/W 0h clock output. It determ this clock programma times 30 ps based on 3 R/W 0h {0, 0, 0, 0} External TOutput {0, 0, 1, 0} Internal Pt Output {0, 0, 0, 1} Internal Pt Output {0, 0, 0, 0, 1} Internal Pt Output {0, 1, 0, 0} CMOS On OutN	R/W	Oh	PRG_DELAY[8:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 4,3, 2, 1, 0 times 30 ps based on this 3 bit code
DIVO6_MISC0_OUTPAGE	47h				
DIVO6_MISCU_OUTPAGE	4711		R/W	0h	{0, 0, 0, 1} Internal Pull Dn, Differential Output {0, 1, 0, 0} CMOS On OutP, Nothing on OutN
			R/W	0h	
		0	R/W	0h	{1, 0, 0, 0} Nothing on OutP, CMOS on OutN {1, 1, 0, 0} CMOS on OutP, CMOS on OutN
DIVOZ DIVO OUTRACE	404	7:4	R/W	0h	spare
DIVO7_DIV2_OUTPAGE	48h	3:0	R/W	0h	DIVO Divider for this output: Bits [19:16]
DIVO7_DIV1_OUTPAGE	49h	7:0	R/W	0h	DIVO Divider for this output: Bits [15:8]
DIVO7_DIV0_OUTPAGE	4Ah	7:0	R/W	0h	DIVO Divider for this output: Bits [7:0]
DIVO7_PROG1_OUTPAGE	4Bh	7:6	R/W	0h	CMOS Driver Phase Selection phase_sel<1> phase_sel<0> ODR_P ODR_N 0 0 CLKP CLKN 0 1 CLKP CLKP 1 0 CLKN CLKN 1 1 CLKN CLKN
		2:0	R/W	0h	Single Ended Driver Programming of strength: Use 0b111= 0d7



Register Name	Register Number	Bit Range	Access Type	Default Value	Description			
					Programmable Output Delay			
DIVO7_PROG0_OUTPAGE	4Ch	7:0	R/W	Oh	PRG_DELAY[5:0] is the coarse delay on the clock output. It determines relative delay on this clock programmable from 0 to 63 VCO clock delays based on this number PRG_DELAY[7:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 3, 2, 1, 0 times 30 ps based on this 2 bit code			
		4:3	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}. VDD Definition for this particular output.			
DIVO7_MISC2_OUTPAGE	4Dh	2:0	R/W	0h	DRV_TYPE: Output Driver Standard: 0b010: DC Coupled CML 0b011: DC Coupled HCSL 0b000: LVDS (Can be AC Coupled or DC Coupled) 0b100: Boosted LVDS (Use for LVPECL like swings with AC Coupled loads) 0b001: DC Coupled LVPECL (with Common mode current) 0b101: DC Coupled LVPECL2 (without Common mode current)			
	4Fh	7:6	R/W	0h	DIVO Divider for 0B output: Bits [31:30]			
		4Fh	4Fh	4	R/W	0h	PRG_DELAY[8:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 4,3, 2, 1, 0 times 30 ps based on this 3 bit code	
DIVO7_MISC0_OUTPAGE				4Fh	3	R/W	0h	{0, 0, 0, 0} External Termination, Differential Output {0, 0, 1, 0} Internal Pull Up, Differential
				2	R/W	0h	Output {0, 0, 0, 1} Internal Pull Dn, Differential Output	
				1	R/W	0h	{0, 1, 0, 0} CMOS On OutP, Nothing on OutN {1, 0, 0, 0} Nothing on OutP, CMOS on	
		0	R/W	0h	OutN {1, 1, 0, 0} CMOS on OutP, CMOS on OutN			
DIVO0T_DIV2_OUTPAGE	50h	7:4	R/W	0h	spare			
		3:0	R/W	0h	DIVO Divider for this output: Bits [19:16]			
DIVO0T_DIV1_OUTPAGE	51h	7:0	R/W	0h	DIVO Divider for this output: Bits [15:8]			
DIVO0T_DIV0_OUTPAGE	52h	7:0	R/W	0h	DIVO Divider for this output: Bits [7:0]			
DIVO0T_PROG1_OUTPAGE	DIVO0T_PROG1_OUTPAGE 53h	7:6	R/W	0h	CMOS Driver Phase Selection phase_sel<1> phase_sel<0> ODR_P ODR_N 0 0 CLKP CLKN 0 1 CLKP CLKP 1 0 CLKN CLKN 1 1 CLKN CLKN			
		2:0	R/W	0h	Single Ended Driver Programming of strength: Use 0b111= 0d7			



Register Name	Register Number	Bit Range	Access Type	Default Value	Description			
					Programmable Output Delay			
DIVO0T_PROG0_OUTPAGE	54h	7:0	R/W	Oh	PRG_DELAY[5:0] is the coarse delay on the clock output. It determines relative delay on this clock programmable from 0 to 63 VCO clock delays based on this number PRG_DELAY[7:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 3, 2, 1, 0 times 30 ps based on this 2 bit code			
		4:3	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}. VDD Definition for this particular output.			
DIVO0T_MISC2_OUTPAGE	55h	2:0	R/W	0h	DRV_TYPE: Output Driver Standard: 0b010: DC Coupled CML 0b011: DC Coupled HCSL 0b000: LVDS (Can be AC Coupled or DC Coupled) 0b100: Boosted LVDS (Use for LVPECL like swings with AC Coupled loads) 0b001: DC Coupled LVPECL (with Common mode current) 0b101: DC Coupled LVPECL2 (without Common mode current)			
	57h	7:6	R/W	0h	DIVO Divider for 0B output: Bits [29:28]			
		57h		4	R/W	0h	PRG_DELAY[8:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 4,3, 2, 1, 0 times 30 ps based on this 3 bit code	
DIVO0T_MISC0_OUTPAGE			3	R/W	0h	{0, 0, 0, 0} External Termination, Differential Output		
BIVOUT_IMIOUS_COTT ACE			0	0111	0111		2	R/W
		1	R/W	0h	(0, 1, 0, 0) CMOS On OutP, Nothing on OutN (1, 0, 0, 0) Nothing on OutP, CMOS on			
		0	R/W	0h	OutN {1, 1, 0, 0} CMOS on OutP, CMOS on OutN			
DIVO0B_DIV2_OUTPAGE	60h	7:0	R/W	0h	DIVO Divider for 0B output: Bits [23:16]			
DIVO0B_DIV1_OUTPAGE	61h	7:0	R/W	0h	DIVO Divider for 0B output: Bits [15:8]			
DIVO0B_DIV0_OUTPAGE	62h	7:0	R/W	0h	DIVO Divider for 0B output: Bits [7:0]			
DIVO0B_PROG1_OUTPAGE	63h	7:6	R/W	0h	CMOS Driver Phase Selection phase_sel<1> phase_sel<0> ODR_P ODR_N 0 0 CLKP CLKN 0 1 CLKP CLKP 1 0 CLKN CLKN 1 1 CLKN CLKN			
		2:0	R/W	0h	Single Ended Driver Programming of strength: Use 0b111= 0d7			



Register Name	Register Number	Bit Range	Access Type	Default Value	Description			
					Programmable Output Delay			
DIVO0B_PROG0_OUTPAGE	64h	7:0	R/W	Oh	PRG_DELAY[5:0] is the coarse delay on the clock output. It determines relative delay on this clock programmable from 0 to 63 VCO clock delays based on this number PRG_DELAY[7:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 3, 2, 1, 0 times 30 ps based on this 2 bit code			
		4:3	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}. VDD Definition for this particular output.			
DIVO0B_MISC2_OUTPAGE	65h	2:0	R/W	0h	DRV_TYPE: Output Driver Standard: 0b010: DC Coupled CML 0b011: DC Coupled HCSL 0b000: LVDS (Can be AC Coupled or DC Coupled) 0b100: Boosted LVDS (Use for LVPECL like swings with AC Coupled loads) 0b001: DC Coupled LVPECL (with Common mode current) 0b101: DC Coupled LVPECL2 (without Common mode current)			
	67h	7:6	R/W	0h	DIVO Divider for 0B output: Bits [25:24]			
		67h	67h	67h	4	R/W	0h	PRG_DELAY[8:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 4,3, 2, 1, 0 times 30 ps based on this 3 bit code
DIVO0B_MISC0_OUTPAGE					3	R/W	0h	{0, 0, 0, 0} External Termination, Differential Output
5.1.602600_5011.7.62	0111	2	R/W	0h	{0, 0, 1, 0} Internal Pull Up, Differential Output {0, 0, 0, 1} Internal Pull Dn, Differential			
			1	R/W	0h	Output {0, 1, 0, 0} CMOS On OutP, Nothing on OutN		
		0	R/W	0h	{1, 0, 0, 0} Nothing on OutP, CMOS on OutN {1, 1, 0, 0} CMOS on OutP, CMOS on OutN			
	001	7:4	R/W	0h	spare			
DIVO1B_DIV2_OUTPAGE	68h	3:0	R/W	0h	DIVO Divider for this output: Bits [19:16]			
DIVO1B_DIV1_OUTPAGE	69h	7:0	R/W	0h	DIVO Divider for this output: Bits [15:8]			
DIVO1B_DIV0_OUTPAGE	6Ah	7:0	R/W	0h	DIVO Divider for this output: Bits [7:0]			
DIVO1B_PROG1_OUTPAGE	6Bh	7:6	R/W	Oh	CMOS Driver Phase Selection phase_sel<1> phase_sel<0> ODR_P ODR_N 0 0 CLKP CLKN 0 1 CLKP CLKP 1 0 CLKN CLKN 1 1 CLKN CLKN			
		2:0	R/W	0h	Single Ended Driver Programming of strength: Use 0b111= 0d7			



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
DIVO1B_PROG0_OUTPAGE	6Ch	7:0	R/W	0h	Programmable Output Delay PRG_DELAY[5:0] is the coarse delay on the clock output. It determines relative delay on this clock programmable from 0 to 63 VCO clock delays based on this number PRG_DELAY[7:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 3, 2, 1, 0 times 30 ps based on this 2 bit code
		4:3	R/W	0h	VDD_DEF: VDD {1.8(00), 2.5(01), 3.3(10)}. VDD Definition for this particular output.
DIVO1B_MISC2_OUTPAGE	6Dh	2:0	R/W	0h	DRV_TYPE: Output Driver Standard: 0b010: DC Coupled CML 0b011: DC Coupled HCSL 0b000: LVDS (Can be AC Coupled or DC Coupled) 0b100: Boosted LVDS (Use for LVPECL like swings with AC Coupled loads) 0b001: DC Coupled LVPECL (with Common mode current) 0b101: DC Coupled LVPECL2 (without Common mode current)
		7:6	R/W	0h	SPARE
		4	R/W	0h	PRG_DELAY[8:6] is the fine delay on the clock output. It determines relative delay on this clock programmable in 4,3, 2, 1, 0 times 30 ps based on this 3 bit code
DIVO1B_MISC0_OUTPAGE	PAGE 6Fh	3	R/W	0h	{0, 0, 0, 0} External Termination, Differential Output
DIVOTE_MICOU_COTT AGE		2	R/W	0h	{0, 0, 1, 0} Internal Pull Up, Differential Output {0, 0, 0, 1} Internal Pull Dn, Differential
		1	R/W	0h	Output {0, 1, 0, 0} CMOS On OutP, Nothing on OutN
		0	R/W	0h	{1, 0, 0, 0} Nothing on OutP, CMOS on OutN {1, 1, 0, 0} CMOS on OutP, CMOS on OutN
PAGE_NUMBER	FFh	7:0	R/W	0h	On all pages register FF is a READ / WRITE register used to change the page number



Table 34. Page A: PLL A Related Registers (Similar for Pages B, C, D).

The Registers from 10h to 2Fh are equivalent NVMCopy Registers for this Page. Fractional Divider Registers are not valid for DIVN2 for PLLA but valid for PLLs B, C, D.

Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		7	R	0h	SPARE
		6	R	0h	SPARE
		5	R	0h	SPARE
STATUS_PLLA	02h	4	R	0h	SPARE
STATUS_FEEA	0211	3	R	0h	SPARE
		2	R	0h	SPARE
		1	R	0h	SPARE
		0	R	0h	Dynamic status of Loss of lock for PLLA
		7	R/W	1h	SPARE
		6	R/W	1h	SPARE
		5	R/W	1h	SPARE
NOTIFY_PLLA	03h	4	R/W	1h	SPARE
NOTH I_I ZEA	CON	3	R/W	1h	SPARE
		2	R/W	1h	SPARE
		1	R/W	1h	SPARE
		0	R/W	1h	Sticky/Notify status Loss of lock for PLLA
		7	R/W	1h	SPARE
		6	R/W	1h	SPARE
		5	R/W	1h	SPARE
		4	R/W	1h	SPARE
MASKb_PLLA	04h	3	R/W	1h	SPARE
		2	R/W	1h	SPARE
		1	R/W	1h	SPARE
		0	R/W	1h	Mask bit for NOTIFY_PLLA (03h) If programmed as '0': Mask sticky/Notify bit generation for 03h[0]
		7	R/W	0h	Reserved
		6	R/W	0h	Spare
		5	R/W	1h	DLPF co-efficient selection provided by the GUI
Directives_GENERIC_PLLA	05h	4	R/W	0h	Force external clock in switch
		3	R/W	0h	Force the PLL in holdover mode
		2	R/W	0h	Large change for resetting entire DIVO system: Edge triggered
		0	R/W	0h	Spare
STATUS_1_PLLA	06h	7	R	0h	SPARE



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		6	R	0h	SPARE
		5	R	0h	SPARE
		4	R	0h	SPARE
		3	R	0h	Dynamic status for cycle slip detection
		2	R	0h	Dynamic status for indicating holdover window is valid
		1	R	0h	Dynamic status for fast lock mode
		0	R	0h	Dynamic status for holdover
		7	R/W	1h	SPARE
		6	R/W	1h	SPARE
		5	R/W	1h	SPARE
		4	R/W	1h	SPARE
NOTIFY_1_PLLA	07h	3	R/W	1h	Sticky/Notify status for cycle slip detection
		2	R/W	1h	Sticky bit indicating holdover window is valid
		1	R/W	1h	Sticky/Notify status for fast lock mode
		0	R/W	1h	Sticky/Notify status for holdover
		7	R/W	1h	SPARE
		6	R/W	1h	SPARE
		5	R/W	1h	SPARE
		4	R/W	1h	SPARE
		3	R/W	1h	Mask bit for NOTIFY_1_PLLA (07h)If programmed as '0': Mask sticky/Notify bit generation for 07h[3]
MASKb_1_PLLA	08h	2	R/W	1h	Mask bit for NOTIFY_1_PLLA (07h)If programmed as '0': Mask sticky/Notify bit generation for 07h[2]
		1	R/W	1h	Mask bit for NOTIFY_1_PLLA FASTLOCK (07h)If programmed as '0': Mask sticky/Notify bit generation for 07h[1]
		0	R/W	1h	Mask bit for NOTIFY_1_PLLA (07h)If programmed as '0': Mask sticky/Notify bit generation for 07h[0]
PRG_Directives_PLLA 0Fh	0Fh	7:3	R/W	0h	PRG_CMD Directives: 5b1_1000: PROGRAM_EFUSE 5b0_1100: READ_EFUSE 5b0_0110: Copy NVM Copy to Settings 5b1_1011: Proceed to Active
		2	R/W	0h	Spare
		1	R/W	0h	Escape to the PRG_CMD state from ACTIVE state
DDATH DIIA	10h	7:5	R/W	0h	DI DE Settings from the CI II
PPATH_PLLA	1011	4:0	R/W	0h	DLPF Settings from the GUI



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
IPATH1_PLLA	11h	7:3	R/W	0h	
		2:0	R/W	0h	
IPATH2_PLLA	12h	7:5	R/W	0h	
		4:0	R/W	0h	
FASTLOCK_PPATH_PLLA	13h	7:5	R/W	0h	
		4:0	R/W	0h	
FASTLOCK_IPATH1_PLLA	14h	7:3	R/W	0h	
		2:0	R/W	0h	
FASTLOCK_IPATH2_PLLA	15h	7:5	R/W	0h	
		4:0	R/W	0h	
		7	R/W	0h	CP gain configuration settings provided by
		6	R/W	0h	GUI
		5	R/W	0h	PLL loop filer configuration provided by GUI
CYCLESLIP_MISC_CTRL_PLLA	16h	4	R/W	0h	PLL loop filer configuration provided by GUI
		3	R/W	0h	ZDB related setting provided by GUI
		2:1		0h	Cycle Slip detector threshold settings computed by GUI
		0	R/W	0h	Enable for cycle slip detector for DLPF
DIVNINT_PLLA	17h	7	R/W	0h	Master Disable for PLLA in sync mode and all associated functions
		6:0	R/W	0h	DIVN Integer part computed by GUI
		7	R/W	0h	Enable ADC Dither
		6	R/W	0h	Offset Enable in the PLL Charge Pump
MISCXO_PLLA	18h	5	R/W	0h	Select ACTIVE clock manually from manual input select pins when in manual active select mode
		4	R/W	0h	DIVN Integer part computed by GUI
		3:1	R/W	0h	Charge Pump Binning for VCO KV
		0	R/W	0h	0: Fractional Mode; 1: Integer Mode
		7:6	R/W	0h	Phase averager configuration settings
DLPF_PHI_CORRECTION_PLLA	19h	5:2	R/W	0h	Phase measurement filter BW setting (3 is spare)
		1	R/W	0h	Phase Correction Setting: Use default from GUI
DIVNFRAC2_PLLA	1Ah	7:0	R/W	0h	DIVN Fractional part computed by GUI
DIVNFRAC3_PLLA	1Bh	7:0	R/W	0h	DIVN Fractional part computed by GUI
DIVNFRAC4_PLLA	1Ch	7:0	R/W	0h	DIVN Fractional part computed by GUI
DIVN2_INT1_PLLA	1Dh	7:0	R/W	0h	DIVN2 Integer part computed by GUI
DIVN2_INT2_PLLA	1Eh	7:0	R/W	0h	DIVN2 Integer part computed by GUI



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		7	R/W	0h	Enable Revertive switching for input clock switching
DIVN2_INT3_PLLA	1Fh	6	R/W	0h	Force manual selection of ACTIVE clock
		5	R/W	0h	Force Integer mode for the DIVN2 DSM
		4:0	R/W	0h	DIVN2 Integer part computed by GUI
DIVN2_FRN1_PLLA	20h	7:0	R/W	0h	DIVN2 Fractional part computed by GUI
DIVN2_FRN2_PLLA	21h	7:0	R/W	0h	DIVN2 Fractional part computed by GUI
DIVN2_FRN3_PLLA	22h	7:0	R/W	0h	DIVN2 Fractional part computed by GUI
DIVN2_FRN4_PLLA	23h	7:0	R/W	0h	DIVN2 Fractional part computed by GUI
DIVN2_FRD1_PLLA	24h	7:0	R/W	0h	DIVN2 Fractional part computed by GUI
DIVN2_FRD2_PLLA	25h	7:0	R/W	0h	DIVN2 Fractional part computed by GUI
DIVN2_FRD3_PLLA	26h	7:0	R/W	0h	DIVN2 Fractional part computed by GUI
DIVN2_FRD4_PLLA	27h	7:0	R/W	0h	DIVN2 Fractional part computed by GUI
OUTPUT_EN_PLLA	28h	7:6	R/W	0h	PSEQ_SYNC_DELAY 0: 500us 1: 8.17ms 2: 131.07ms 3: 2.09sec
		5:0	R/W	0h	One Hot Output Enable for Outputs 5:0
		7:6	R/W	0h	Programmable Phase Propagation Mode slope for the PLL 00: Use the Bandwidth 01: 10 usec/sec 10: 40 usec/sec 11: 160 usec/sec
		5	R/W	0h	Wait for Input Clock in power up in the PLL wake-up sequence
LL_REG1_PLLA	29h	4	R/W	0h	Use Fast Lock BW for exit from holdover to latch on fast to the new clock
		3:1	R/W	0h	Loss of Lock Delay = (2^(26- (2*LLDELAYTIMER))/4M). Wait for this delay time before announcing LL de- assertion
		0	R/W	0h	LL Clear Threshold {LL_CLR_VALUE_PLLA[1], 0x2A[0]} 2'b00 : 0.2 PPM 2'b01 : 0.4 PPM 2'b10 : 2 PPM 2'b11 : 200 PPM



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		7:5	R/W	0h	LL_SET_VALUE_PLLA[7:4] 0: 0.2 PPM 1: 0.4 PPM 2: 2 PPM 3: 4 PPM 4: 20 PPM 5: 40 PPM 6: 200 PPM
LL_REG2_PLLA	2Ah	4	R/W	0h	7: 400 PPM 8: 2000 PPM 9: 4000 PPM 10: 0.2 PPM 11: 0.2 PPM 12: 0.2 PPM 13: 0.2 PPM 14: 0.2 PPM 15: 0.2 PPM
		3:1	R/W	Oh	PLL_PSEQ_DELAY 0: 500us 1: 2ms 2: 8.19ms 3: 32.76ms 4: 131.07ms 5: 524.28ms 6: 2.09sec 7: 8.38sec
		0	R/W	0h	LL Clear Threshold {0x29[0], LL_CLR_VALUE_PLLA[0]} 2'b00 : 0.2 PPM 2'b01 : 0.4 PPM 2'b10 : 2 PPM 2'b11 : 200 PPM
		7:5	R/W	0h	Holdover Tdelay settings for the PLL computed by the GUI
	OD!	4	R/W	0h	Enable Zero Delay Buffer mode with feedback clock routed from the PCB on in3
	2Bh	3:1	R/W	0h	Holdover Average settings for the PLL computed by the GUI
		0	R/W	0h	Enable output clock sync on an independent input coming from IN3
HOLDOVER2_PLLA		7	R/W	0h	Cycle Slip Detector related default
20	2Ch	6	R/W	0h	Enable Phase Propagation during input clock switch Enable Phase Build Out Mode where the phase difference between input clocks is absorbed by the PLL
		5	R/W	1h	Dither configuration for DIVN2 DSM
		4	R/W	0h	Enable revert to spare input clock during clock switching



Register Name	Register Number	Bit Range	Access Type	Default Value	Description
		3:1	R/W	0h	DLPF related constant from the GUI
		0	R/W	0h	Internal voltage programming: Use default from GUI Profile
		7	R/W	0h	Enable fast lock mode based on loss of lock status
DECIMATION_RATIO_PLLA	2Dh	6:3	R/W	0h	Internal Rate Change factors in DLPF computed by GUI
		2:0	R/W	0h	Internal Rate Change factors in DLPF computed by GUI
ONEDVO2 DI LA	2Eh	7:3	R/W	0h	Internal Rate Change factors in DLPF computed by GUI
ONEBYR2_PLLA	2511	2:0	R/W	0h	Internal Rate Change factors in DLPF computed by GUI
		7:6	R/W	0h	PATTERN :{'01'/10'} =] Efuse Locked, {'00'/'11'} =] Efuse NOT Locked
LOCKPATTERN_PLLA	2Fh	5:4	R/W	0h	Program the frequency ramp slope from the following- 00: 0.2 ppm/s, 01: 2 ppm/s, 10: 20 ppm/s, 11: 200 ppm/s
		3	R/W	0h	Enable the frequency ramp feature
		2:0	R/W	0h	Internal Frequency Divider : Computed by the GUI
DCO_FRAC1_PLLA	31h	7:0	R/W	0h	DCO fractional control code
DCO_FRAC2_PLLA	32h	7:0	R/W	0h	DCO fractional control code
DCO_FRAC3_PLLA	33h	7:0	R/W	0h	DCO fractional control code
DCO_FRAC4_PLLA	34h	7:0	R/W	0h	DCO fractional control code
		7:4	R/W	0h	Reserved
		3	R/W	0h	DCO Increment in Frequency from registers
DCO_FUNCTION_PLLA	35h	2	R/W	0h	DCO Decrement in Frequency from registers
		1	R/W	0h	Enable DCO free run mode
		0	R/W	0h	DCO Mask for this PLL
DCO_BUMP2_PLLA	36h	7:0	R/W	0h	DCO integer control code
		7:6	R/W	0h	DCO integer control code
DCO_BUMP3_PLLA	27h	5	R/W	0h	Enable DCO sync mode
DOO_BUNIF3_FLLA	37h	4	R/W	0h	SPARE
		3:0	R/W	0h	SPARE
PAGE_NUMBER	FFh	7:0	R/W	0h	On all pages register FF is a READ / WRITE register used to change the page number



Package Dimensions and Patterns

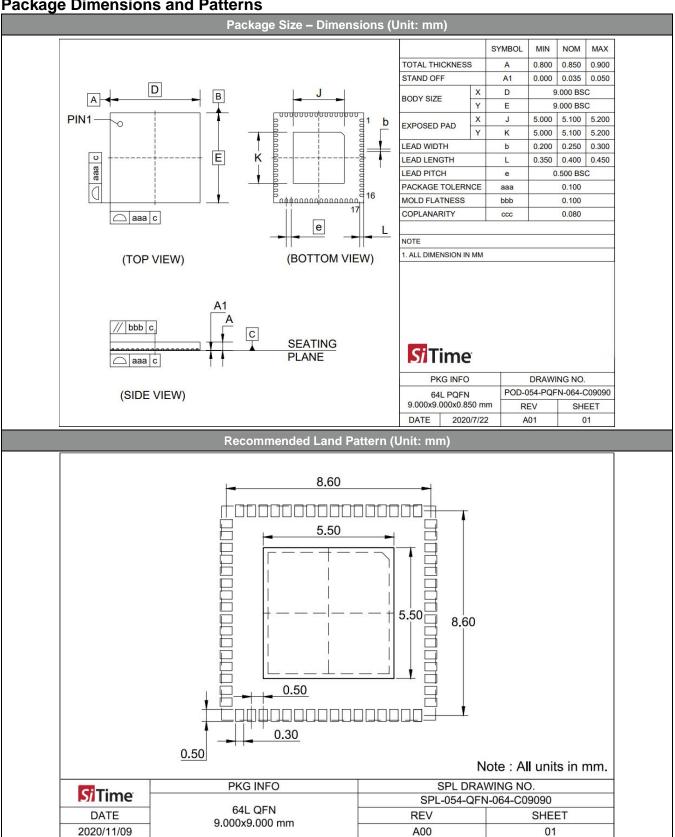




Table 35. Revision History

Revisions	Release Date	Change Summary
0.3	23 Apr 2019	Preliminary release Added Register Map sections
0.31	31 Aug 2019	Fixed typos Added "Y"1ku tape and reel order code
1.0	20 May 2020	I ² C address setting description added Added Low Wander Mode and Sysref sections Updated figures and numbering Added additional Notes Updated Features and Description Added "X" tape and reel order code Added pin pull-up and pull-down resistor values Updated supply current for VDDIN Updated PSNR, VDD, VDDIN values
1.01	2 Aug 2020	Formatting changes Updated Ordering Information
1.02	28 Aug 2020	Modified Absolute Crossing Point Voltage (VCROSS) specification Changed rev table date format
1.03	28 Sep 2020	Formatting updates Updated I2C Protocol section
1.04	25 Jan 2021	Formatting and trademarks update Rearranged sections
2.0	21 Mar 2022	Final Release
2.1	25 Jul 2022	Formatting update to Block Diagram Updated notes for Table 4
2.2	29 Sep 2022	Updated notes for DC Electrical Characteristics values and footnotes Added Voltage Ramp data and diagrams Updated I ² C addressing instructions Fixed typos
2.3	14 Nov 2022	Updated version ID Added specs for LVDS common mode voltage at 1.8 V Fixed register maps Minor corrections to diagrams & wording
2.31	21 Nov 2022	Fixed typos in "Monitoring the Status for Master and Slave Pages"
2.33	22 May 2023	Updated trademarks and page 1 references links
2.35	26 Jul 2023	Updated LVDS (Vocm, Table 13) and Output Voltage (Vol, Table 9) specifications
2.37	30 Aug 2023	Added "4-16A" integration bandwidth jitter
2.38	25 Mar 2024	Fixed typo to correct MSL3

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